

# Micron Serial NOR Flash Memory

**3V, Twin-Quad I/O, 4KB, 32KB, 64KB, Sector Erase  
MT25TL01GBBB, MT25TL01GHBB**

## Features

- Stacked device (two 512Mb die)
- SPI-compatible serial bus interface
- Single and double transfer rate (STR/DTR)
- Clock frequency
  - 133 MHz (MAX) for all protocols in STR
  - 90 MHz (MAX) for all protocols in DTR
- Dual/quad I/O instruction provides increased throughput up to 90 MB/s for each die corresponding to 180 MB/s for the twin-quad device
- Supported protocols in both STR and DTR
  - Extended I/O protocol
  - Dual I/O protocol
  - Quad I/O protocol
- Execute-in-place (XIP)
- PROGRAM/ERASE SUSPEND operations
- Volatile and nonvolatile configuration settings
- Software reset
- Additional reset pin for selected part numbers
- 3-byte and 4-byte addressability mode supported
- Dedicated 64-byte OTP area outside main memory
  - Readable and user-lockable
  - Permanent lock with PROGRAM OTP command
- Erase capability
  - Die erase
  - Sector erase 64KB uniform granularity
  - Subsector erase 4KB, 32KB granularity
- Security and write protection
  - Volatile and nonvolatile locking and software write protection for each 64KB sector
  - Nonvolatile configuration locking
  - Password protection
  - Hardware write protection: nonvolatile bits (BP[3:0] and TB) define protected area size
  - Program/erase protection during power-up
  - CRC detects accidental changes to raw data
- Electronic signature
  - JEDEC-standard 3-byte signature (BA20h)
  - Extended device ID: two additional bytes identify device factory options
- JESD47H-compliant
  - Minimum 100,000 ERASE cycles per sector
  - Data retention: 20 years (TYP)

## Options

- Voltage
  - 2.7–3.6V
- Density
  - 1Gb
- Device stacking
  - B = 2 die and 1 S# pin
  - H = 2 die and 2 S# pins
- Device generation
- Die revision
- Pin configuration
  - RESET# and HOLD#
- Sector size
  - 64KB
- Packages – JEDEC-standard, RoHS-compliant
  - 16-pin SOP2, 300 mils body width (SO16W)
  - 24-ball T-PBGA, 05/6mm x 8mm (TBGA24)
- Security features
  - Standard
- Special options
  - Automotive
- Standard security
- Operating temperature range
  - From –40°C to +105°C

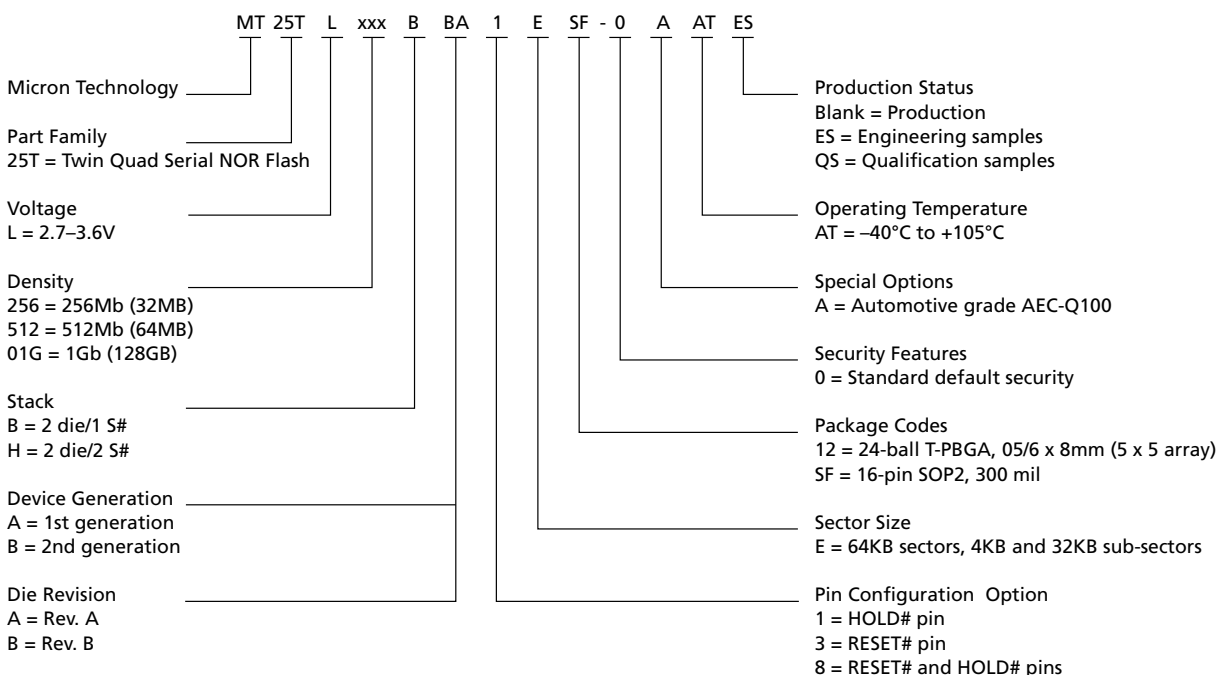
## Marking

L  
01G  
B  
H  
B  
B  
8  
E  
SF  
12  
0  
A  
0  
AT

## Part Number Ordering

Micron serial NOR Flash devices are available in different configurations and densities. Verify valid part numbers by using Micron's part catalog search at [www.micron.com](http://www.micron.com). To compare features and specifications by device type, visit [www.micron.com/products](http://www.micron.com/products). Contact the factory for devices not found.

**Figure 1: Part Number Ordering Information**



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## Important Notes and Warnings

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## Device Description

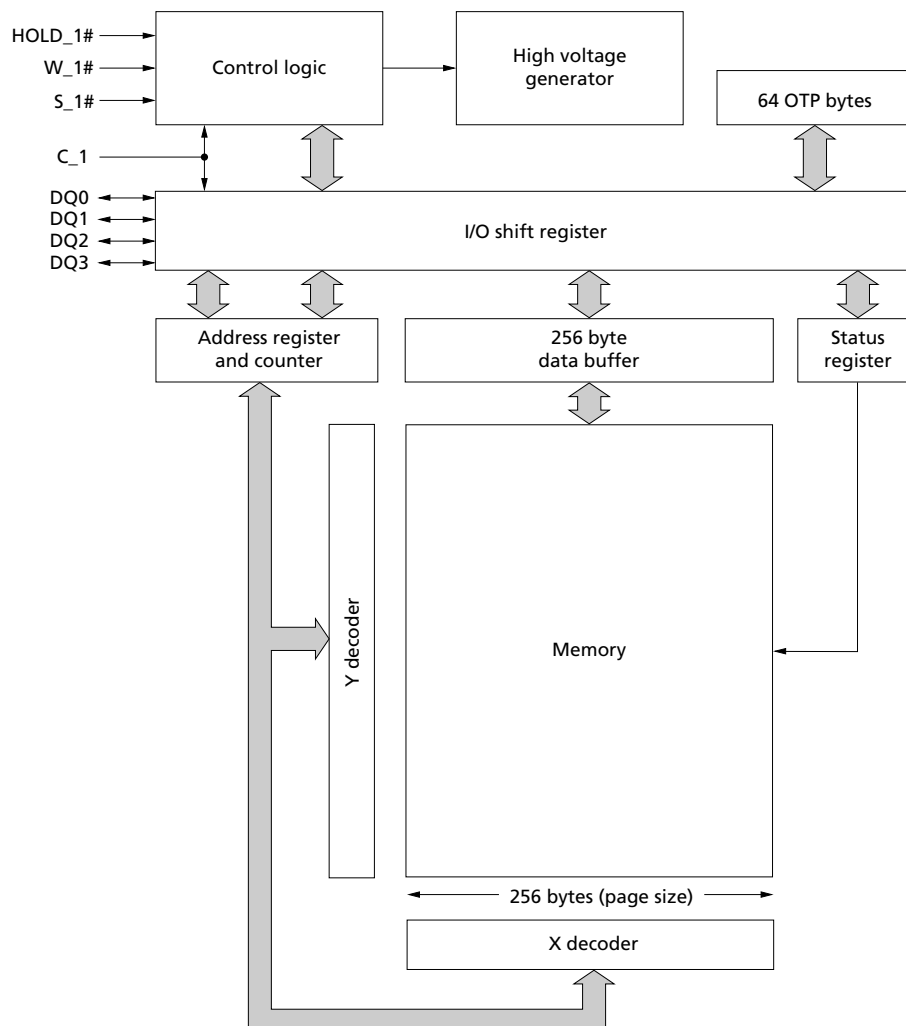
The MT25T is a high-performance, multiple input/output, serial NOR Flash memory device. It features a high-speed SPI-compatible bus interface, execute-in-place (XIP) functionality, advanced write protection mechanisms, and extended address access. Innovative, high-performance, dual and quad input/output commands enable double or quadruple the transfer bandwidth for READ and PROGRAM operations.

The device contains two quad I/O die, each able to operate independently for a total of eight I/Os. The memory map applies to each die. Each die has internal registers for status, configuration, and device protection that can be set and read independently from one other. Micron recommends that internal configuration settings for the two die be set identically.

The device is offered in two ways: One way is each die with its own S# and CLK signals, as represented in the "Separate Chip Select and Clock Signals" figure, and enabling each die to function independently. The other is an S# signal and a CLK signal shared between the two die, as represented in the "Shared Chip Select and Clock Signals" figure, and enabling the two die to function as one with higher bandwidth operations. Contact the factory for more information.

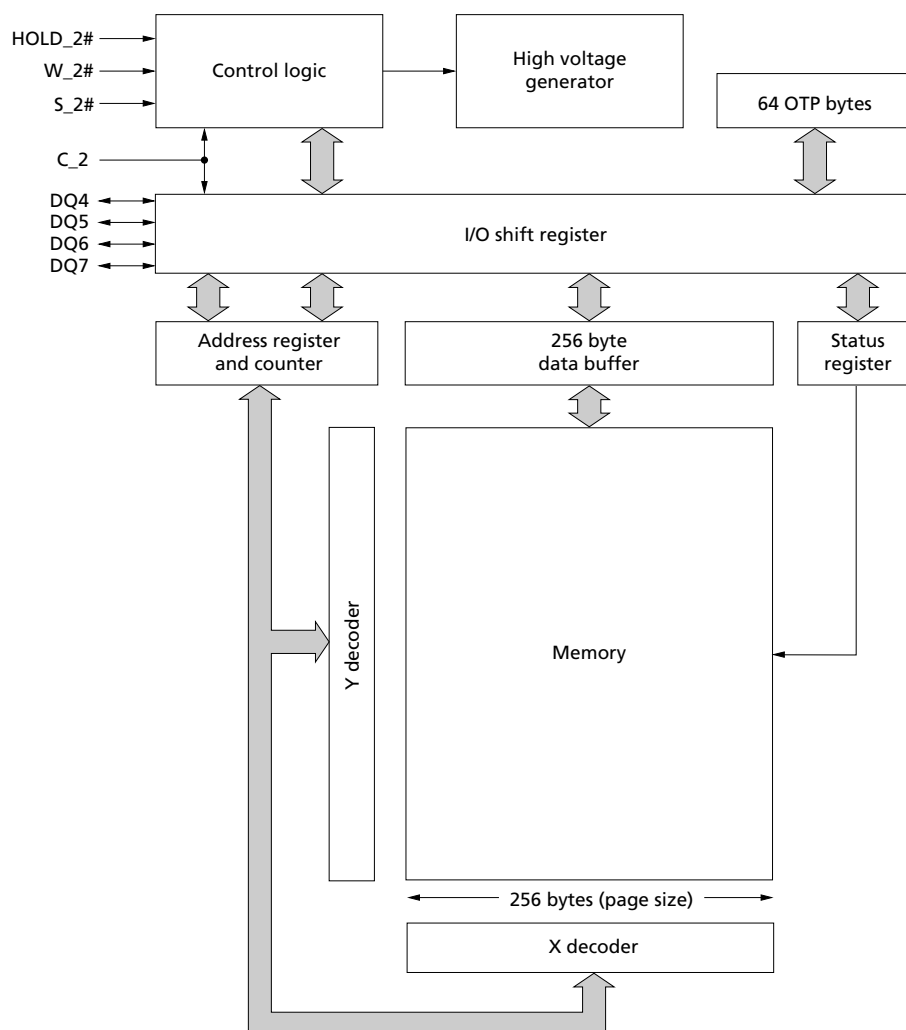
## Block Diagram

**Figure 2: Block Diagram – Flash Die 1**



Note: 1. Each page of memory can be individually programmed, but the device is not page-erasable.

**Figure 3: Block Diagram – Flash Die 2**



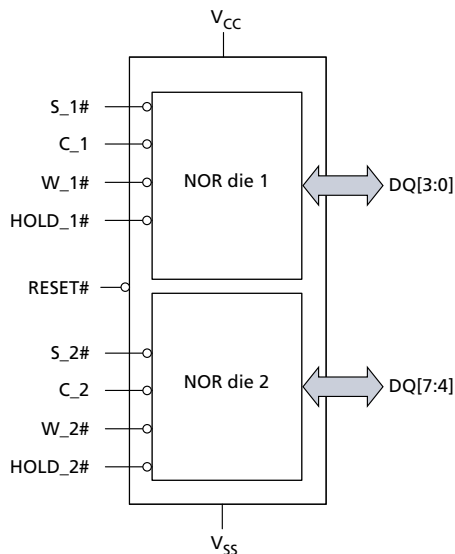
Note: 1. Each page of memory can be individually programmed, but the device is not page-erasable.

## Advanced Security Protection

The device offers an advanced security protection scheme where each sector can be independently locked, by either volatile or nonvolatile locking features. The nonvolatile locking configuration can also be locked, as well password-protected. See Block Protection Settings and Sector and Password Protection for more details.

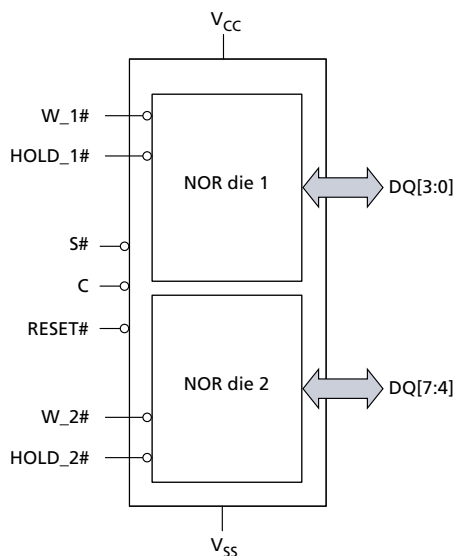
## Device Logic Diagram

**Figure 4: Logic Diagram – Separate Chip-Select and Clock Signals**



Note: 1. The  $RESET\#$  pin is available on dedicated part numbers. See the Part Numbering Ordering Information section for more details.

**Figure 5: Logic Diagram – Shared Chip-Select and Clock Signals**



Note: 1. The  $RESET\#$  pin is available on dedicated part numbers. See the Part Numbering Ordering section for more details.

## Signal Assignments

**Figure 6: 16-Pin, Plastic Small Outline – SO16 (Top View) (Single Chip-Select and Clock)**

|                 |   |    |                 |
|-----------------|---|----|-----------------|
| HOLD_1#/DQ3     | 1 | 16 | C               |
| V <sub>CC</sub> | 2 | 15 | DQ0             |
| RESET#/DNU      | 3 | 14 | DQ4             |
| HOLD_2#/DQ7     | 4 | 13 | NC              |
| DQ5             | 5 | 12 | W_2#/DQ6        |
| NC              | 6 | 11 | NC              |
| S#              | 7 | 10 | V <sub>SS</sub> |
| DQ1             | 8 | 9  | W_1#/DQ2        |

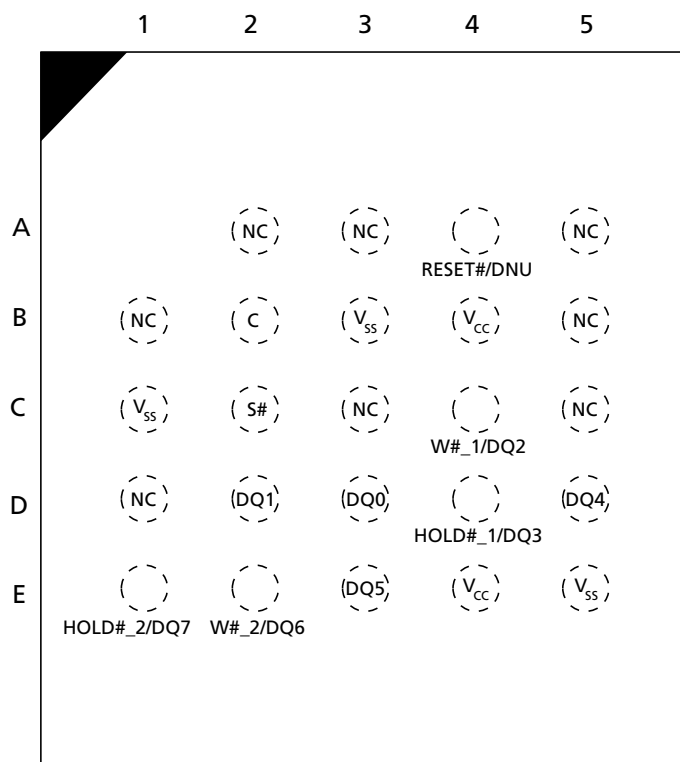
- Notes:
1. RESET# or HOLD# signals can share Pin 1 with DQ3, depending on the selected device (see Part Numbering Ordering Information). When using single and dual I/O commands on these parts, DQ3 must be driven HIGH by the host, or an external pull-up resistor must be placed on the PCB, in order to avoid allowing the HOLD# or RESET# input to float.
  2. Pin 3 = RESET# or DNU, depending on the part number. This signal has an internal pull-up resistor and may be left unconnected if not used.

**Figure 7: 16-Pin, Plastic Small Outline – SO16 (Top View) (Dual Chip-Select and Clock)**

|                 |   |    |                 |
|-----------------|---|----|-----------------|
| HOLD_1#/DQ3     | 1 | 16 | C_1             |
| V <sub>CC</sub> | 2 | 15 | DQ0             |
| RESET#/DNU      | 3 | 14 | DQ4             |
| HOLD_2#/DQ7     | 4 | 13 | C_2             |
| DQ5             | 5 | 12 | W_2#/DQ6        |
| S#_2            | 6 | 11 | NC              |
| S#_1            | 7 | 10 | V <sub>SS</sub> |
| DQ1             | 8 | 9  | W_1#/DQ2        |

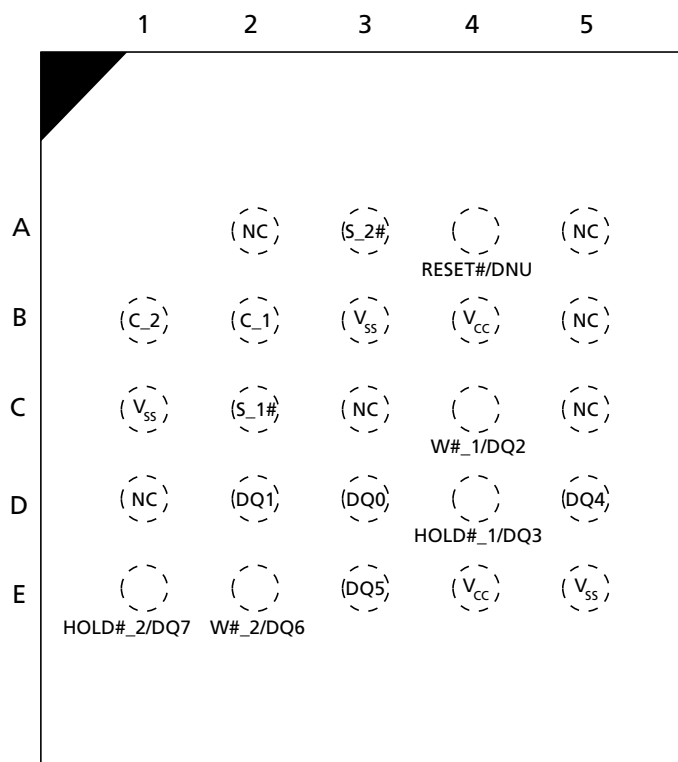
- Notes:
1. RESET# or HOLD# signals can share Pin 1 with DQ3, depending on the selected device (see Part Numbering Ordering Information). When using single and dual I/O commands on these parts, DQ3 must be driven HIGH by the host, or an external pull-up resistor must be placed on the PCB, in order to avoid allowing the HOLD# or RESET# input to float.
  2. Pin 3 = RESET# or DNU, depending on the part number. This signal has an internal pull-up resistor and may be left unconnected if not used.

**Figure 8: 24-Ball TBGA – 5 x 5 (Balls Down) (Single Chip-Select and Clock)**



- Notes:
1. RESET# or HOLD# signals can share Ball D4 with DQ3, depending on the selected device (see Part Numbering Ordering Information). When using single and dual I/O commands on these parts, DQ3 must be driven HIGH by the host, or an external pull-up resistor must be placed on the PCB, in order to avoid allowing the HOLD# or RESET# input to float.
  2. Ball A4 = RESET# or DNU, depending on the part number. This signal has an internal pull-up resistor and may be left unconnected if not used.

**Figure 9: 24-Ball TBGA – 5 x 5 (Balls Down) (Double Chip-Select and Clock)**



- Notes:
1. RESET# or HOLD# signals can share Ball D4 with DQ3, depending on the selected device (see Part Numbering Ordering Information). When using single and dual I/O commands on these parts, DQ3 must be driven HIGH by the host, or an external pull-up resistor must be placed on the PCB, in order to avoid allowing the HOLD# or RESET# input to float.
  2. Ball A4 = RESET# or DNU, depending on the part number. This signal has an internal pull-up resistor and may be left unconnected if not used.

## Signal Descriptions

The signal description table below is a comprehensive list of signals for the MT25T family devices. All signals listed may not be supported on this device. See Signal Assignments for information specific to this device.

**Table 1: Signal Descriptions**

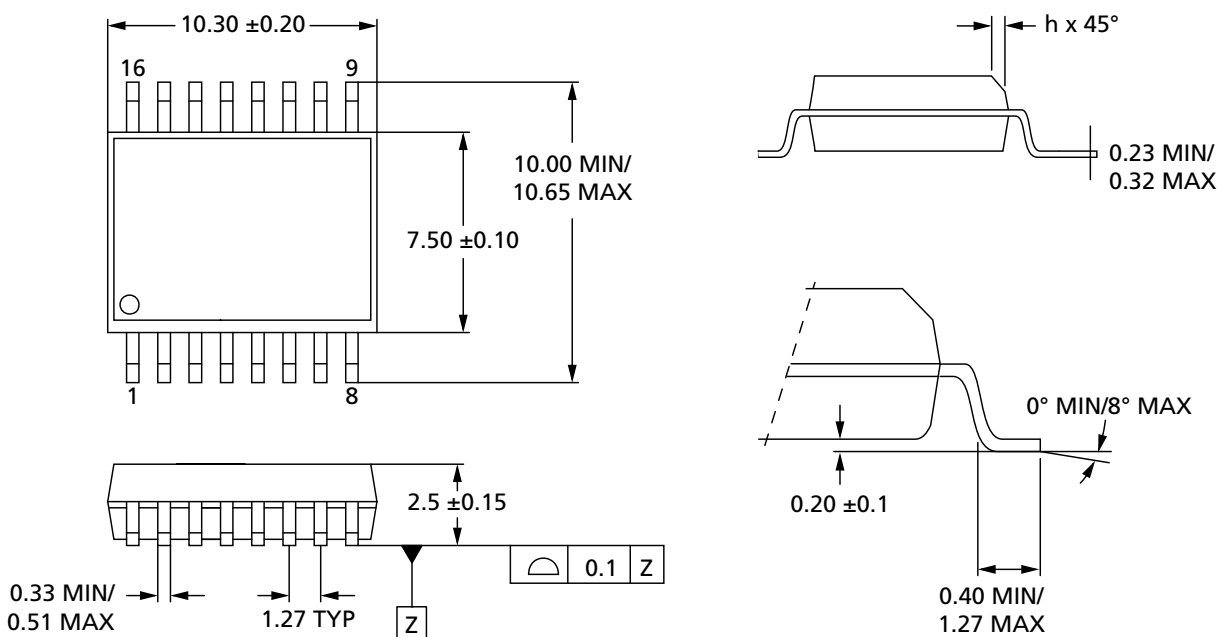
| Symbol              | Type  | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|---------------------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| C                   | Input | <b>Clock:</b> Provides the timing of the serial interface. Commands are latched on the rising edge of the clock. In STR commands or protocol, address and data inputs are latched on the rising edge of the clock, while data is output on the falling edge of the clock. In DTR commands or protocol, address and data inputs are latched on both edges of the clock, and data is output on both edges of the clock. In single clock C configuration, C_1 and C_2 are connected together internally at package level.                                                                                                                                                                                                                                   |
| C_1                 |       | Associated to die 1.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| C_2                 |       | Associated to die 2.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| S#                  | Input | <b>Chip select:</b> Because each die has its own DQ signals, each die can work independently. When S# is driven HIGH, the device enters standby mode, unless an internal PROGRAM, ERASE, or WRITE STATUS REGISTER cycle is in progress. All other input pins are ignored and the output pins are tri-stated. On parts where the pin configuration offers a dedicated RESET# pin, however, the RESET# input pin remains active when S# is HIGH. Driving S# LOW enables the device, placing it in the active mode. After power-up, a falling edge on S# is required prior to the start of any command. In single S# configuration, S_1# and S_2# are connected together internally at package level.                                                       |
| S_1#                |       | Associated to die 1.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| S_2#                |       | Associated to die 2.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| DQ[3:0],<br>DQ[7:4] | I/O   | <b>Serial data:</b> Bidirectional signals that transfer address, data, and command information. When using legacy (x1) SPI commands in extended I/O protocol (XIO-SPI), DQ0/DQ4 is an input and DQ1/DQ5 is an output. DQ[3:2]/DQ[7:6] are not used. When using dual commands in XIO SPI or when using DIO-SPI, DQ[1:0]/DQ[5:4] are I/O. DQ[3:2]/DQ[7:6] are not used. When using quad commands in XIO-SPI or when using QIO-SPI, DQ[3:0]/DQ[7:4] are I/O.                                                                                                                                                                                                                                                                                                |
| RESET#              | Input | <b>RESET:</b> Hardware RESET# signal shared by both die. When RESET# is driven LOW, the device is reset and the outputs are tri-stated. If RESET# is driven LOW while an internal WRITE, PROGRAM, or ERASE operation is in progress, data may be lost. The RESET# functionality can be disabled using bit 4 of the nonvolatile configuration register or bit 4 of the enhanced volatile configuration register. The RESET# has an internal pull-up resistor and may be left floating if not used. For pin configurations that share the DQ3/DQ7 pins with RESET#, the RESET# functionality is disabled in QIO-SPI mode.                                                                                                                                  |
| HOLD_1#,<br>HOLD_2# | Input | <b>HOLD_1# (die 1), HOLD_2# (die 2):</b> Pauses any serial communications with the related die without deselecting the device. Outputs are tri-stated and inputs are ignored. To enable HOLD, the related die must be selected by its associated S# being driven LOW.<br>In QIO-SPI, HOLD# acts as an I/O (DQ3/DQ7 functionality), and the HOLD# functionality is disabled when the device is selected.<br>Because each die has its own nonvolatile configuration register, the HOLD# functionality for each die can be disabled using bit 4 of its associated nonvolatile configuration register or bit 4 of its associated enhanced volatile configuration register. HOLD# functionality is disabled in QIO-SPI mode or when DTR operation is enabled. |

**Table 1: Signal Descriptions (Continued)**

| Symbol          | Type             | Description                                                                                                                                                                                                                                                                                                       |
|-----------------|------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| W_1#,<br>W_2#   | Control<br>Input | <b>Write protect:</b> W_1# (die 1) and W_2# (die 2) can be used as a protection control input or in QIO-SPI operations. When LOW, the blocks defined by the block protection bits BP[3:0] are protected against PROGRAM or ERASE operations. Status register bit 7 should be set to 1 to enable write protection. |
| V <sub>CC</sub> | Supply           | <b>Core and IO power supply:</b> All V <sub>CC</sub> pins must be connected to system power supply.                                                                                                                                                                                                               |
| V <sub>SS</sub> | Supply           | <b>Core and IO ground connection:</b> All V <sub>SS</sub> pins must be connected to system ground.                                                                                                                                                                                                                |
| DNU             | –                | <b>Do not use:</b> Do not connect to any other signal, or power supply; must be left floating.                                                                                                                                                                                                                    |
| RFU             | –                | <b>Reserved for future use:</b> Reserved by Micron for future device functionality and enhancement. Recommend that these be left floating. May be connected internally, but external connections will not affect operation.                                                                                       |
| NC              | –                | <b>No connect :</b> No internal connection; can be driven or floated.                                                                                                                                                                                                                                             |

## Package Dimensions – Package Code: SF

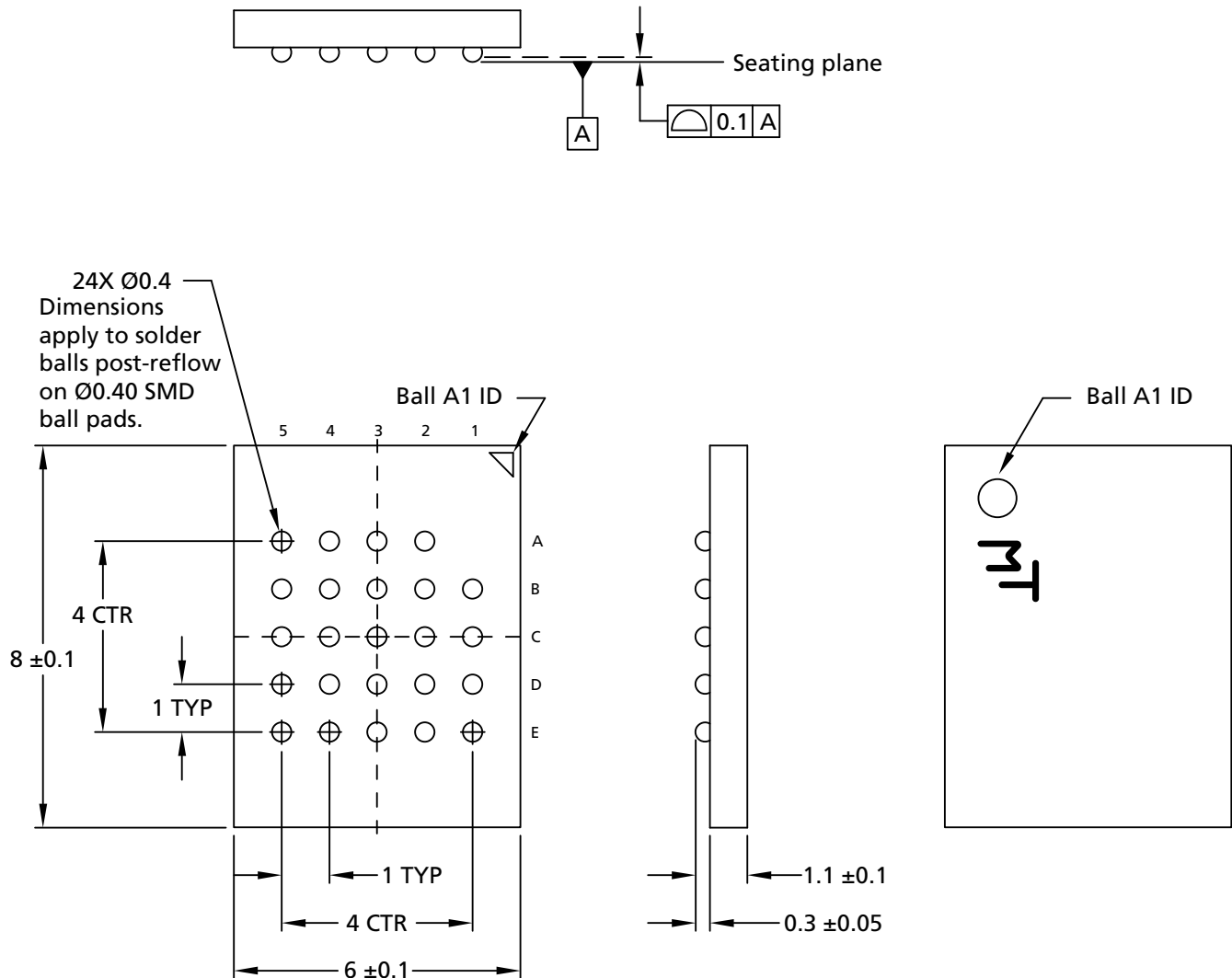
**Figure 10: 16-Pin SOP2 – 300 Mils Body Width**



- Notes:
1. All dimensions are in millimeters.
  2. See Part Number Ordering Information for complete package names and details.

## Package Dimensions – Package Code: 12

**Figure 11: 24-Ball T-PBGA (5 x 5 ball grid array) – 6mm x 8mm**



- Notes: 1. All dimensions are in millimeters.  
 2. See Part Number Ordering Information for complete package names and details.

## Memory Map – 512Mb Density

**Table 2: Sectors[1023:0]**

| Sector | 32KB Subsector | 4KB Subsector | Address Range |            |
|--------|----------------|---------------|---------------|------------|
|        |                |               | Start         | End        |
| 1023   | 2047           | 16383         | 03FF F000h    | 03FF FFFFh |
|        |                | ⋮             | ⋮             | ⋮          |
|        | 2046           | ⋮             | ⋮             | ⋮          |
|        |                | 16368         | 03FF 0000h    | 03FF 0FFFh |
| ⋮      |                | ⋮             | ⋮             | ⋮          |
| 511    | 1023           | 8191          | 01FF F000h    | 01FF FFFFh |
|        |                | ⋮             | ⋮             | ⋮          |
|        | 1022           | ⋮             | ⋮             | ⋮          |
|        |                | 8176          | 01FF 0000h    | 01FF 0FFFh |
| ⋮      |                | ⋮             | ⋮             | ⋮          |
| 255    | 511            | 4095          | 00FF F000h    | 00FF FFFFh |
|        |                | ⋮             | ⋮             | ⋮          |
|        | 510            | ⋮             | ⋮             | ⋮          |
|        |                | 4080          | 00FF 0000h    | 00FF 0FFFh |
| ⋮      |                | ⋮             | ⋮             | ⋮          |
| 0      | 1              | 15            | 0000 F000h    | 0000 FFFFh |
|        |                | ⋮             | ⋮             | ⋮          |
|        | 0              | ⋮             | ⋮             | ⋮          |
|        |                | 0             | 0000 0000h    | 0000 0FFFh |

Note: 1. See Part Number Ordering Information, Sector Size–Part Numbers table for options.

## Status Register

Status register bits can be read from or written to using READ STATUS REGISTER or WRITE STATUS REGISTER commands, respectively. When the status register enable/disable bit (bit 7) is set to 1 and W# is driven LOW, the status register nonvolatile bits become read-only and the WRITE STATUS REGISTER operation will not execute. The only way to exit this hardware-protected mode is to drive W# HIGH.

**Table 3: Status Register**

| Bit    | Name                                 | Settings                              | Description                                                                                                                                                                                                                               | Notes |
|--------|--------------------------------------|---------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|
| 7      | Status register write enable/disable | 0 = Enabled (default)<br>1 = Disabled | <b>Nonvolatile control bit:</b> Used with W# to enable or disable writing to the status register.                                                                                                                                         |       |
| 5      | Top/bottom                           | 0 = Top (default)<br>1 = Bottom       | <b>Nonvolatile control bit:</b> Determines whether the protected memory area defined by the block protect bits starts from the top or bottom of the memory array.                                                                         |       |
| 6, 4:2 | BP[3:0]                              | See Protected Area tables             | <b>Nonvolatile control bit:</b> Defines memory to be software protected against PROGRAM or ERASE operations. When one or more block protect bits is set to 1, a designated memory area is protected from PROGRAM and ERASE operations.    | 1     |
| 1      | Write enable latch                   | 0 = Clear (default)<br>1 = Set        | <b>Volatile control bit:</b> The device always powers up with this bit cleared to prevent inadvertent WRITE, PROGRAM, or ERASE operations. To enable these operations, the WRITE ENABLE operation must be executed first to set this bit. |       |
| 0      | Write in progress                    | 0 = Ready<br>1 = Busy                 | <b>Status bit:</b> Indicates if one of the following command cycles is in progress:<br>WRITE STATUS REGISTER<br>WRITE NONVOLATILE CONFIGURATION REGISTER<br>PROGRAM<br>ERASE                                                              | 2     |

- Notes:
1. The DIE ERASE command is executed only if all bits = 0.
  2. Status register bit 0 is the inverse of flag status register bit 7.

## Block Protection Settings

**Table 4: Protected Area**

| Status Register Content |     |     |     |     | Protected Area |
|-------------------------|-----|-----|-----|-----|----------------|
| Top/Bottom              | BP3 | BP2 | BP1 | BP0 | 64KB Sectors   |
| 0                       | 0   | 0   | 0   | 0   | None           |
| 0                       | 0   | 0   | 0   | 1   | 1023:1023      |
| 0                       | 0   | 0   | 1   | 0   | 1023:1022      |
| 0                       | 0   | 0   | 1   | 1   | 1023:1020      |
| 0                       | 0   | 1   | 0   | 0   | 1023:1016      |
| 0                       | 0   | 1   | 0   | 1   | 1023:1008      |
| 0                       | 0   | 1   | 1   | 0   | 1023:992       |
| 0                       | 0   | 1   | 1   | 1   | 1023:960       |
| 0                       | 1   | 0   | 0   | 0   | 1023:896       |
| 0                       | 1   | 0   | 0   | 1   | 1023:768       |
| 0                       | 1   | 0   | 1   | 0   | 1023:512       |
| 0                       | 1   | 0   | 1   | 1   | 1023:0         |
| 0                       | 1   | 1   | 0   | 0   | 1023:0         |
| 0                       | 1   | 1   | 0   | 1   | 1023:0         |
| 0                       | 1   | 1   | 1   | 0   | 1023:0         |
| 0                       | 1   | 1   | 1   | 1   | 1023:0         |
| 1                       | 0   | 0   | 0   | 0   | None           |
| 1                       | 0   | 0   | 0   | 1   | 0:0            |
| 1                       | 0   | 0   | 1   | 0   | 1:0            |
| 1                       | 0   | 0   | 1   | 1   | 3:0            |
| 1                       | 0   | 1   | 0   | 0   | 7:0            |
| 1                       | 0   | 1   | 0   | 1   | 15:0           |
| 1                       | 0   | 1   | 1   | 0   | 31:0           |
| 1                       | 0   | 1   | 1   | 1   | 63:0           |
| 1                       | 1   | 0   | 0   | 0   | 127:0          |
| 1                       | 1   | 0   | 0   | 1   | 255:0          |
| 1                       | 1   | 0   | 1   | 0   | 511:0          |
| 1                       | 1   | 0   | 1   | 1   | 1023:0         |
| 1                       | 1   | 1   | 0   | 0   | 1023:0         |
| 1                       | 1   | 1   | 0   | 1   | 1023:0         |
| 1                       | 1   | 1   | 1   | 0   | 1023:0         |
| 1                       | 1   | 1   | 1   | 1   | 1023:0         |

## Flag Status Register

Flag status register bits are read by using READ FLAG STATUS REGISTER command. All bits are volatile and are reset to zero on power-up.

Status bits are set and reset automatically by the internal controller. Error bits must be cleared through the CLEAR STATUS REGISTER command.

**Table 5: Flag Status Register**

| Bit | Name                        | Settings                                       | Description                                                                                                                                                                                        |
|-----|-----------------------------|------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | Program or erase controller | 0 = Busy<br>1 = Ready                          | <b>Status bit:</b> Indicates whether one of the following command cycles is in progress: WRITE STATUS REGISTER, WRITE NONVOLATILE CONFIGURATION REGISTER, PROGRAM, or ERASE.                       |
| 6   | Erase suspend               | 0 = Clear<br>1 = Suspend                       | <b>Status bit:</b> Indicates whether an ERASE operation has been or is going to be suspended.                                                                                                      |
| 5   | Erase                       | 0 = Clear<br>1 = Failure or protection error   | <b>Error bit:</b> Indicates whether an ERASE operation has succeeded or failed.                                                                                                                    |
| 4   | Program                     | 0 = Clear<br>1 = Failure or protection error   | <b>Error bit:</b> Indicates whether a PROGRAM operation has succeeded or failed. It indicates, also, whether a CRC check has succeeded or failed.                                                  |
| 3   | Reserved                    | 0                                              | Reserved                                                                                                                                                                                           |
| 2   | Program suspend             | 0 = Clear<br>1 = Suspend                       | <b>Status bit:</b> Indicates whether a PROGRAM operation has been or is going to be suspended.                                                                                                     |
| 1   | Protection                  | 0 = Clear<br>1 = Failure or protection error   | <b>Error bit:</b> Indicates whether an ERASE or PROGRAM operation has attempted to modify the protected array sector, or whether a PROGRAM operation has attempted to access the locked OTP space. |
| 0   | Addressing                  | 0 = 3-byte addressing<br>1 = 4-byte addressing | <b>Status bit:</b> Indicates whether 3-byte or 4-byte address mode is enabled.                                                                                                                     |

## Extended Address Register

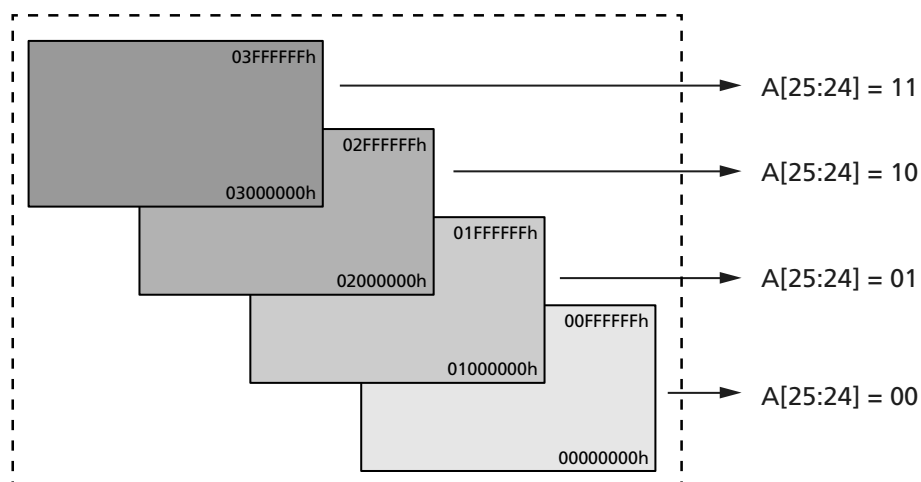
The 3-byte address mode can only access 128Mb of memory. To access the full device in 3-byte address mode, the device includes an extended address register that indirectly provides a fourth address byte A[31:24]. The extended address register bits [1:0] operate as memory address bit A[25:24] to select one of the four 128Mb segments of the memory array.

If 4-byte addressing is enabled, the extended address register settings are ignored.

**Table 6: Extended Address Register**

| Bit | Name     | Settings                                                                                                                   | Description                                                                                                                                                             |
|-----|----------|----------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:2 | A[31:26] | 000000                                                                                                                     | Reserved                                                                                                                                                                |
| 1:0 | A[25:24] | 11 = Highest 128Mb segment<br>10 = Third 128Mb segment<br>01 = Second 128Mb segment<br>00 = Lowest 128Mb segment (default) | Enables specified 128Mb memory segment. The default (lowest) setting can be changed to the highest 128Mb segment using bit 1 of the nonvolatile configuration register. |

**Figure 12: Memory Array Segments**



The PROGRAM and ERASE operations act upon the 128Mb segment selected in the extended address register. The BULK ERASE operation erases the entire device.

The READ operation begins reading in the selected 128Mb segment, but is not bound by it.

In a continuous READ, when the last byte of the segment is read, the next byte output is the first byte of the next segment. The operation wraps to 00000000h; therefore, a download of the whole array is possible with one READ operation.

The value of the extended address register does not change when a READ operation crosses the selected 128Mb boundary.

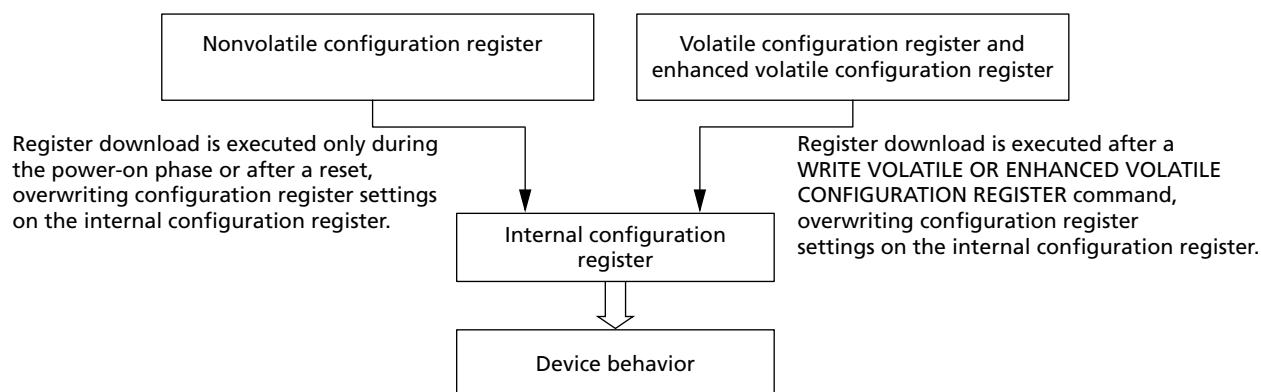
## Internal Configuration Register

The memory configuration is set by an internal configuration register that is not directly accessible to users.

The user can change the default configuration at power up by using the WRITE NON-VOLATILE CONFIGURATION REGISTER. Information from the nonvolatile configuration register overwrites the internal configuration register during power-on or after a reset.

The user can change the configuration during operation by using the WRITE VOLATILE CONFIGURATION REGISTER or the WRITE ENHANCED VOLATILE CONFIGURATION REGISTER commands. Information from the volatile configuration registers overwrite the internal configuration register immediately after the WRITE command completes.

**Figure 13: Internal Configuration Register**



## Nonvolatile Configuration Register

This register is read from and written to using the READ NONVOLATILE CONFIGURATION REGISTER and the WRITE NONVOLATILE CONFIGURATION REGISTER commands, respectively. A register download is executed during power-on or after reset, overwriting the internal configuration register settings that determine device behavior.

A WRITE NONVOLATILE CONFIGURATION REGISTER command to a reserved setting is ignored, flag status register bit 1 is set, and the write enable latch bit is cleared.

**Table 7: Nonvolatile Configuration Register**

| Bit   | Name                          | Settings                                                                                                                                                                                                                       | Description                                                                                                                         | Notes |
|-------|-------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------|-------|
| 15:12 | Number of dummy clock cycles  | 0000 = Identical to 1111<br>0001 = 1<br>0010 = 2<br>:<br>1101 = 13<br>1110 = 14<br>1111 = Default                                                                                                                              | Sets the number of dummy clock cycles subsequent to all FAST READ commands. (See the Command Set Table for default setting values.) | 1     |
| 11:9  | XIP mode at power-on reset    | 000 = XIP: Fast read<br>001 = XIP: Dual output fast read<br>010 = XIP: Dual I/O fast read<br>011 = XIP: Quad output fast read<br>100 = XIP: Quad I/O fast read<br>101 = Reserved<br>110 = Reserved<br>111 = Disabled (default) | Enables the device to operate in the selected XIP mode immediately after power-on reset.                                            |       |
| 8:6   | Output driver strength        | 000 = Reserved<br>001 = 90 ohms<br>010 = Reserved<br>011 = 45 ohms<br>100 = Reserved<br>101 = 20 ohms<br>110 = Reserved<br>111 = 30 ohms (default)                                                                             | Optimizes the impedance at $V_{CC}/2$ output voltage.                                                                               |       |
| 5     | Double transfer rate protocol | 0 = Enabled<br>1 = Disabled (default)                                                                                                                                                                                          | Set DTR protocol as current one. Once enabled, all commands will work in DTR.                                                       |       |
| 4     | Reset/hold                    | 0 = Disabled<br>1 = Enabled (default)                                                                                                                                                                                          | Enables or disables HOLD# or RESET# on DQ3.                                                                                         |       |
| 3     | Quad I/O protocol             | 0 = Enabled<br>1 = Disabled (default)                                                                                                                                                                                          | Enables or disables quad I/O command input (4-4-4 mode).                                                                            | 2     |
| 2     | Dual I/O protocol             | 0 = Enabled<br>1 = Disabled (default)                                                                                                                                                                                          | Enables or disables dual I/O command input (2-2-2 mode).                                                                            | 2     |
| 1     | 128Mb segment select          | 0 = Highest 128Mb segment<br>1 = Lowest 128Mb segment (default)                                                                                                                                                                | Selects the power-on default 128Mb segment for 3-byte address operations. See also the extended address register.                   |       |

**Table 7: Nonvolatile Configuration Register (Continued)**

| Bit | Name                                         | Settings                                                                   | Description                                        | Notes |
|-----|----------------------------------------------|----------------------------------------------------------------------------|----------------------------------------------------|-------|
| 0   | Number of address bytes during command entry | 0 = Enable 4-byte address mode<br>1 = Enable 3-byte address mode (default) | Defines the number of address bytes for a command. |       |

- Notes:
1. The number of cycles must be set to accord with the clock frequency, which varies by the type of FAST READ command (See Supported Clock Frequencies table). Insufficient dummy clock cycles for the operating frequency causes the memory to read incorrect data.
  2. When bits 2 and 3 are both set to 0, the device operates in quad I/O protocol.

## Volatile Configuration Register

This register is read from and written to by the READ VOLATILE CONFIGURATION REGISTER and the WRITE VOLATILE CONFIGURATION REGISTER commands, respectively. A register download is executed after these commands, overwriting the internal configuration register settings that determine device memory behavior.

**Table 8: Volatile Configuration Register**

| Bit | Name                         | Settings                                                                                                                     | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Notes |
|-----|------------------------------|------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|
| 7:4 | Number of dummy clock cycles | 0000 = Identical to 1111<br>0001 = 1<br>0010 = 2<br>:<br>1101 = 13<br>1110 = 14<br>1111 = Default                            | Sets the number of dummy clock cycles subsequent to all FAST READ commands.<br>(See the Command Set Table for default setting values.)                                                                                                                                                                                                                                                                                                                                       | 1     |
| 3   | XIP                          | 0 = Enable<br>1 = Disable (default)                                                                                          | Enables or disables XIP.                                                                                                                                                                                                                                                                                                                                                                                                                                                     |       |
| 2   | Reserved                     | 0                                                                                                                            | 0b = Fixed value.                                                                                                                                                                                                                                                                                                                                                                                                                                                            |       |
| 1:0 | Wrap                         | 00 = 16-byte boundary aligned<br>01 = 32-byte boundary aligned<br>10 = 64-byte boundary aligned<br>11 = Continuous (default) | 16-byte wrap: Output data wraps within an aligned 16-byte boundary starting from the 3-byte address issued after the command code.<br>32-byte wrap: Output data wraps within an aligned 32-byte boundary starting from the 3-byte address issued after the command code.<br>64-byte wrap: Output data wraps within an aligned 64-byte boundary starting from the 3-byte address issued after the command code.<br>Continuously sequences addresses through the entire array. | 2     |

- Notes:
1. The number of cycles must be set according to and sufficient for the clock frequency, which varies by the type of FAST READ command, as shown in the Supported Clock Frequencies table. An insufficient number of dummy clock cycles for the operating frequency causes the memory to read incorrect data.
  2. See the Sequence of Bytes During Wrap table.

**Table 9: Sequence of Bytes During Wrap**

| Starting Address | 16-Byte Wrap                   | 32-Byte Wrap                   | 64-Byte Wrap                 |
|------------------|--------------------------------|--------------------------------|------------------------------|
| 0                | 0-1-2- . . . -15-0-1- . .      | 0-1-2- . . . -31-0-1- . .      | 0-1-2- . . . -63-0-1- . .    |
| 1                | 1-2- . . . -15-0-1-2- . .      | 1-2- . . . -31-0-1-2- . .      | 1-2- . . . -63-0-1-2- . .    |
| ....             | ....                           | ....                           | ....                         |
| 15               | 15-0-1-2-3- . . . -15-0-1- . . | 15-16-17- . . . -31-0-1- . .   | 15-16-17- . . . -63-0-1- . . |
| ....             | ....                           | ....                           | ....                         |
| 31               | —                              | 31-0-1-2-3- . . . -31-0-1- . . | 31-32-33- . . . -63-0-1- . . |
| ....             | ....                           | ....                           | ....                         |
| 63               | —                              | —                              | 63-0-1- . . . -63-0-1- . .   |

## Supported Clock Frequencies

**Table 10: Clock Frequencies – STR (in MHz)**

Note 1 applies to entire table

| Number of Dummy Clock Cycles | FAST READ | DUAL OUTPUT FAST READ | DUAL I/O FAST READ | QUAD OUTPUT FAST READ | QUAD I/O FAST READ |
|------------------------------|-----------|-----------------------|--------------------|-----------------------|--------------------|
| 1                            | 94        | 79                    | 60                 | 44                    | 39                 |
| 2                            | 112       | 97                    | 77                 | 61                    | 48                 |
| 3                            | 129       | 106                   | 86                 | 78                    | 58                 |
| 4                            | 133       | 115                   | 97                 | 97                    | 69                 |
| 5                            | 133       | 125                   | 106                | 106                   | 78                 |
| 6                            | 133       | 133                   | 115                | 115                   | 86                 |
| 7                            | 133       | 133                   | 125                | 125                   | 97                 |
| 8                            | 133       | 133                   | 133                | 133                   | 106                |
| 9                            | 133       | 133                   | 133                | 133                   | 115                |
| 10                           | 133       | 133                   | 133                | 133                   | 125                |
| 11 : 14                      | 133       | 133                   | 133                | 133                   | 133                |

Note: 1. Values are guaranteed by characterization and not 100% tested in production.

**Table 11: Clock Frequencies – DTR (in MHz)**

Notes apply to entire table

| Number of Dummy Clock Cycles | FAST READ | DUAL OUTPUT FAST READ | DUAL I/O FAST READ | QUAD OUTPUT FAST READ | QUAD I/O FAST READ |
|------------------------------|-----------|-----------------------|--------------------|-----------------------|--------------------|
| 1                            | 59        | 45                    | 40                 | 26                    | 20                 |
| 2                            | 73        | 59                    | 49                 | 40                    | 30                 |
| 3                            | 82        | 68                    | 59                 | 59                    | 39                 |
| 4                            | 90        | 76                    | 65                 | 65                    | 49                 |
| 5                            | 90        | 83                    | 75                 | 75                    | 58                 |
| 6                            | 90        | 90                    | 83                 | 83                    | 68                 |
| 7                            | 90        | 90                    | 90                 | 90                    | 78                 |
| 8                            | 90        | 90                    | 90                 | 90                    | 85                 |
| 9                            | 90        | 90                    | 90                 | 90                    | 90                 |
| 10 :14                       | 90        | 90                    | 90                 | 90                    | 90                 |

- Notes:
1. Values are guaranteed by characterization and not 100% tested in production.
  2. A tuning data pattern (TDP) capability provides applications with data patterns for adjusting the data latching point at the host end when the clock frequency is set higher than 133 MHz in STR mode and higher than 66 MHz in double transfer rate (DTR) mode. For additional details, refer to TN-25-07: Tuning Data Pattern for MT25Q and MT25T Devices.

## Enhanced Volatile Configuration Register

This register is read from and written to using the READ ENHANCED VOLATILE CONFIGURATION REGISTER and the WRITE ENHANCED VOLATILE CONFIGURATION REGISTER commands, respectively. A register download is executed after these commands, overwriting the internal configuration register settings that determine device memory behavior.

**Table 12: Enhanced Volatile Configuration Register**

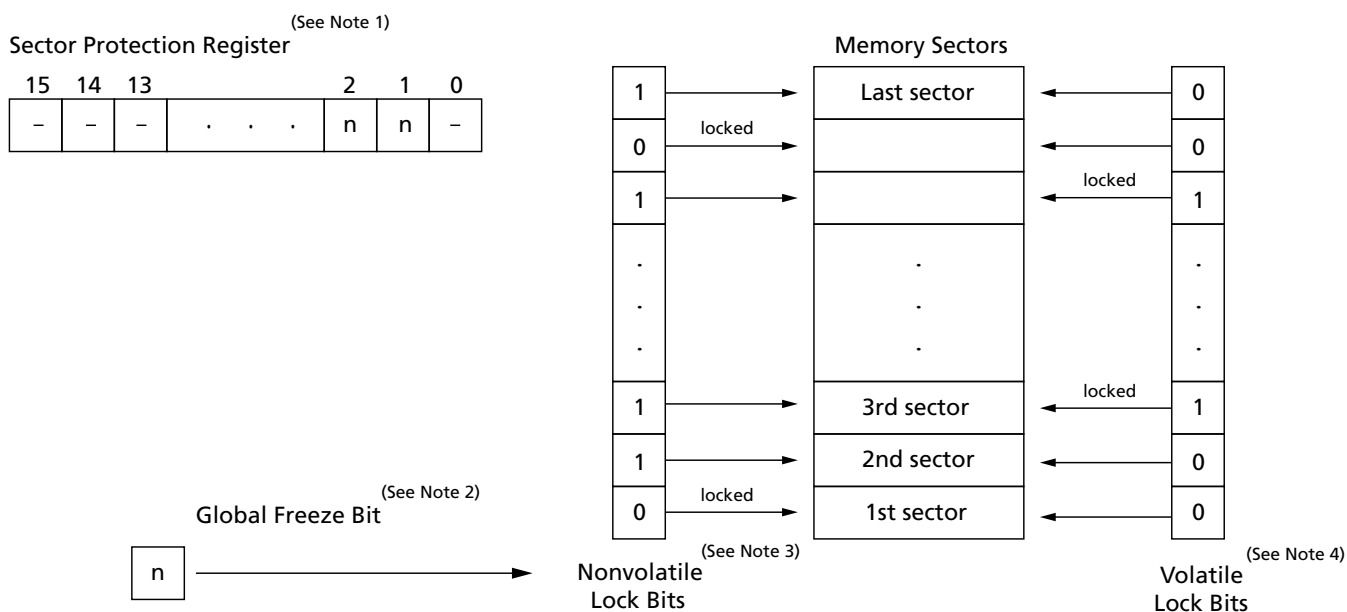
| Bit | Name                          | Settings                                                                                                                                           | Description                                                                             | Notes |
|-----|-------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------|-------|
| 7   | Quad I/O protocol             | 0 = Enabled<br>1 = Disabled (default)                                                                                                              | Enables or disables quad I/O command input (4-4-4 mode).                                | 1     |
| 6   | Dual I/O protocol             | 0 = Enabled<br>1 = Disabled (default)                                                                                                              | Enables or disables dual I/O command input (2-2-2 mode).                                | 1     |
| 5   | Double transfer rate protocol | 0 = Enabled<br>1 = Disabled (Default, single transfer rate)                                                                                        | Set DTR protocol as current one. Once enabled, all commands will work in DTR.           |       |
| 4   | Reset/hold                    | 0 = Disabled<br>1 = Enabled (default)                                                                                                              | Enables or disables HOLD# or RESET# on DQ3. (Available only on specified part numbers.) |       |
| 3   | Reserved                      | 1                                                                                                                                                  |                                                                                         |       |
| 2:0 | Output driver strength        | 000 = Reserved<br>001 = 90 ohms<br>010 = Reserved<br>011 = 45 ohms<br>100 = Reserved<br>101 = 20 ohms<br>110 = Reserved<br>111 = 30 ohms (default) | Optimizes the impedance at $V_{CC}/2$ output voltage.                                   |       |

Note: 1. When bits 6 and 7 are both set to 0, the device operates in quad I/O protocol. When either bit 6 or 7 is set to 0, the device operates in dual I/O or quad I/O respectively. When a bit is set, the device enters the selected protocol immediately after the WRITE ENHANCED VOLATILE CONFIGURATION REGISTER command. The device returns to the default protocol after the next power-on or reset. Also, the rescue sequence or another WRITE ENHANCED VOLATILE CONFIGURATION REGISTER command will return the device to the default protocol.

## Security Registers

Security registers enable sector and password protection on multiple levels using non-volatile and volatile register and bit settings (shown below). The applicable register tables follow.

**Figure 14: Sector and Password Protection**



- Notes:
- Sector protection register.** This 16-bit nonvolatile register includes two active bits[2:1] to enable sector and password protection.
  - Global freeze bit.** This volatile bit protects the settings in all nonvolatile lock bits.
  - Nonvolatile lock bits.** Each nonvolatile bit corresponds to and provides nonvolatile protection for an individual memory sector, which remains locked (protection enabled) until its corresponding bit is cleared to 1.
  - Volatile lock bits.** Each volatile bit corresponds to and provides volatile protection for an individual memory sector, which is locked temporarily (protection is cleared when the device is reset or powered down).
  - The first and last sectors will have volatile protections at the 4KB subsector level. Each 4KB subsector in these sectors can be individually locked by volatile lock bits setting; nonvolatile protections granularity remain at the sector level.

## Sector Protection Security Register

**Table 13: Sector Protection Register**

| Bits | Name                     | Settings                                                                                    | Description                                                                                                                                                                                                                                                                                                                                                              | Notes   |
|------|--------------------------|---------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|
| 15:3 | Reserved                 | 1 = Default                                                                                 | —                                                                                                                                                                                                                                                                                                                                                                        |         |
| 2    | Password protection lock | 1 = Disabled (default)<br>0 = Enabled                                                       | <b>Nonvolatile bit:</b> When set to 1, password protection is disabled. When set to 0, password protection is enabled permanently; the 64-bit password cannot be retrieved or reset.                                                                                                                                                                                     | 1, 2    |
| 1    | Sector protection lock   | 1 = Enabled, with password protection (default)<br>0 = Enabled, without password protection | <b>Nonvolatile bit:</b> When set to 1, nonvolatile lock bits can be set to lock/unlock their corresponding memory sectors; bit 2 can be set to 0, enabling password protection permanently.<br>When set to 0, nonvolatile lock bits can be set to lock/unlock their corresponding memory sectors; bit 2 must remain set to 1, disabling password protection permanently. | 1, 3, 4 |
| 0    | Reserved                 | 1 = Default                                                                                 | —                                                                                                                                                                                                                                                                                                                                                                        |         |

- Notes:
- Bits 2 and 1 are user-configurable, one-time-programmable, and mutually exclusive in that only one of them can be set to 0. It is recommended that one of the bits be set to 0 when first programming the device.
  - The 64-bit password must be programmed and verified before this bit is set to 0 because after it is set, password changes are not allowed, thus providing protection from malicious software. When this bit is set to 0, a 64-bit password is required to reset the global freeze bit from 0 to 1. In addition, if the password is incorrect or lost, the global freeze bit can no longer be set and nonvolatile lock bits cannot be changed. (See the Sector and Password Protection figure and the Global Freeze Bit Definition table).
  - Whether this bit is set to 1 or 0, it enables programming or erasing nonvolatile lock bits (which provide memory sector protection). The password protection bit must be set beforehand because setting this bit will either enable password protection permanently (bit 2 = 0) or disable password protection permanently (bit 1 = 0).
  - By default, all sectors are unlocked when the device is shipped from the factory. Sectors are locked, unlocked, read, or locked down as explained in the Nonvolatile and Volatile Lock Bits table and the Volatile Lock Bit Register Bit Definitions table.

**Table 14: Global Freeze Bit**

| Bits | Name              | Settings                              | Description                                                                                                                                                                                                                                                                                              |
|------|-------------------|---------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:1  | Reserved          | 0                                     | Bit values are 0                                                                                                                                                                                                                                                                                         |
| 0    | Global freeze bit | 1 = Disabled (default)<br>0 = Enabled | <b>Volatile bit:</b> When set to 1, all nonvolatile lock bits can be set to enable or disable locking their corresponding memory sectors.<br>When set to 0, nonvolatile lock bits are protected from PROGRAM or ERASE commands. This bit should not be set to 0 until the nonvolatile lock bits are set. |

- Note:
- The READ GLOBAL FREEZE BIT command enables reading this bit. When password protection is enabled, this bit is locked upon device power-up or reset. It cannot be changed without the password. After the password is entered, the UNLOCK PASSWORD command resets this bit to 1, enabling programming or erasing the nonvolatile lock bits. After the bits are changed, the WRITE GLOBAL FREEZE BIT command sets this bit to 0, protecting the nonvolatile lock bits from PROGRAM or ERASE operations.

## Nonvolatile and Volatile Sector Lock Bits Security

**Table 15: Nonvolatile and Volatile Lock Bits**

| Bit Details          | Nonvolatile Lock Bit                                                                                                                                                                                               | Volatile Lock Bit                                                                                                                                                                                                                        |
|----------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Description          | Each sector of memory has one corresponding non-volatile lock bit                                                                                                                                                  | Each sector of memory has one corresponding volatile lock bit; this bit is the sector write lock bit described in the Volatile Lock Bit Register table.                                                                                  |
| Function             | When set to 0, locks and protects its corresponding memory sector from PROGRAM or ERASE operations. Because this bit is nonvolatile, the sector remains locked, protection enabled, until the bit is cleared to 1. | When set to 1, locks and protects its corresponding memory sector from PROGRAM or ERASE operations. Because this bit is volatile, protection is temporary. The sector is unlocked, protection disabled, upon device reset or power-down. |
| Settings             | 1 = Lock disabled<br>0 = Lock enabled                                                                                                                                                                              | 0 = Lock disabled<br>1 = Lock enabled                                                                                                                                                                                                    |
| Enabling protection  | The bit is set to 0 by the WRITE NONVOLATILE LOCK BITS command, enabling protection for designated locked sectors. Programming a sector lock bit requires the typical byte programming time.                       | The bit is set to 1 by the WRITE VOLATILE LOCK BITS command, enabling protection for designated locked sectors.                                                                                                                          |
| Disabling protection | All bits are cleared to 1 by the ERASE NONVOLATILE LOCK BITS command, unlocking and disabling protection for all sectors simultaneously. Erasing all sector lock bits requires typical sector erase time.          | All bits are set to 0 upon reset or power-down, unlocking and disabling protection for all sectors.                                                                                                                                      |
| Reading the bit      | Bits are read by the READ NONVOLATILE LOCK BITS command.                                                                                                                                                           | Bits are read by the READ VOLATILE LOCK BITS command.                                                                                                                                                                                    |

## Volatile Lock Bit Security Register

One volatile lock bit register is associated with each sector of memory. It enables the sector to be locked, unlocked, or locked-down with the WRITE VOLATILE LOCK BITS command, which executes only when sector lock down (bit 1) is set to 0. Each register can be read with the READ VOLATILE LOCK BITS command. This register is compatible with and provides the same locking capability as the lock register in the Micron N25Q SPI NOR family.

**Table 16: Volatile Lock Bit Register**

| Bit | Name              | Settings                                                    | Description                                                                                                                                                                                                                                                                       |
|-----|-------------------|-------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:2 | Reserved          | 0                                                           | Bit values are 0.                                                                                                                                                                                                                                                                 |
| 1   | Sector lock down  | 0 = Lock-down disabled (default)<br>1 = Lock-down enabled   | <b>Volatile bit:</b> Device always powers up with this bit set to 0 so that sector lock down and sector write lock bits can be set to 1. When this bit set to 1, neither of the two volatile lock bits can be written to until the next power cycle, hardware, or software reset. |
| 0   | Sector write lock | 0 = Write lock disabled (default)<br>1 = Write lock enabled | <b>Volatile bit:</b> Device always powers up with this bit set to 0 so that PROGRAM and ERASE operations in this sector can be executed and sector content modified. When this bit is set to 1, PROGRAM and ERASE operations in this sector are not executed.                     |

## Device ID Data

The device ID data shown in the tables here is read by the READ ID and MULTIPLE I/O READ ID operations. The tables below apply to each of the 2 dies the product is composed of.

**Table 17: Device ID Data**

| Byte#                          | Name                                                | Content Value                      | Assigned By  |
|--------------------------------|-----------------------------------------------------|------------------------------------|--------------|
| Manufacturer ID (1 Byte total) |                                                     |                                    |              |
| 1                              | Manufacturer ID (1 Byte)                            | 20h                                | JEDEC        |
| Device ID (2 Bytes total)      |                                                     |                                    |              |
| 2                              | Memory Type (1 Byte)                                | BAh = 3V                           | Manufacturer |
| 3                              | Memory Capacity (1 Byte)                            | 20h = 512Mb                        |              |
|                                |                                                     | 19h = 256Mb                        |              |
|                                |                                                     | 18h = 128Mb                        |              |
| Unique ID (17 Bytes total)     |                                                     |                                    |              |
| 4                              | Indicates the number of remaining ID bytes (1 Byte) | 10h                                | Factory      |
| 5                              | Extended device ID (1 Byte)                         | See Extended Device ID First Byte  |              |
| 6                              | Device configuration information (1 Bytes)          | See Extended Device ID Second Byte |              |
| 7:20                           | Customized factory data (14 Bytes)                  | Unique ID code (UID)               |              |

**Table 18: Extended Device ID Data, First Byte**

| Bit 7    | Bit 6                                   | Bit 5 <sup>1</sup>                                | Bit 4    | Bit 3                                  | Bit 2 <sup>2</sup>                                          | Bit 1                                | Bit 0 |
|----------|-----------------------------------------|---------------------------------------------------|----------|----------------------------------------|-------------------------------------------------------------|--------------------------------------|-------|
| Reserved | Device Generation<br>1 = 2nd generation | 1 = Alternate BP scheme<br>0 = Standard BP scheme | Reserved | HOLD#/RESET#:<br>0 = HOLD<br>1 = RESET | Additional HW RESET#:<br>1 = Available<br>0 = Not available | Sector size:<br>00 = Uniform<br>64KB |       |

- Notes: 1. For alternate BP scheme information, contact the factory.  
2. Available for specific part numbers. See Part Number Ordering Information for details.

**Table 19: Extended Device ID, Second Byte**

| Bit 7        | Bit 6        | Bit 5        | Bit 4        | Bit 3        | Bit 2        | Bit 1                                               | Bit 0 |
|--------------|--------------|--------------|--------------|--------------|--------------|-----------------------------------------------------|-------|
| Reserved = 0 | Reserved = 0 | Reserved = 0 | Reserved = 0 | Reserved = 0 | Reserved = 0 | CS#/CLK option:<br>01 = 1CS#/1CLK<br>10 = 2CS#/2CLK |       |

## Serial Flash Discovery Parameter Data

The serial Flash discovery parameter (SFDP) provides a standard, consistent method to describe serial Flash device functions and features using internal parameter tables. The parameter tables can be interrogated by host system software, enabling adjustments to accommodate divergent features from multiple vendors. The SFDP standard defines a common parameter table that describes important device characteristics and serial access methods used to read the parameter table data.

Micron's SFDP table information aligns with JEDEC-standard JESD216 for serial Flash discoverable parameters. The latest JEDEC standard includes revision 1.6. Beginning week 42 (2014), Micron's MT25Q production parts will include SFDP data that aligns with revision 1.6.

Refer to JEDEC-standard JESD216B for a complete overview of the SFDP table definition.

Data in the SFDP tables is read by the READ SERIAL FLASH DISCOVERY PARAMETER operation.

See Micron TN-25-06: Serial Flash Discovery Parameters for MT25Q Family for serial Flash discovery parameter data.

# Command Definitions

**Table 20: Command Set**

Notes 1 and 2 apply to the entire table

| Command                                    | Code   | Command-Address-Data |          |          | Address Bytes | Dummy Clock Cycles |          |          | Data Bytes | Notes |
|--------------------------------------------|--------|----------------------|----------|----------|---------------|--------------------|----------|----------|------------|-------|
|                                            |        | Extended SPI         | Dual SPI | Quad SPI |               | Extended SPI       | Dual SPI | Quad SPI |            |       |
| Software RESET Operations                  |        |                      |          |          |               |                    |          |          |            |       |
| RESET ENABLE                               | 66h    | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –     |
| RESET MEMORY                               | 99h    | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –     |
| READ ID Operations                         |        |                      |          |          |               |                    |          |          |            |       |
| READ ID                                    | 9E/9Fh | 1-0-1                |          |          | 0             | 0                  |          |          | 1 to 20    | –     |
| MULTIPLE I/O READ ID                       | AFh    | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1 to 20    | –     |
| READ SERIAL FLASH DISCOVERY<br>PARAMETER   | 5Ah    | 1-1-1                | 2-2-2    | 4-4-4    | 3             | 8                  | 8        | 8        | 1 to ∞     | 3     |
| READ MEMORY Operations                     |        |                      |          |          |               |                    |          |          |            |       |
| READ                                       | 03h    | 1-1-1                |          |          | 3(4)          | 0                  | 0        | 0        | 1 to ∞     | 4     |
| FAST READ                                  | 0Bh    | 1-1-1                | 2-2-2    | 4-4-4    | 3(4)          | 8                  | 8        | 10       | 1 to ∞     | 4, 5  |
| DUAL OUTPUT FAST READ                      | 3Bh    | 1-1-2                | 2-2-2    |          | 3(4)          | 8                  | 8        |          | 1 to ∞     | 4, 5  |
| DUAL INPUT/OUTPUT FAST READ                | BBh    | 1-2-2                | 2-2-2    |          | 3(4)          | 8                  | 8        |          | 1 to ∞     | 4, 5  |
| QUAD OUTPUT FAST READ                      | 6Bh    | 1-1-4                |          | 4-4-4    | 3(4)          | 8                  |          | 10       | 1 to ∞     | 4, 5  |
| QUAD INPUT/OUTPUT FAST READ                | EBh    | 1-4-4                |          | 4-4-4    | 3(4)          | 10                 |          | 10       | 1 to ∞     | 4, 5  |
| DTR FAST READ                              | 0Dh    | 1-1-1                | 2-2-2    | 4-4-4    | 3(4)          | 6                  | 6        | 8        | 1 to ∞     | 4, 5  |
| DTR DUAL OUTPUT FAST READ                  | 3Dh    | 1-1-2                | 2-2-2    |          | 3(4)          | 6                  | 6        |          | 1 to ∞     | 4, 5  |
| DTR DUAL INPUT/OUTPUT FAST<br>READ         | BDh    | 1-2-2                | 2-2-2    |          | 3(4)          | 6                  | 6        |          | 1 to ∞     | 4, 5  |
| DTR QUAD OUTPUT FAST READ                  | 6Dh    | 1-1-4                |          | 4-4-4    | 3(4)          | 6                  |          | 8        | 1 to ∞     | 4, 5  |
| DTR QUAD INPUT/OUTPUT FAST<br>READ         | EDh    | 1-4-4                |          | 4-4-4    | 3(4)          | 8                  |          | 8        | 1 to ∞     | 4, 5  |
| QUAD INPUT/OUTPUT WORD<br>READ             | E7h    | 1-4-4                |          | 4-4-4    | 3(4)          | 4                  |          | 4        | 1 to ∞     | 4     |
| READ MEMORY Operations with 4-Byte Address |        |                      |          |          |               |                    |          |          |            |       |
| 4-BYTE READ                                | 13h    | 1-1-1                |          |          | 4             | 0                  | 0        | 0        | 1 to ∞     | 5     |
| 4-BYTE FAST READ                           | 0Ch    | 1-1-1                | 2-2-2    | 4-4-4    | 4             | 8                  | 8        | 10       | 1 to ∞     | 5     |
| 4-BYTE DUAL OUTPUT FAST READ               | 3Ch    | 1-1-2                | 2-2-2    |          | 4             | 8                  | 8        |          | 1 to ∞     | 5     |

**Table 20: Command Set (Continued)**

Notes 1 and 2 apply to the entire table

| Command                                       | Code | Command-Address-Data |          |          | Address Bytes | Dummy Clock Cycles |          |          | Data Bytes | Notes |
|-----------------------------------------------|------|----------------------|----------|----------|---------------|--------------------|----------|----------|------------|-------|
|                                               |      | Extended SPI         | Dual SPI | Quad SPI |               | Extended SPI       | Dual SPI | Quad SPI |            |       |
| 4-BYTE DUAL INPUT/OUTPUT FAST READ            | BCh  | 1-2-2                | 2-2-2    |          | 4             | 8                  | 8        |          | 1 to ∞     | 5     |
| 4-BYTE QUAD OUTPUT FAST READ                  | 6Ch  | 1-1-4                |          | 4-4-4    | 4             | 8                  |          | 10       | 1 to ∞     | 5     |
| 4-BYTE QUAD INPUT/OUTPUT FAST READ            | ECh  | 1-4-4                |          | 4-4-4    | 4             | 10                 |          | 10       | 1 to ∞     | 5     |
| 4-BYTE DTR FAST READ                          | 0Eh  | 1-1-1                | 2-2-2    | 4-4-4    | 4             | 6                  | 6        | 8        | 1 to ∞     | 5     |
| 4-BYTE DTR DUAL INPUT/OUTPUT FAST READ        | BEh  | 1-2-2                | 2-2-2    |          | 4             | 6                  | 6        |          | 1 to ∞     | 5     |
| 4-BYTE DTR QUAD INPUT/OUTPUT FAST READ        | EEh  | 1-4-4                |          | 4-4-4    | 4             | 8                  |          | 8        | 1 to ∞     | 5     |
| <b>WRITE Operations</b>                       |      |                      |          |          |               |                    |          |          |            |       |
| WRITE ENABLE                                  | 06h  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –     |
| WRITE DISABLE                                 | 04h  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –     |
| <b>READ REGISTER Operations</b>               |      |                      |          |          |               |                    |          |          |            |       |
| READ STATUS REGISTER                          | 05h  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1 to ∞     | –     |
| READ FLAG STATUS REGISTER                     | 70h  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1 to ∞     | –     |
| READ NONVOLATILE CONFIGURATION REGISTER       | B5h  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 2 to ∞     | –     |
| READ VOLATILE CONFIGURATION REGISTER          | 85h  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1 to ∞     | –     |
| READ ENHANCED VOLATILE CONFIGURATION REGISTER | 65h  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1 to ∞     | –     |
| READ EXTENDED ADDRESS REGISTER                | C8h  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1 to ∞     | –     |
| READ GENERAL PURPOSE READ REGISTER            | 96h  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 8                  | 8        | 8        | 1 to ∞     | 6, 7  |
| <b>WRITE REGISTER Operations</b>              |      |                      |          |          |               |                    |          |          |            |       |
| WRITE STATUS REGISTER                         | 01h  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1          | 8     |
| WRITE NONVOLATILE CONFIGURATION REGISTER      | B1h  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 2          | 8     |

**Table 20: Command Set (Continued)**

Notes 1 and 2 apply to the entire table

| Command                                        | Code    | Command-Address-Data |          |          | Address Bytes | Dummy Clock Cycles |          |          | Data Bytes | Notes |
|------------------------------------------------|---------|----------------------|----------|----------|---------------|--------------------|----------|----------|------------|-------|
|                                                |         | Extended SPI         | Dual SPI | Quad SPI |               | Extended SPI       | Dual SPI | Quad SPI |            |       |
| WRITE VOLATILE CONFIGURATION REGISTER          | 81h     | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1          | 8     |
| WRITE ENHANCED VOLATILE CONFIGURATION REGISTER | 61h     | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1          | 8     |
| WRITE EXTENDED ADDRESS REGISTER                | C5h     | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1          | 8     |
| <b>CLEAR FLAG STATUS REGISTER Operation</b>    |         |                      |          |          |               |                    |          |          |            |       |
| CLEAR FLAG STATUS REGISTER                     | 50h     | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –     |
| <b>PROGRAM Operations</b>                      |         |                      |          |          |               |                    |          |          |            |       |
| PAGE PROGRAM                                   | 02h     | 1-1-1                | 2-2-2    | 4-4-4    | 3(4)          | 0                  | 0        | 0        | 1 to 256   | 8     |
| DUAL INPUT FAST PROGRAM                        | A2h     | 1-1-2                | 2-2-2    |          | 3(4)          | 0                  | 0        |          | 1 to 256   | 4, 8  |
| EXTENDED DUAL INPUT FAST PROGRAM               | D2h     | 1-2-2                | 2-2-2    |          | 3(4)          | 0                  | 0        |          | 1 to 256   | 4, 8  |
| QUAD INPUT FAST PROGRAM                        | 32h     | 1-1-4                |          | 4-4-4    | 3(4)          | 0                  |          | 0        | 1 to 256   | 4, 8  |
| EXTENDED QUAD INPUT FAST PROGRAM               | 38h     | 1-4-4                |          | 4-4-4    | 3(4)          | 0                  |          | 0        | 1 to 256   | 4, 8  |
| <b>PROGRAM Operations with 4-Byte Address</b>  |         |                      |          |          |               |                    |          |          |            |       |
| 4-BYTE PAGE PROGRAM                            | 12h     | 1-1-1                | 2-2-2    | 4-4-4    | 4             | 0                  | 0        | 0        | 1 to 256   | 8     |
| 4-BYTE QUAD INPUT FAST PROGRAM                 | 34h     | 1-1-4                |          | 4-4-4    | 4             | 0                  |          | 0        | 1 to 256   | 8     |
| 4-BYTE QUAD INPUT EXTENDED FAST PROGRAM        | 3Eh     | 1-4-4                |          | 4-4-4    | 4             | 0                  |          | 0        | 1 to 256   | 8     |
| <b>ERASE Operations</b>                        |         |                      |          |          |               |                    |          |          |            |       |
| 32KB SUBSECTOR ERASE                           | 52h     | 1-1-0                | 2-2-0    | 4-4-0    | 3(4)          | 0                  | 0        | 0        | 0          | 4, 8  |
| 4KB SUBSECTOR ERASE                            | 20h     | 1-1-0                | 2-2-0    | 4-4-0    | 3(4)          | 0                  | 0        | 0        | 0          | 4, 8  |
| SECTOR ERASE                                   | D8h     | 1-1-0                | 2-2-0    | 4-4-0    | 3(4)          | 0                  | 0        | 0        | 0          | 4, 8  |
| 512Mb BULK ERASE                               | C7h/60h | 1-0-0                | 2-0-0    | 4-0-0    | 3(4)          | 0                  | 0        | 0        | 0          | 8     |
| <b>ERASE Operations with 4-Byte Address</b>    |         |                      |          |          |               |                    |          |          |            |       |
| 4-BYTE SECTOR ERASE                            | DCh     | 1-1-0                | 2-2-0    | 4-4-0    | 4             | 0                  | 0        | 0        | 0          | 8     |
| 4-BYTE 4KB SUBSECTOR ERASE                     | 21h     | 1-1-0                | 2-2-0    | 4-4-0    | 4             | 0                  | 0        | 0        | 0          | 8     |
| 4-BYTE 32KB SUBSECTOR ERASE                    | 5Ch     | 1-1-0                | 2-2-0    | 4-4-0    | 4             | 0                  | 0        | 0        | 0          | 8     |

**Table 20: Command Set (Continued)**

Notes 1 and 2 apply to the entire table

| Command                                | Code | Command-Address-Data |          |          | Address Bytes | Dummy Clock Cycles |          |          | Data Bytes | Notes    |
|----------------------------------------|------|----------------------|----------|----------|---------------|--------------------|----------|----------|------------|----------|
|                                        |      | Extended SPI         | Dual SPI | Quad SPI |               | Extended SPI       | Dual SPI | Quad SPI |            |          |
| SUSPEND/RESUME Operations              |      |                      |          |          |               |                    |          |          |            |          |
| PROGRAM/ERASE SUSPEND                  | 75h  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –        |
| PROGRAM/ERASE RESUME                   | 7Ah  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –        |
| ONE-TIME PROGRAMMABLE (OTP) Operations |      |                      |          |          |               |                    |          |          |            |          |
| READ OTP ARRAY                         | 4Bh  | 1-1-1                | 2-2-2    | 4-4-4    | 3(4)          | 8                  | 8        | 10       | 1 to 64    | 4, 5     |
| PROGRAM OTP ARRAY                      | 42h  | 1-1-1                | 2-2-2    | 4-4-4    | 3(4)          | 0                  | 0        | 0        | 1 to 64    | 4, 8     |
| 4-BYTE ADDRESS MODE Operations         |      |                      |          |          |               |                    |          |          |            |          |
| ENTER 4-BYTE ADDRESS MODE              | B7h  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –        |
| EXIT 4-BYTE ADDRESS MODE               | E9h  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –        |
| QUAD PROTOCOL Operations               |      |                      |          |          |               |                    |          |          |            |          |
| ENTER QUAD INPUT/OUTPUT MODE           | 35h  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –        |
| RESET QUAD INPUT/OUTPUT MODE           | F5h  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –        |
| Deep Power-Down Operations             |      |                      |          |          |               |                    |          |          |            |          |
| ENTER DEEP POWER DOWN                  | B9h  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –        |
| RELEASE FROM DEEP POWER-DOWN           | ABh  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –        |
| ADVANCED SECTOR PROTECTION Operations  |      |                      |          |          |               |                    |          |          |            |          |
| READ SECTOR PROTECTION                 | 2Dh  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 1 to ∞     | –        |
| PROGRAM SECTOR PROTECTION              | 2Ch  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 2          | 8        |
| READ VOLATILE LOCK BITS                | E8h  | 1-1-1                | 2-2-2    | 4-4-4    | 3(4)          | 0                  | 0        | 0        | 1 to ∞     | 4, 9     |
| WRITE VOLATILE LOCK BITS               | E5h  | 1-1-1                | 2-2-2    | 4-4-4    | 3(4)          | 0                  | 0        | 0        | 1          | 4, 8, 10 |
| READ NONVOLATILE LOCK BITS             | E2h  | 1-1-1                | 2-2-2    | 4-4-4    | 4             | 0                  | 0        | 0        | 1 to ∞     | –        |
| WRITE NONVOLATILE LOCK BITS            | E3h  | 1-1-0                | 2-2-0    | 4-4-0    | 4             | 0                  | 0        | 0        | 0          | 8        |
| ERASE NONVOLATILE LOCK BITS            | E4h  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | 8        |
| READ GLOBAL FREEZE BIT                 | A7h  | 1-0-1                |          |          | 0             | 0                  | 0        | 0        | 1 to ∞     | –        |
| WRITE GLOBAL FREEZE BIT                | A6h  | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | 8        |
| READ PASSWORD                          | 27h  | 1-0-1                |          |          | 0             | 0                  | 0        | 0        | 1 to ∞     | –        |
| WRITE PASSWORD                         | 28h  | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 8          | 8        |

**Table 20: Command Set (Continued)**

Notes 1 and 2 apply to the entire table

| Command                                                          | Code    | Command-Address-Data |          |          | Address Bytes | Dummy Clock Cycles |          |          | Data Bytes | Notes |
|------------------------------------------------------------------|---------|----------------------|----------|----------|---------------|--------------------|----------|----------|------------|-------|
|                                                                  |         | Extended SPI         | Dual SPI | Quad SPI |               | Extended SPI       | Dual SPI | Quad SPI |            |       |
| UNLOCK PASSWORD                                                  | 29h     | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 8          | –     |
| <b>ADVANCED SECTOR PROTECTION Operations with 4-Byte Address</b> |         |                      |          |          |               |                    |          |          |            |       |
| 4-BYTE READ VOLATILE LOCK BITS                                   | E0h     | 1-1-1                | 2-2-2    | 4-4-4    | 4             | 0                  | 0        | 0        | 1 to ∞     | –     |
| 4-BYTE WRITE VOLATILE LOCK BITS                                  | E1h     | 1-1-1                | 2-2-2    | 4-4-4    | 4             | 0                  | 0        | 0        | 1          | 8     |
| <b>ADVANCED FUNCTION INTERFACE Operations</b>                    |         |                      |          |          |               |                    |          |          |            |       |
| INTERFACE ACTIVATION                                             | 9Bh     | 1-0-0                | 2-0-0    | 4-0-0    | 0             | 0                  | 0        | 0        | 0          | –     |
| CYCLIC REDUNDANCY CHECK                                          | 9Bh/27h | 1-0-1                | 2-0-2    | 4-0-4    | 0             | 0                  | 0        | 0        | 10 or 18   | –     |

- Notes:
1. Micron extended SPI protocol is the standard SPI protocol with additional commands that extend functionality and enable address or data transmission on multiple DQn lines.
  2. The command code is always transmitted on DQn = 1, 2, or 4 lines according to the standard, dual, or quad protocol respectively. However, a command may be able to transmit address and data on multiple DQn lines regardless of protocol. The protocol columns show the number of DQn lines a command uses to transmit command, address, and data information as shown in these examples: command-address-data = 1-1-1, or 1-2-2, or 2-4-4, and so on.
  3. The READ SERIAL FLASH DISCOVERY PARAMETER operation accepts only 3-byte address even if the device is configured to 4-byte address mode. The number of dummy cycles for the READ SFDP command is fixed (8 dummy cycles) and is not affected by dummy cycle settings in the nonvolatile configuration register and volatile configuration register. For the max clock frequency achievable refer to Supported Clock Frequencies tables for 8 dummy cycles.
  4. Requires 4 bytes of address if the device is configured to 4-byte address mode.
  5. The number of dummy clock cycles required when shipped from Micron factories. The user can modify the dummy clock cycle number via the nonvolatile configuration register and the volatile configuration register.
  6. The number of dummy cycles for the READ GENERAL PURPOSE READ REGISTER command is fixed (8 dummy cycles) and is not affected by dummy cycle settings in the nonvolatile configuration register and volatile configuration register.
  7. The general purpose read register is 64 bytes. After the first 64 bytes, the device outputs 00h and does not wrap.
  8. The WRITE ENABLE command must be issued first before this operation can be executed.
  9. Formerly referred to as the READ LOCK REGISTER operation.
  10. Formerly referred to as the WRITE LOCK REGISTER operation.

## Software RESET Operations

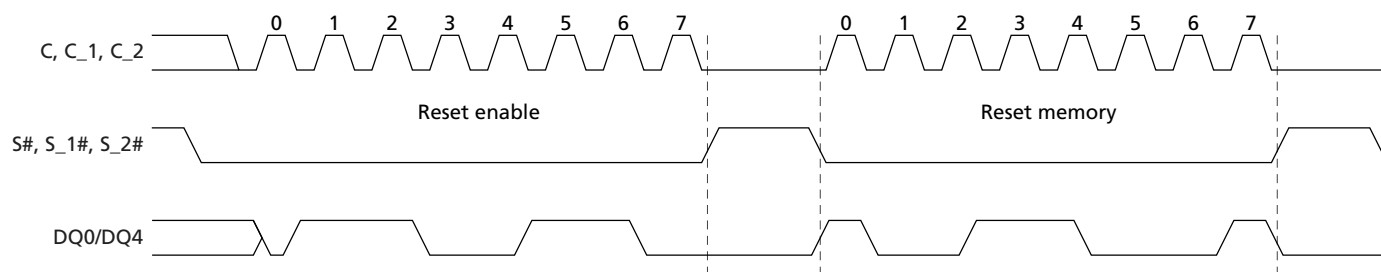
### RESET ENABLE and RESET MEMORY Commands

To initiate these commands, S# is driven LOW and the command code is input on DQ0/DQ4. A minimum deselection time of  $t_{SHSL2}$  must come between RESET ENABLE and RESET MEMORY or reset is not guaranteed. Then, S# must be driven HIGH for the device to enter power-on reset. A time of  $t_{SHSL3}$  is required before the device can be reselected by driving S# LOW.

**Table 21: RESET ENABLE and RESET MEMORY Operations**

| Operation Name     | Description/Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|--------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RESET ENABLE (66h) | <p>To reset the device, the RESET ENABLE command must be followed by the RESET MEMORY command. When the two commands are executed, the device enters a power-on reset condition. It is recommended to exit XIP mode before executing these two commands. All volatile lock bits, the volatile configuration register, and the enhanced volatile configuration register are reset to the power-on reset default condition according to nonvolatile configuration register settings.</p> <p>If a reset is initiated while a WRITE, PROGRAM, or ERASE operation is in progress or suspended, the operation is aborted and data may be corrupted.</p> <p>Reset is effective after the flag status register bit 7 outputs 1 with at least one byte output. A RESET ENABLE command is not accepted during WRITE STATUS REGISTER and WRITE NONVOLATILE CONFIGURATION REGISTER operations.</p> |
| RESET MEMORY (99h) |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |

**Figure 15: RESET ENABLE and RESET MEMORY Command**



Note: 1. The number of lines and rate for transmission varies with extended, dual, or quad SPI.

## READ ID Operations

### READ ID and MULTIPLE I/O READ ID Commands

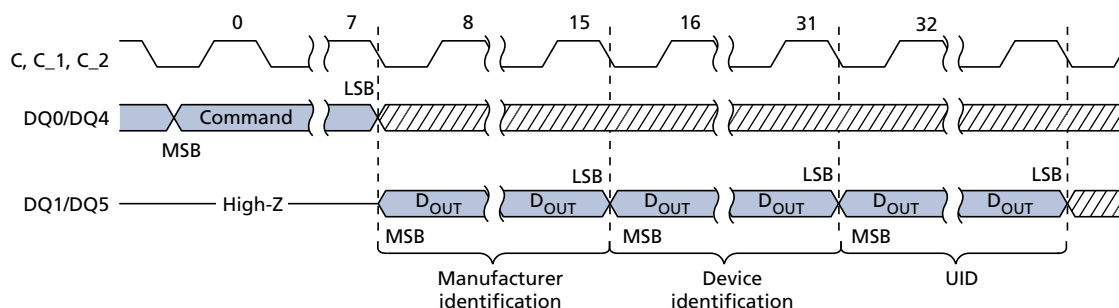
To initiate these commands, S# is driven LOW and the command code is input on DQ<sub>n</sub>. When S# is driven HIGH, the device goes to standby. The operation is terminated by driving S# HIGH at any time during data output.

**Table 22: READ ID and MULTIPLE I/O READ ID Operations**

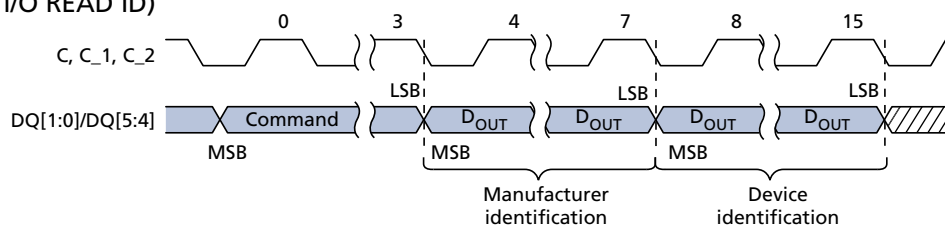
| Operation Name             | Description/Conditions                                                                                                                                                                                           |
|----------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| READ ID (9Eh/9F)           | Outputs information shown in the Device ID Data tables. If an ERASE or PROGRAM cycle is in progress when the command is initiated, the command is not decoded and the command cycle in progress is not affected. |
| MULTIPLE I/O READ ID (AFh) |                                                                                                                                                                                                                  |

**Figure 16: READ ID and MULTIPLE I/O READ ID Commands**

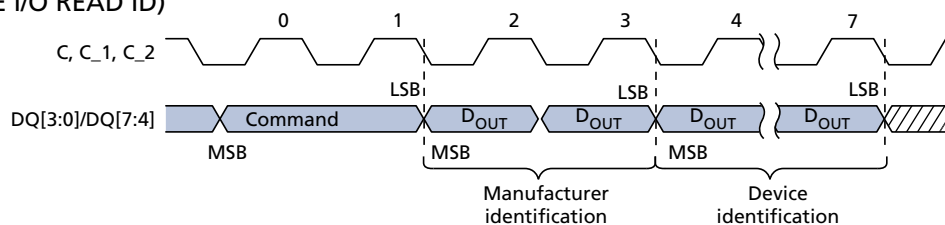
Extended (READ ID)



Dual (MULTIPLE I/O READ ID)



Quad (MULTIPLE I/O READ ID)



 Don't Care

Note: 1. S# not shown.

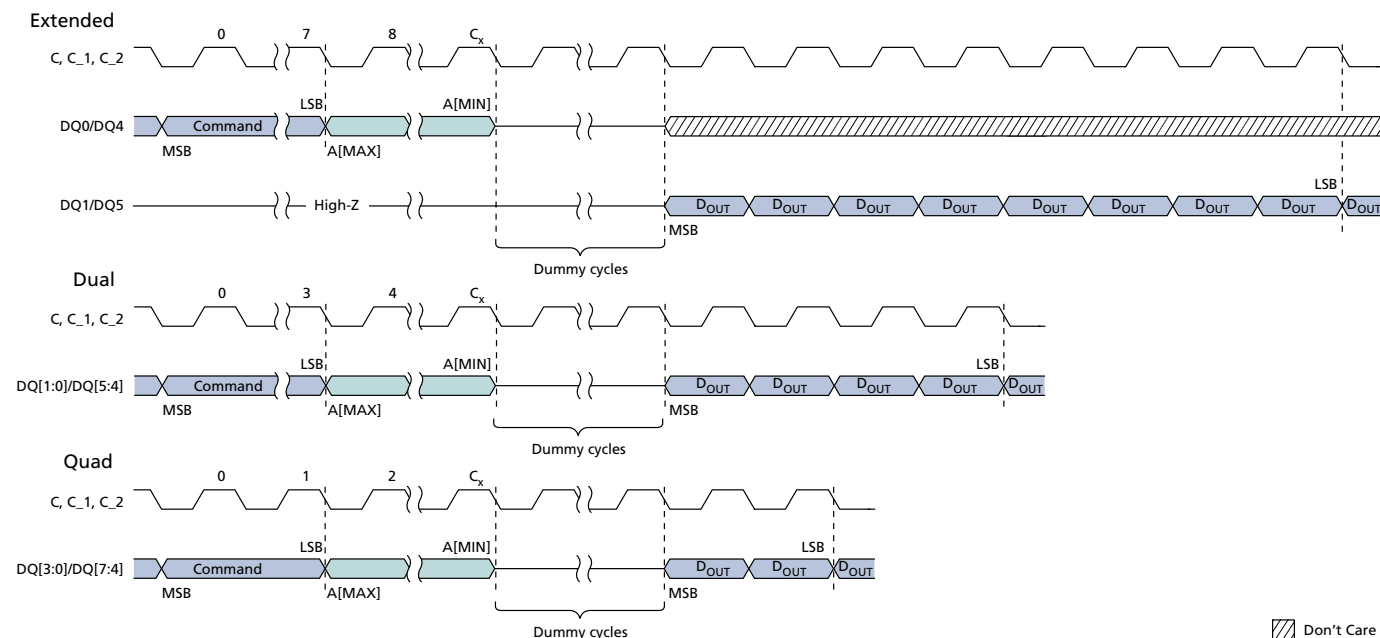
## READ SERIAL FLASH DISCOVERY PARAMETER Operation

### READ SERIAL FLASH DISCOVERY PARAMETER Command

To execute READ SERIAL FLASH DISCOVERY PARAMETER command, S# is driven LOW. The command code is input on DQ0/DQ4, followed by three address bytes and eight dummy clock cycles. The device outputs the information starting from the specified address. When the 2048-byte boundary is reached, the data output wraps to address 0 of the Serial Flash Discovery Parameter Data table. The operation is terminated by driving S# HIGH at any time during data output.

**Note:** The operation always executes in continuous mode so the read burst wrap setting in the volatile configuration register does not apply.

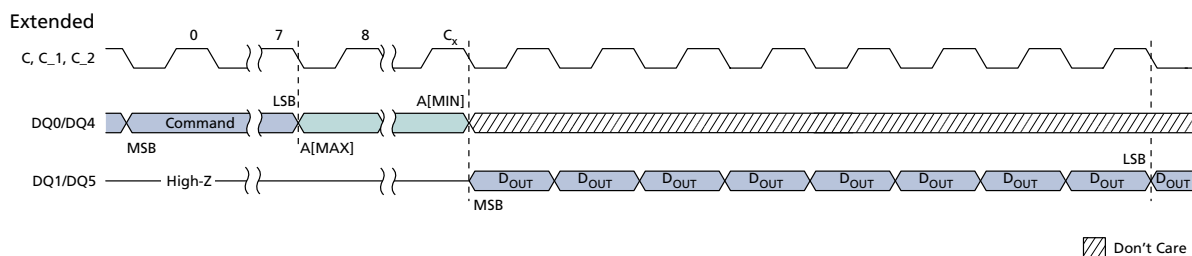
**Figure 17: READ SERIAL FLASH DISCOVERY PARAMETER Command – 5Ah**



- Notes:
1. For extended protocol,  $C_x = 7 + (A[\text{MAX}] + 1)$ ; For dual protocol,  $C_x = 3 + (A[\text{MAX}] + 1)/2$ ; For quad protocol,  $C_x = 1 + (A[\text{MAX}] + 1)/4$ .
  2. S# not shown.

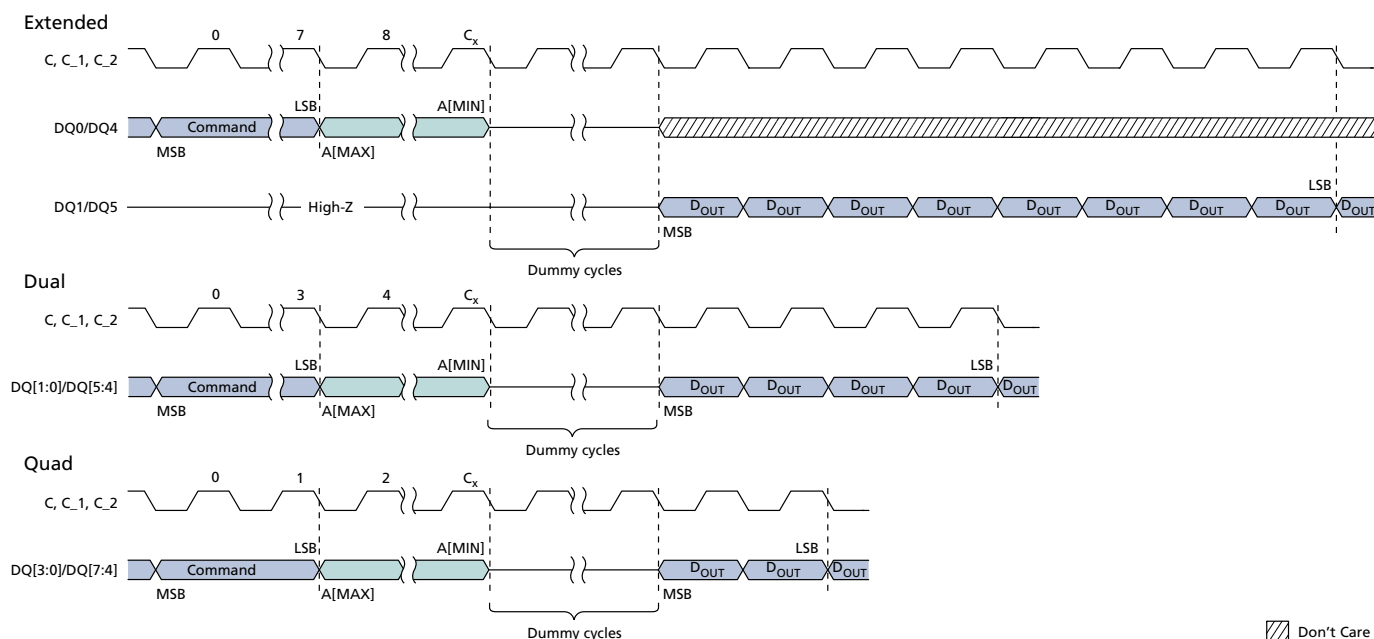
## READ MEMORY Operations Timings

**Figure 18: READ – 03h/13h<sup>3</sup>**



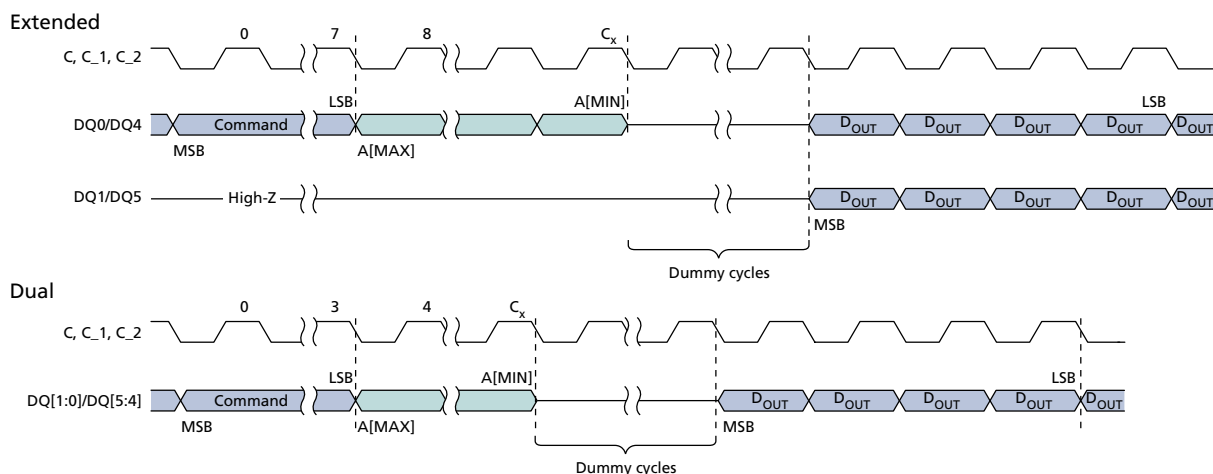
- Notes:
1. For extended protocol,  $C_x = 7 + (A[\text{MAX}] + 1)$ ; For dual protocol,  $C_x = 3 + (A[\text{MAX}] + 1)/2$ ; For quad protocol,  $C_x = 1 + (A[\text{MAX}] + 1)/4$ .
  2. S# not shown.
  3. READ and 4-BYTE READ commands

**Figure 19: FAST READ – 0Bh/0Ch<sup>3</sup>**



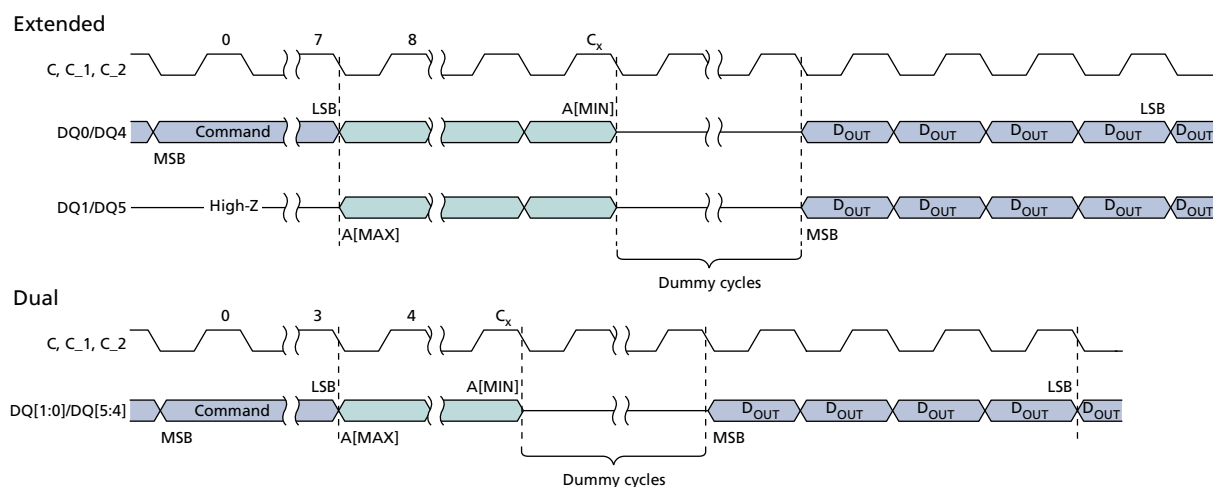
- Notes:
1. For extended protocol,  $C_x = 7 + (A[\text{MAX}] + 1)$ ; For dual protocol,  $C_x = 3 + (A[\text{MAX}] + 1)/2$ ; For quad protocol,  $C_x = 1 + (A[\text{MAX}] + 1)/4$ .
  2. S# not shown.
  3. FAST READ and 4-BYTE FAST READ commands.

**Figure 20: DUAL OUTPUT FAST READ – 3Bh/3Ch<sup>3</sup>**



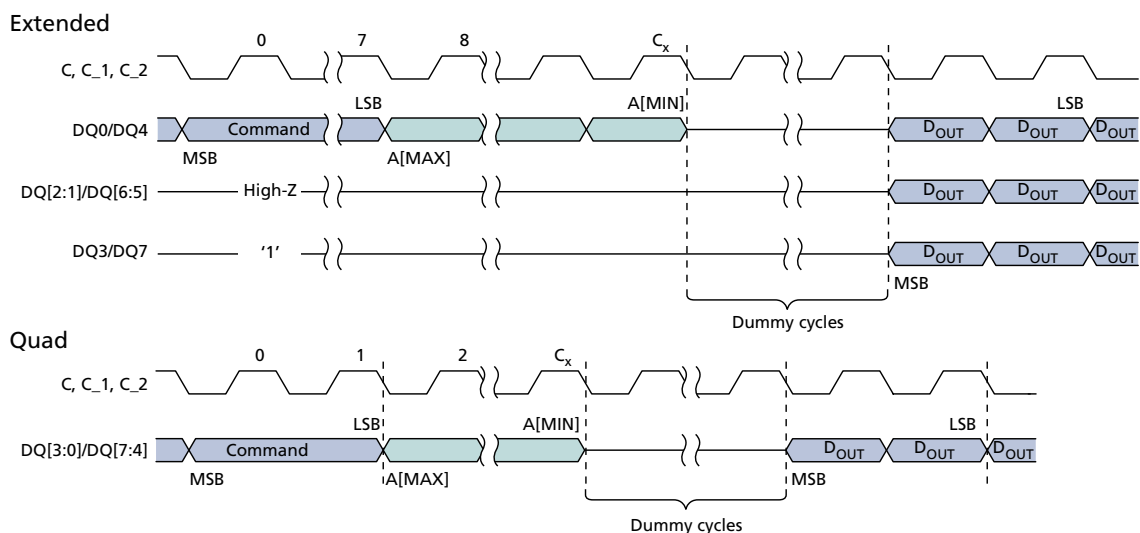
- Notes:
1. For extended protocol,  $C_x = 7 + (A[MSB] + 1)$ ; For dual protocol,  $C_x = 3 + (A[MSB] + 1)/2$ .
  2. S# not shown.
  3. DUAL OUTPUT FAST READ and 4-BYTE DUAL OUTPUT FAST READ commands.

**Figure 21: DUAL INPUT/OUTPUT FAST READ – BBh/BCh<sup>3</sup>**



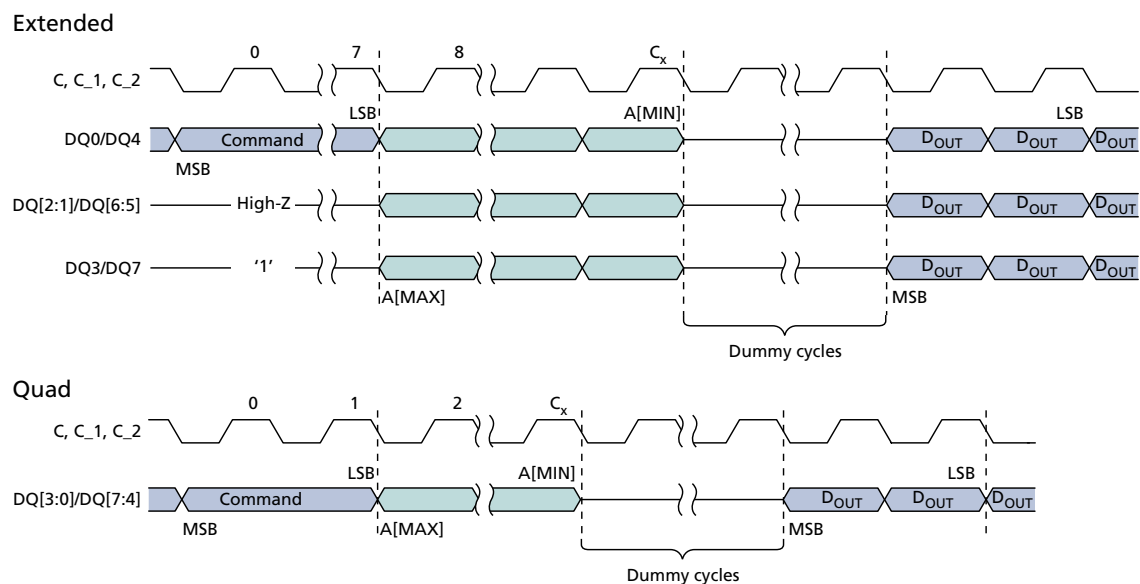
- Notes:
1. For extended protocol,  $C_x = 7 + (A[MSB] + 1)/2$ ; For dual protocol,  $C_x = 3 + (A[MSB] + 1)/2$ .
  2. S# not shown.
  3. DUAL INPUT/OUTPUT FAST READ and 4-BYTE DUAL INPUT/OUTPUT FAST READ commands.

**Figure 22: QUAD OUTPUT FAST READ – 6Bh/6Ch<sup>3</sup>**



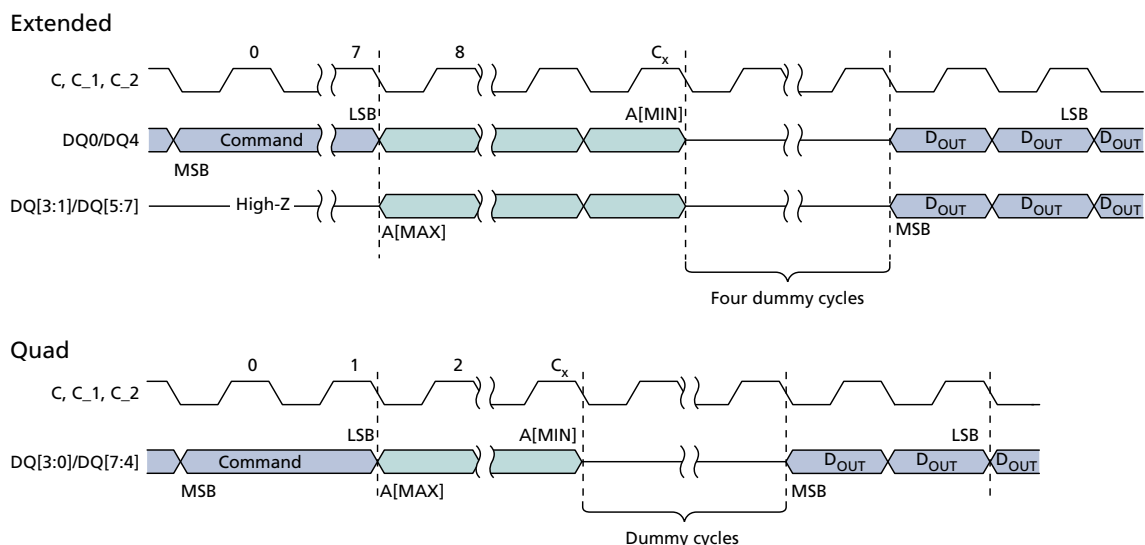
- Notes:
1. For extended protocol,  $C_x = 7 + (A[MAX] + 1)/4$ ; For quad protocol,  $C_x = 1 + (A[MAX] + 1)/4$ .
  2. S# not shown.
  3. QUAD OUTPUT FAST READ and 4-BYTE QUAD OUTPUT FAST READ commands.

**Figure 23: QUAD INPUT/OUTPUT FAST READ – EBh/ECh<sup>3</sup>**



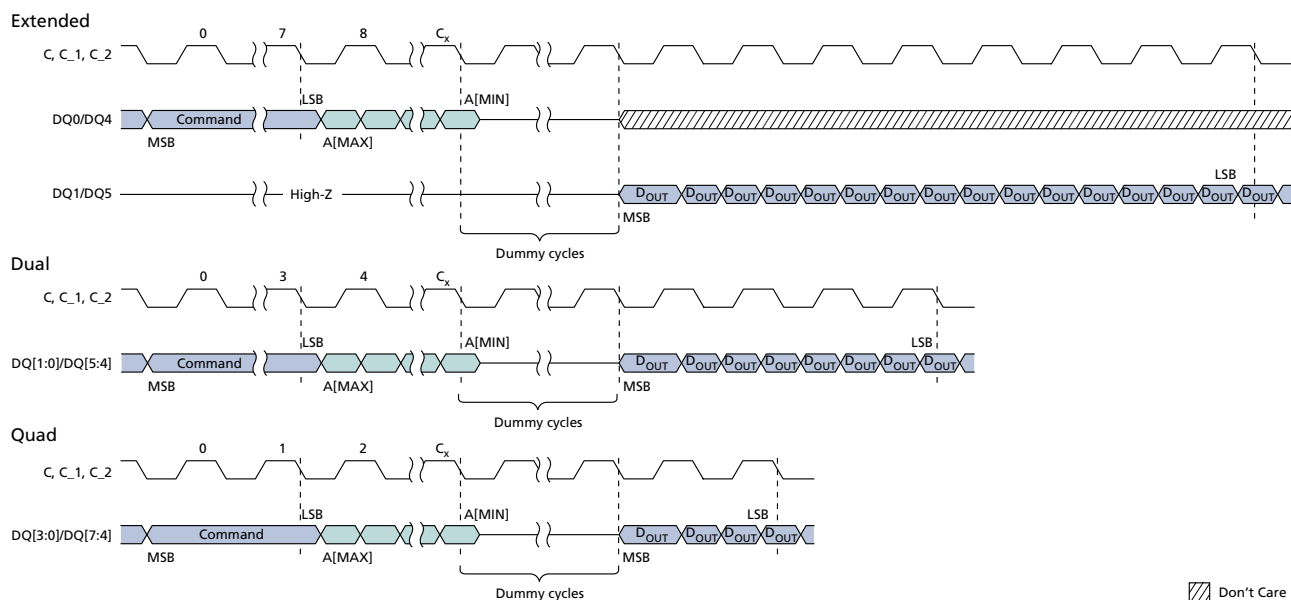
- Notes:
1. For extended protocol,  $C_x = 7 + (A[MAX] + 1)/4$ ; For quad protocol,  $C_x = 1 + (A[MAX] + 1)/4$ .
  2. S# not shown.
  3. QUAD INPUT/OUTPUT FAST READ and 4-BYTE QUAD INPUT/OUTPUT FAST READ commands

**Figure 24: QUAD INPUT/OUTPUT WORD READ – E7h<sup>3</sup>**



- Notes:
1. For extended protocol,  $C_x = 7 + (A[Max] + 1)/4$ ; For quad protocol,  $C_x = 1 + (A[Max] + 1)/4$ .
  2. S# not shown.
  3. QUAD INPUT/OUTPUT WORD READ and 4-BYTE QUAD INPUT/OUTPUT WORD READ commands.

**Figure 25: DTR FAST READ – 0Dh/0Eh<sup>3</sup>**



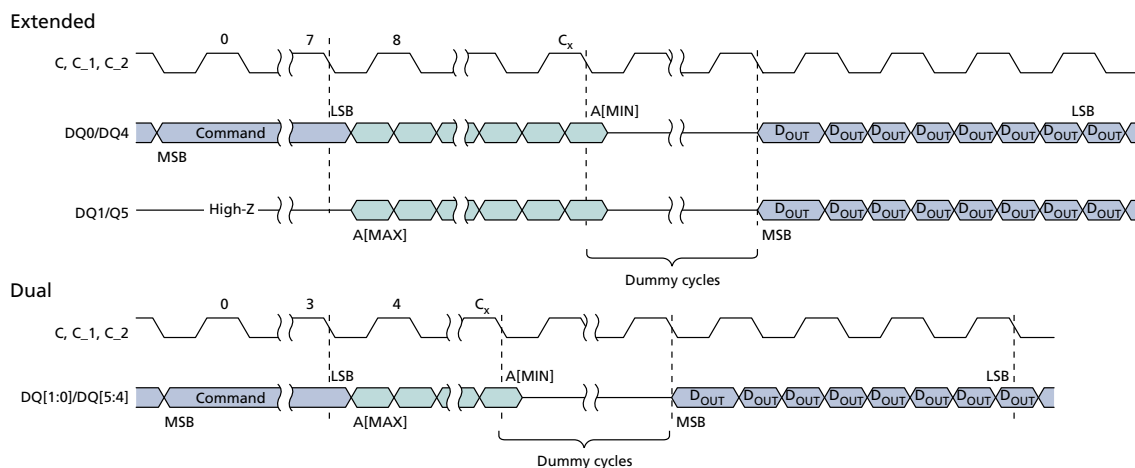
- Notes:
1. For extended protocol,  $C_x = 7 + (A[Max] + 1)/2$ ; For dual protocol,  $C_x = 3 + (A[Max] + 1)/4$ ; For quad protocol,  $C_x = 1 + (A[Max] + 1)/8$ .
  2. S# not shown.
  3. DTR FAST READ and 4-BYTE DTR FAST READ commands.

The figure shows two timing diagrams, 'Extended' and 'Dual', illustrating the relationship between clock signals, command/data signals, and address signals.

**Extended:** This diagram shows a clock signal with cycles 0, 7, 8, and  $C_x$  marked. The command signal (DQ0/DQ4) is active from cycle 0 to 7, with the MSB at cycle 0 and the LSB at cycle 7. The address signal (A[MIN] to A[MAX]) is active from cycle 8 to  $C_x$ . The data signal (DOUT) is active from cycle  $C_x$  to cycle 15, with the MSB at cycle  $C_x$  and the LSB at cycle 15. The data signal is labeled 'DOUT' for each cycle.

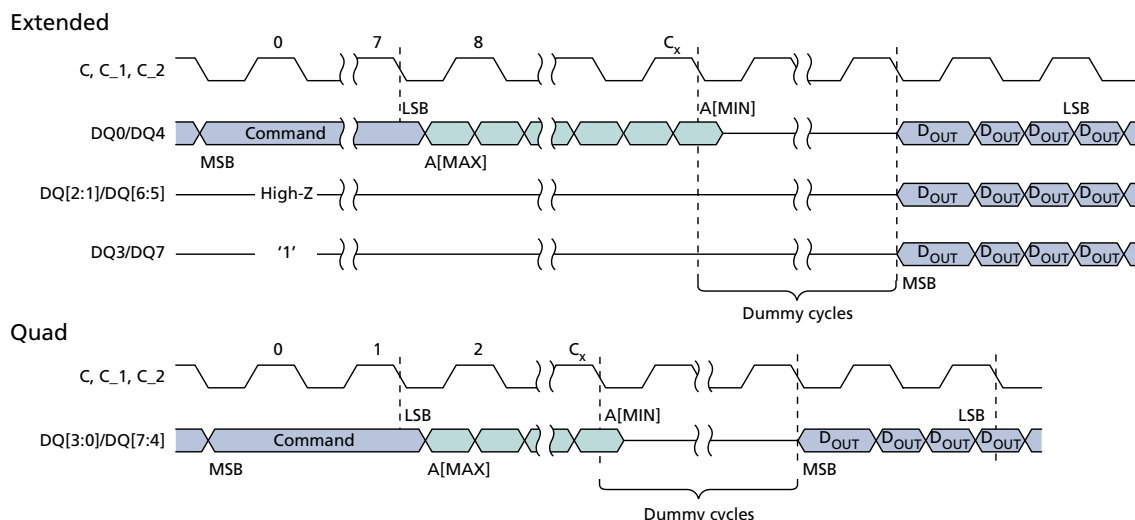
**Dual:** This diagram shows a clock signal with cycles 0, 3, 4, and  $C_x$  marked. The command signal (DQ[1:0]/DQ[5:4]) is active from cycle 0 to 3, with the MSB at cycle 0 and the LSB at cycle 3. The address signal (A[MIN] to A[MAX]) is active from cycle 4 to  $C_x$ . The data signal (DOUT) is active from cycle  $C_x$  to cycle 15, with the MSB at cycle  $C_x$  and the LSB at cycle 15. The data signal is labeled 'DOUT' for each cycle. The period between cycle 3 and cycle 4 is labeled 'Dummy cycles'.

- Figure 27: DTR DUAL INPUT/OUTPUT FAST READ – BDh<sup>3</sup>**



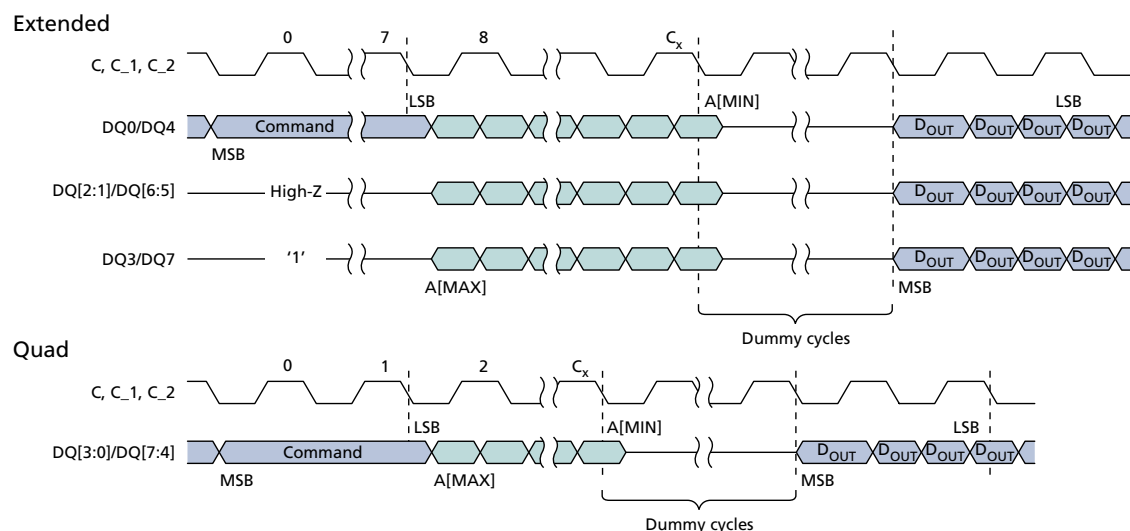
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**Figure 28: DTR QUAD OUTPUT FAST READ – 6Dh<sup>3</sup>**



- Notes:
1. For extended protocol,  $C_x = 7 + (A[MAX] + 1)/2$ ; For quad protocol,  $C_x = 1 + (A[MAX] + 1)/8$ .
  2. S# not shown.
  3. DTR QUAD OUTPUT FAST READ and 4-BYTE DTR QUAD OUTPUT FAST READ commands.

**Figure 29: DTR QUAD INPUT/OUTPUT FAST READ – EDh<sup>3</sup>**



- Notes:
1. For extended protocol,  $C_x = 7 + (A[MAX] + 1)/8$ ; For quad protocol,  $C_x = 1 + (A[MAX] + 1)/8$ .
  2. S# not shown.
  3. DTR QUAD INPUT/OUTPUT FAST READ and 4-BYTE DTR QUAD INPUT/OUTPUT FAST READ commands

### 4-BYTE READ MEMORY Operations

**Table 23: 4-BYTE READ MEMORY Operations**

| Operation Name                               | Description/Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|----------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 4-BYTE READ (13h)                            | <p>READ MEMORY operations can be extended to a 4-byte address range, with [A31:0] input during address cycle.</p> <p>Selection of the 3-byte or 4-byte address range can be enabled in two ways: through the nonvolatile configuration register or through the ENABLE 4-BYTE ADDRESS MODE/EXIT 4-BYTE ADDRESS MODE commands.</p> <p>Each address bit is latched in during the rising edge of the clock. The addressed byte can be at any location, and the address automatically increments to the next address after each byte of data is shifted out; therefore, a die can be read with a single command.</p> <p>FAST READ can operate at a higher frequency (<math>f_c</math>).</p> <p>4-BYTE commands and DTR 4-BYTE commands function in 4-BYTE and DTR 4-BYTE protocols regardless of settings in the nonvolatile configuration register or enhanced volatile configuration register; other commands function in 4-BYTE and DTR protocols only after the specific protocol is enabled by the register settings.</p> |
| 4-BYTE FAST READ (0Ch)                       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 4-BYTE DUAL OUTPUT FAST READ (3Ch)           |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 4-BYTE DUAL INPUT/OUTPUT FAST READ (BCh)     |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 4-BYTE QUAD OUTPUT FAST READ (6Ch)           |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 4-BYTE QUAD INPUT/OUTPUT FAST READ (ECh)     |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| DTR 4-BYTE FAST READ (0Eh)                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| DTR 4-BYTE DUAL INPUT/OUTPUT FAST READ (BEh) |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| DTR 4-BYTE QUAD INPUT/OUTPUT FAST READ (EEh) |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |

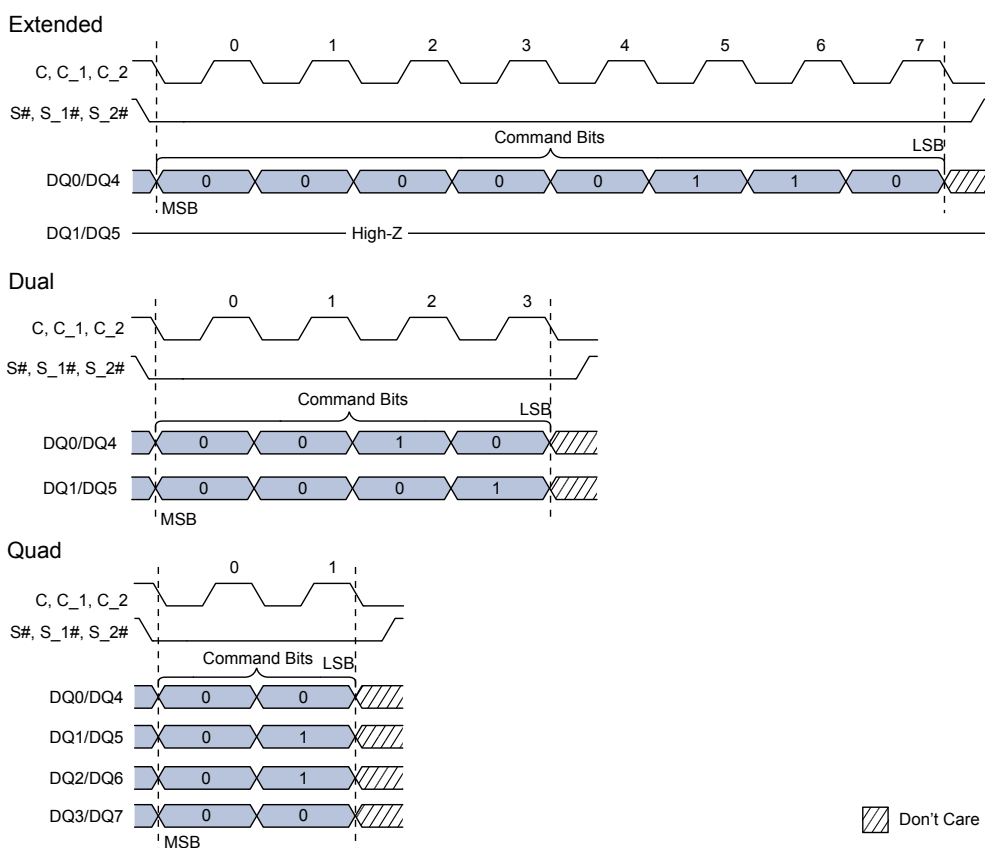
## WRITE ENABLE/DISABLE Operations

To initiate a command, S# is driven LOW and held LOW until the eighth bit of the command code has been latched in, after which it must be driven HIGH. For extended, dual, and quad SPI protocols respectively, the command code is input on DQ0/DQ4, DQ[1:0]/DQ[5:4], and DQ[3:0]/DQ[7:4]. If S# is not driven HIGH after the command code has been latched in, the command is not executed, flag status register error bits are not set, and the write enable latch remains cleared to its default setting of 0, providing protection against errant data modification.

**Table 24: WRITE ENABLE/DISABLE Operations**

| Operation Name      | Description/Conditions                                                                                                                                                                    |
|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| WRITE ENABLE (06h)  | Sets the write enable latch bit before each PROGRAM, ERASE, and WRITE command.                                                                                                            |
| WRITE DISABLE (04h) | Clears the write enable latch bit. In case of a protection error, WRITE DISABLE will not clear the bit. Instead, a CLEAR FLAG STATUS REGISTER command must be issued to clear both flags. |

**Figure 30: WRITE ENABLE and WRITE DISABLE Timing**



Note: 1. WRITE ENABLE command sequence and code, shown here, is 06h (0000 0110 binary); WRITE DISABLE is identical, but its command code is 04h (0000 0100 binary).

## READ REGISTER Operations

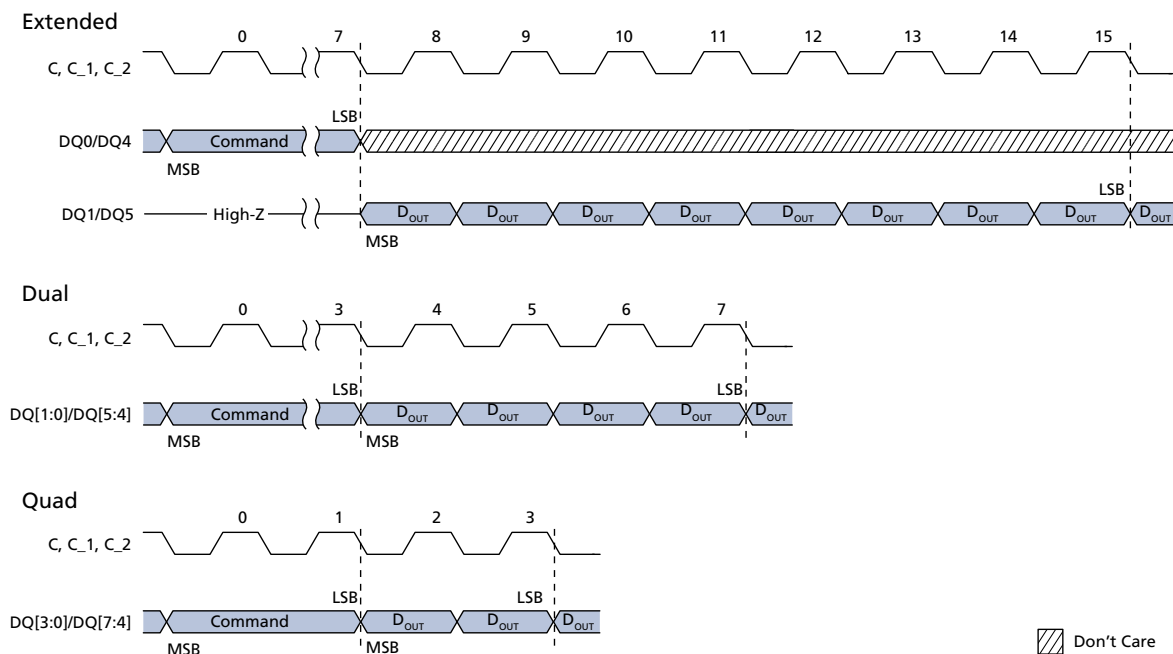
To initiate a command, S# is driven LOW. For extended SPI protocol, input is on DQ0/DQ4, output on DQ1/DQ5. For dual SPI protocol, input/output is on DQ[1:0]/DQ[5:4] and for quad SPI protocol, input/output is on DQ[3:0]/DQ[7:4]. The operation is terminated by driving S# HIGH at any time during data output.

**Table 25: READ REGISTER Operations**

| Operation Name                                      | Description/Conditions                                                                                                                                                                                                                            | Note |
|-----------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| READ STATUS REGISTER (05h)                          | Can be read continuously and at any time, including during a PROGRAM, ERASE, or WRITE operation. If one of these operations is in progress, checking the write in progress bit or P/E controller bit is recommended before executing the command. |      |
| READ FLAG STATUS REGISTER (70h)                     |                                                                                                                                                                                                                                                   |      |
| READ NONVOLATILE CONFIGURATION REGISTER (B5h)       | Can be read continuously. After all 16 bits of the register have been read, a 0 is output. All reserved fields output a value of 1.                                                                                                               | 1    |
| READ VOLATILE CONFIGURATION REGISTER (85h)          | When the register is read continuously, the same byte is output repeatedly.                                                                                                                                                                       |      |
| READ ENHANCED VOLATILE CONFIGURATION REGISTER (65h) |                                                                                                                                                                                                                                                   |      |

Note: 1. The operation will have output data starting from the least significant byte.

**Figure 31: READ REGISTER Timing**



Notes: 1. Supports all READ REGISTER commands except DYNAMIC PROTECTION BITS READ.

2. A READ NONVOLATILE CONFIGURATION REGISTER operation will output data starting from the least significant byte.
3. S# not shown.

## WRITE REGISTER Operations

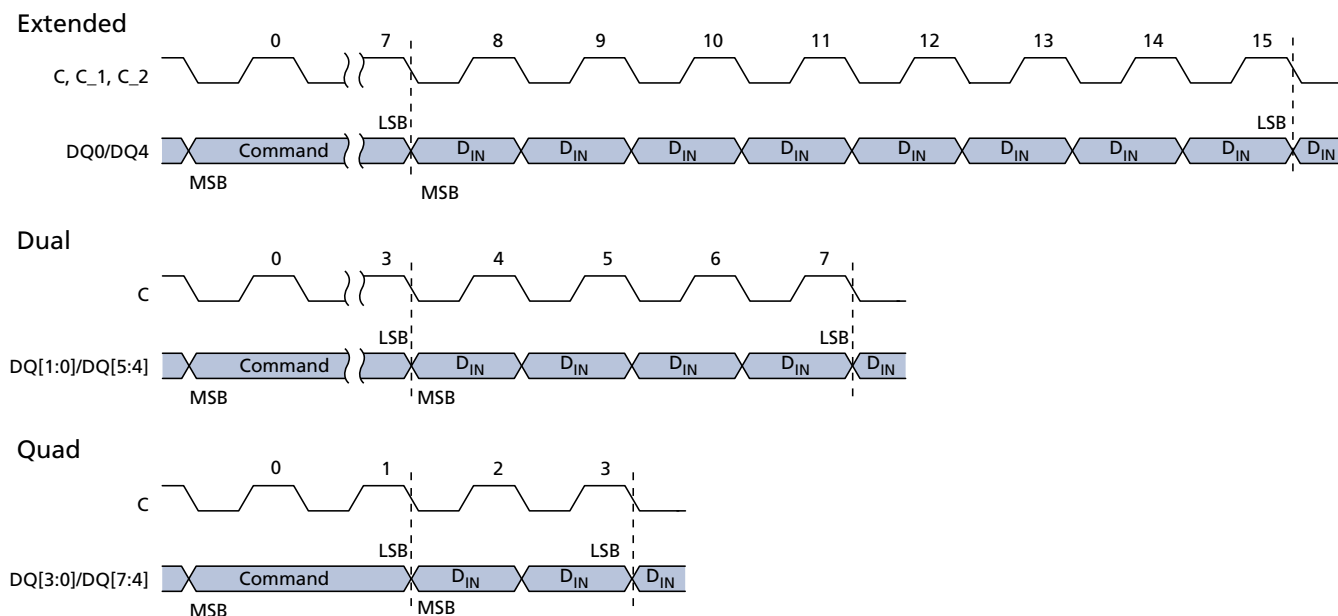
Before a WRITE REGISTER command is initiated, the WRITE ENABLE command must be executed to set the write enable latch bit to 1. To initiate a command, S# is driven LOW and held LOW until the eighth bit of the last data byte has been latched in, after which it must be driven HIGH; for the WRITE NONVOLATILE CONFIGURATION REGISTER command, S# is held LOW until the 16th bit of the last data byte has been latched in. For the extended, dual, and quad SPI protocols respectively, input is on DQ0/DQ4, DQ[1:0]/DQ[5:4], and DQ[3:0]/DQ[7:4], followed by the data bytes. If S# is not driven HIGH, the command is not executed, flag status register error bits are not set, and the write enable latch remains set to 1. The operation is self-timed and its duration is  $t_W$  for WRITE STATUS REGISTER and  $t_{NVCR}$  for WRITE NONVOLATILE CONFIGURATION REGISTER.

**Table 26: WRITE REGISTER Operations**

| Operation Name                                       | Description/Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                           | Note |
|------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| WRITE STATUS REGISTER (01h)                          | The WRITE STATUS REGISTER command writes new values to status register bits 7:2, enabling software data protection. The status register can also be combined with the W# signal to provide hardware data protection. This command has no effect on status register bits 1:0.                                                                                                                                                                                     | 1    |
| WRITE NONVOLATILE CONFIGURATION REGISTER (B1h)       | For the WRITE STATUS REGISTER and WRITE NONVOLATILE CONFIGURATION REGISTER commands, when the operation is in progress, the write in progress bit is set to 1. The write enable latch bit is cleared to 0, whether the operation is successful or not. The status register and flag status register can be polled for the operation status. When the operation completes, the write in progress bit is cleared to 0, whether the operation is successful or not. |      |
| WRITE VOLATILE CONFIGURATION REGISTER (81h)          | Because register bits are volatile, change to the bits is immediate. Reserved bits are not affected by this command.                                                                                                                                                                                                                                                                                                                                             |      |
| WRITE ENHANCED VOLATILE CONFIGURATION REGISTER (61h) |                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |      |

Note: 1. The WRITE NONVOLATILE CONFIGURATION REGISTER operation must have input data starting from the least significant byte.

**Figure 32: WRITE REGISTER Timing**



- Notes:
1. Supports all WRITE REGISTER commands except WRITE LOCK REGISTER.
  2. Data is two bytes for a WRITE NONVOLATILE CONFIGURATION REGISTER operation, input starting from the least significant byte.
  3. S# not shown.

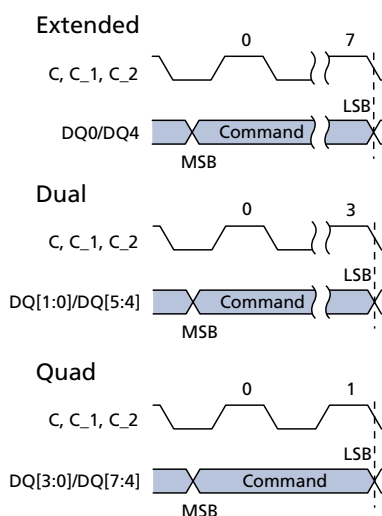
## CLEAR FLAG STATUS REGISTER Operation

To initiate a command, S# is driven LOW. For the extended, dual, and quad SPI protocols respectively, input is on DQ0/DQ4, DQ[1:0]/DQ[5:4], and DQ[3:0]/DQ[7:4]. The operation is terminated by driving S# HIGH at any time.

**Table 27: CLEAR FLAG STATUS REGISTER Operation**

| Operation Name                   | Description/Conditions                                 |
|----------------------------------|--------------------------------------------------------|
| CLEAR FLAG STATUS REGISTER (50h) | Resets the error bits (erase, program, and protection) |

**Figure 33: CLEAR FLAG STATUS REGISTER Timing**



Note: 1. S# not shown.

## PROGRAM Operations

Before a PROGRAM command is initiated, the WRITE ENABLE command must be executed to set the write enable latch bit to 1. To initiate a command, S# is driven LOW and held LOW until the eighth bit of the last data byte has been latched in, after which it must be driven HIGH. If S# is not driven HIGH, the command is not executed, flag status register error bits are not set, and the write enable latch remains set to 1. Each address bit is latched in during the rising edge of the clock. When a command is applied to a protected sector, the command is not executed, the write enable latch bit remains set to 1, and flag status register bits 1 and 4 are set. If the operation times out, the write enable latch bit is reset and the program fail bit is set to 1.

**Note:** The manner of latching data shown and explained in the timing diagrams ensures that the number of clock pulses is a multiple of one byte before command execution, helping reduce the effects of noisy or undesirable signals and enhancing device data protection.

**Table 28: PROGRAM Operations**

| Operation Name                         | Description/Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|----------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PAGE PROGRAM (02h)                     | <p>A PROGRAM operation changes a bit from 1 to 0.</p> <p>When the operation is in progress, the write in progress bit is set to 1. The write enable latch bit is cleared to 0, whether the operation is successful or not. The status register and flag status register can be polled for the operation status. When the operation completes, the write in progress bit is cleared to 0. An operation can be paused or resumed by the PROGRAM/ERASE SUSPEND or PROGRAM/ERASE RESUME command, respectively.</p> <p>If the bits of the least significant address, which is the starting address, are not all zero, all data transmitted beyond the end of the current page is programmed from the starting address of the same page. If the number of bytes sent to the device exceed the maximum page size, previously latched data is discarded and only the last maximum page-size number of data bytes are guaranteed to be programmed correctly within the same page. If the number of bytes sent to the device is less than the maximum page size, they are correctly programmed at the specified addresses without any effect on the other bytes of the same page.</p> |
| DUAL INPUT FAST PROGRAM (A2h)          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| EXTENDED DUAL INPUT FAST PROGRAM (D2h) |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| QUAD INPUT FAST PROGRAM (32h)          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| EXTENDED QUAD INPUT FAST PROGRAM (38h) |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |

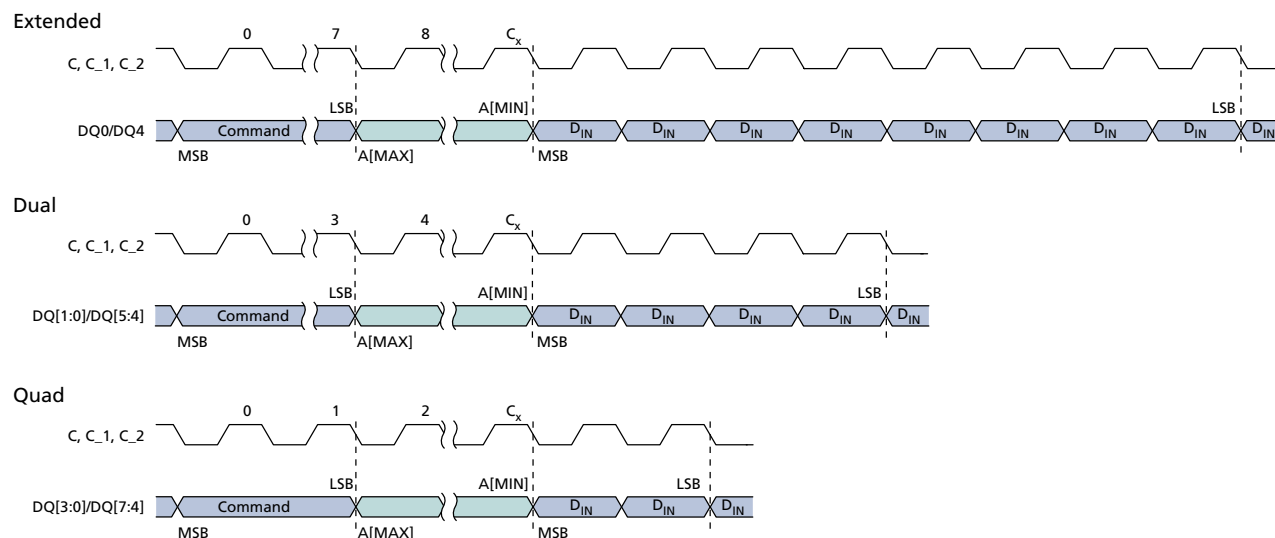
### 4-BYTE PROGRAM Operations

**Table 29: 4-BYTE PROGRAM Operations**

| Operation Name                                | Description/Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|-----------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 4-BYTE PAGE PROGRAM (12h)                     | <p>PROGRAM operations can be extended to a 4-byte address range, with [A31:0] input during address cycle.</p> <p>Selection of the 3-byte or 4-byte address range can be enabled in two ways: through the nonvolatile configuration register or through the ENABLE 4-BYTE ADDRESS MODE/EXIT 4-BYTE ADDRESS MODE commands.</p> <p>4-BYTE commands and DTR 4-BYTE commands function in 4-BYTE and DTR 4-BYTE protocol regardless of settings in the nonvolatile configuration register or enhanced volatile configuration register; other commands function in 4-BYTE and DTR protocols only after the specific protocol is enabled by the register settings.</p> |
| 4-BYTE QUAD INPUT FAST PROGRAM (34h)          |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 4-BYTE EXTENDED QUAD INPUT FAST PROGRAM (3Eh) |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |

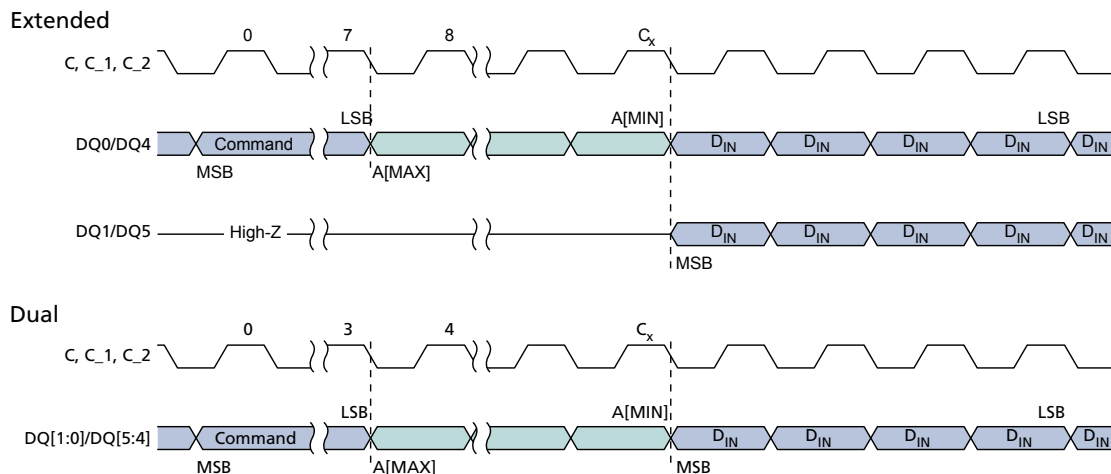
## PROGRAM Operations Timings

**Figure 34: PAGE PROGRAM Command**



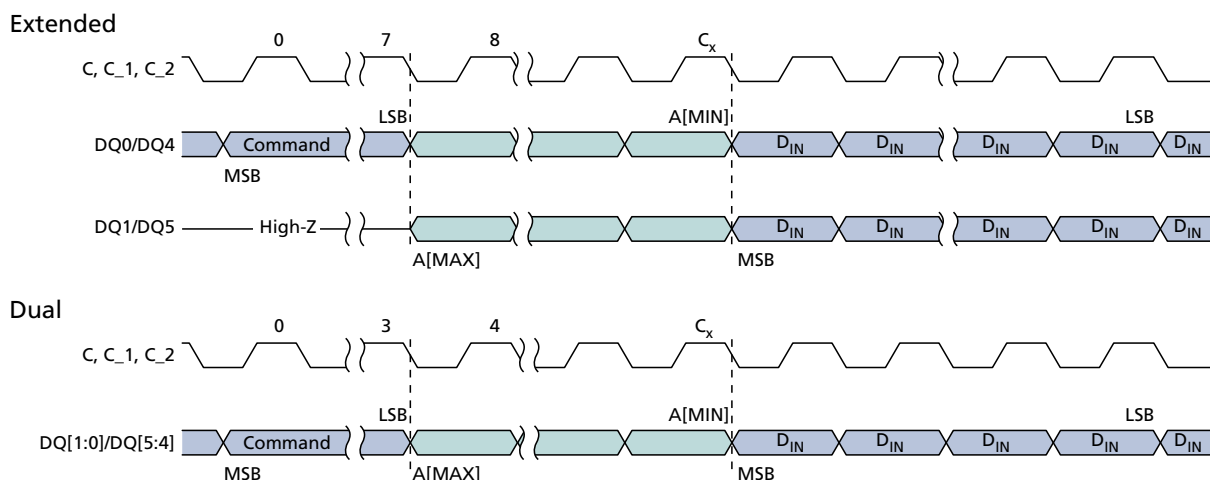
- Notes:
1. For extended SPI protocol,  $C_x = 7 + (A[MAX] + 1)$ ; For dual SPI protocol,  $C_x = 3 + (A[MAX] + 1)/2$ ; For quad SPI protocol,  $C_x = 1 + (A[MAX] + 1)/4$ .
  2. S# not shown. The operation is self-timed, and its duration is  $t_{PP}$ .

**Figure 35: DUAL INPUT FAST PROGRAM Command**



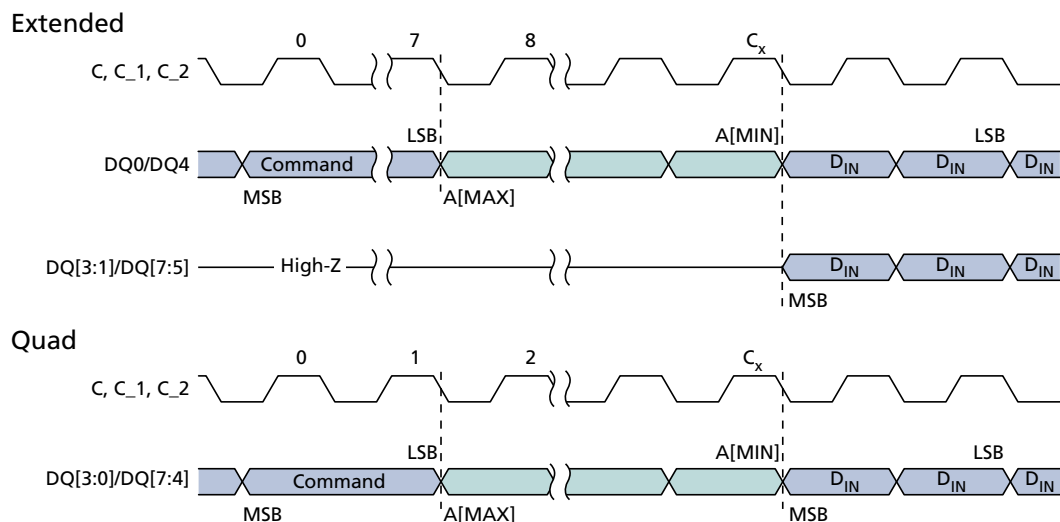
- Notes:
1. For extended SPI protocol,  $C_x = 7 + (A[MAX] + 1)$ ; For dual SPI protocol,  $C_x = 3 + (A[MAX] + 1)/2$ .
  2. S# not shown.

**Figure 36: EXTENDED DUAL INPUT FAST PROGRAM Command**



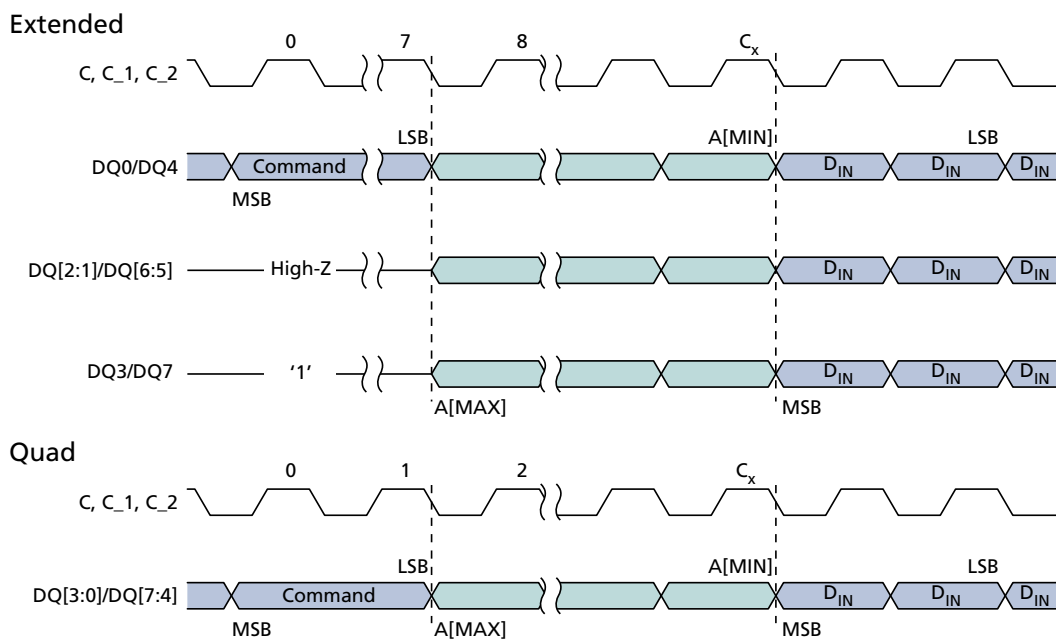
- Notes: 1. For extended SPI protocol,  $C_x = 7 + (A[MAX] + 1)/2$ ; For dual SPI protocol,  $C_x = 3 + (A[MAX] + 1)/2$ .  
2. S# not shown.

**Figure 37: QUAD INPUT FAST PROGRAM Command**



- Notes: 1. For extended SPI protocol,  $C_x = 7 + (A[MAX] + 1)$ ; For quad SPI protocol,  $C_x = 1 + (A[MAX] + 1)/4$ .  
2. S# not shown.

**Figure 38: EXTENDED QUAD INPUT FAST PROGRAM Command**



- Notes:
1. For extended SPI protocol,  $C_x = 7 + (A[MAX] + 1)/4$ ; For quad SPI protocol,  $C_x = 1 + (A[MAX] + 1)/4$ .
  2. S# not shown.

### ERASE Operations

An ERASE operation changes a bit from 0 to 1. Before any ERASE command is initiated, the WRITE ENABLE command must be executed to set the write enable latch bit to 1; if not, the device ignores the command and no error bits are set to indicate operation failure. S# is driven LOW and held LOW until the eighth bit of the last data byte has been latched in, after which it must be driven HIGH. The operations are self-timed, and duration is <sup>t</sup>SSE, <sup>t</sup>SE, or <sup>t</sup>BE according to command.

If S# is not driven HIGH, the command is not executed, flag status register error bits are not set, and the write enable latch remains set to 1. A command applied to a protected subsector is not executed. Instead, the write enable latch bit remains set to 1, and flag status register bits 1 and 5 are set.

When the operation is in progress, the program or erase controller bit of the flag status register is set to 0. In addition, the write in progress bit is set to 1. When the operation completes, the write in progress bit is cleared to 0. The write enable latch bit is cleared to 0, whether the operation is successful or not. If the operation times out, the write enable latch bit is reset and the erase error bit is set to 1.

The status register and flag status register can be polled for the operation status. When the operation completes, these register bits are cleared to 1.

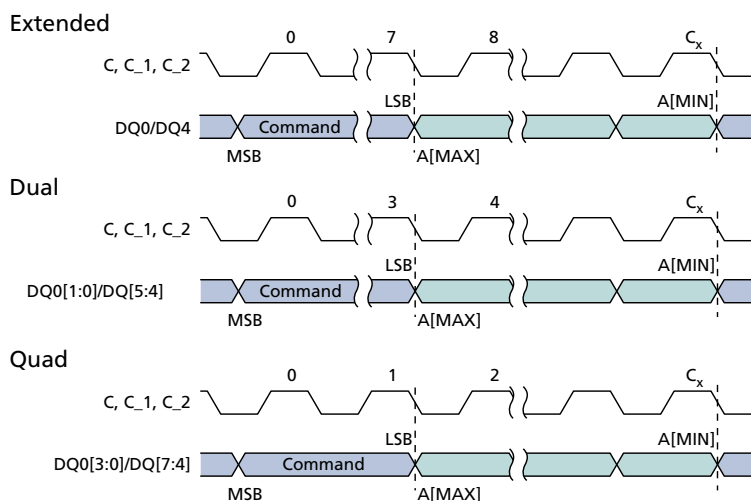
**Note:** For all ERASE operations, noisy or undesirable signal effects can be reduced and device data protection enhanced by holding S# LOW until the eighth bit of the last data byte has been latched in; this ensures that the number of clock pulses is a multiple of one byte before command execution.

The tables below apply to both of the die contained in the device.

**Table 30: ERASE Operations**

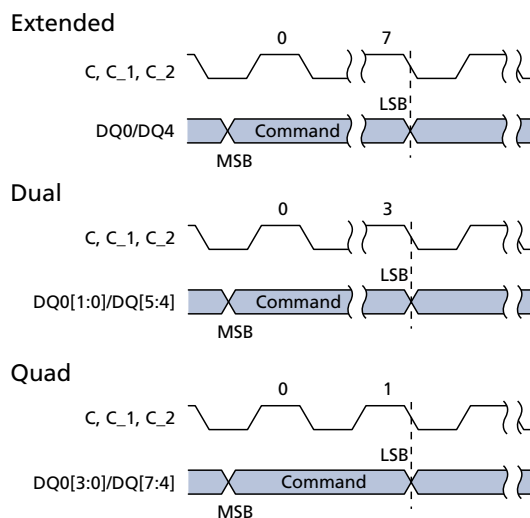
| Operation Name            | Description/Conditions                                                                                                                                                                                                                                                                               |
|---------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SUBSECTOR ERASE (52h/20h) | Sets the selected subsector or sector bits to FFh. Any address within the subsector is valid for entry. Each address bit is latched in during the rising edge of the clock. The operation can be suspended and resumed by the PROGRAM/ERASE SUSPEND and PROGRAM/ERASE RESUME commands, respectively. |
| SECTOR ERASE (D8h)        |                                                                                                                                                                                                                                                                                                      |
| BULK ERASE (C7h/60h)      | Sets the device bits to FFh.<br>The command is not executed if any sector is locked. Instead, the write enable latch bit remains set to 1, and flag status register bits 1 and 5 are set.                                                                                                            |

**Figure 39: SUBSECTOR and SECTOR ERASE Timing**



- Notes:
1. For extended SPI protocol,  $C_x = 7 + (A[\text{MAX}] + 1)$ ; For dual SPI protocol,  $C_x = 3 + (A[\text{MAX}] + 1)/2$ ; For quad SPI protocol,  $C_x = 1 + (A[\text{MAX}] + 1)/4$ .
  2. S# not shown.

**Figure 40: BULK ERASE Timing**



- Note:
1. S# not shown.

## SUSPEND/RESUME Operations

### PROGRAM/ERASE SUSPEND Operations

A PROGRAM/ERASE SUSPEND command enables the memory controller to interrupt and suspend an array PROGRAM or ERASE operation within the program/erase latency. To initiate the command, S# is driven LOW, and the command code is input on DQn. The operation is terminated by the PROGRAM/ERASE RESUME command.

For a PROGRAM SUSPEND, the flag status register bit 2 is set to 1. For an ERASE SUSPEND, the flag status register bit 6 is set to 1.

After an erase/program latency time, the flag status register bit 7 is also set to 1, but the device is considered in suspended state once bit 7 of the flag status register outputs 1 with at least one byte output. In the suspended state, the device is waiting for any operation.

If the time remaining to complete the operation is less than the suspend latency, the device completes the operation and clears the flag status register bits 2 or 6, as applicable. Because the suspend state is volatile, if there is a power cycle, the suspend state information is lost and the flag status register powers up as 80h.

It is possible to nest a PROGRAM/ERASE SUSPEND operation inside a PROGRAM/ERASE SUSPEND operation just once. Issue an ERASE command and suspend it. Then issue a PROGRAM command and suspend it also. With the two operations suspended, the next PROGRAM/ERASE RESUME command resumes the latter operation, and a second PROGRAM/ERASE RESUME command resumes the former (or first) operation.

### PROGRAM/ERASE RESUME Operations

A PROGRAM/ERASE RESUME operation terminates the PROGRAM/ERASE RESUME command. To initiate the command, S# is driven LOW, and the command code is input on DQn. The operation is terminated by driving S# HIGH.

The tables below apply to both of the die contained in the device.

**Table 31: SUSPEND/RESUME Operations**

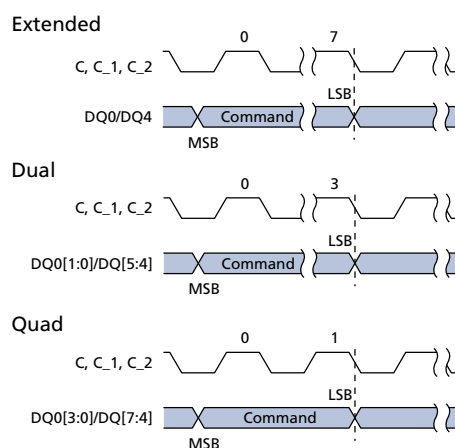
| Operation Name        | Description/Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|-----------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PROGRAM SUSPEND (75h) | A READ operation is possible in any page except the one in a suspended state. Reading from a sector that is in a suspended state will output indeterminate data.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| ERASE SUSPEND (75h)   | <p>A PROGRAM or READ operation is possible in any sector except the one in a suspended state. Reading from a sector that is in a suspended state will output indeterminate data. During a SUSPEND SUBSECTOR ERASE operation, reading an address in the sector that contains the suspended subsector could output indeterminate data.</p> <p>The device ignores a PROGRAM command to a sector that is in an erase suspend state; it also sets the flag status register bit 4 to 1 (program failure/protection error) and leaves the write enable latch bit unchanged.</p> <p>When the ERASE resumes, it does not check the new lock status of the WRITE VOLATILE LOCK BITS command.</p> |

**Table 31: SUSPEND/RESUME Operations (Continued)**

| Operation Name       | Description/Conditions                                                                                                                                                                                                                                                                                                                                                                                                                                |
|----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PROGRAM RESUME (7Ah) | <p>The status register write in progress bit is set to 1 and the flag status register program erase controller bit is set to 0. The command is ignored if the device is not in a suspended state.</p> <p>When the operation is in progress, the program or erase controller bit of the flag status register is set to 0. The flag status register can be polled for the operation status. When the operation completes, that bit is cleared to 1.</p> |
| ERASE RESUME (7Ah)   |                                                                                                                                                                                                                                                                                                                                                                                                                                                       |

Note: 1. See the Operations Allowed/Disallowed During Device States table.

**Figure 41: PROGRAM/ERASE SUSPEND or RESUME Timing**



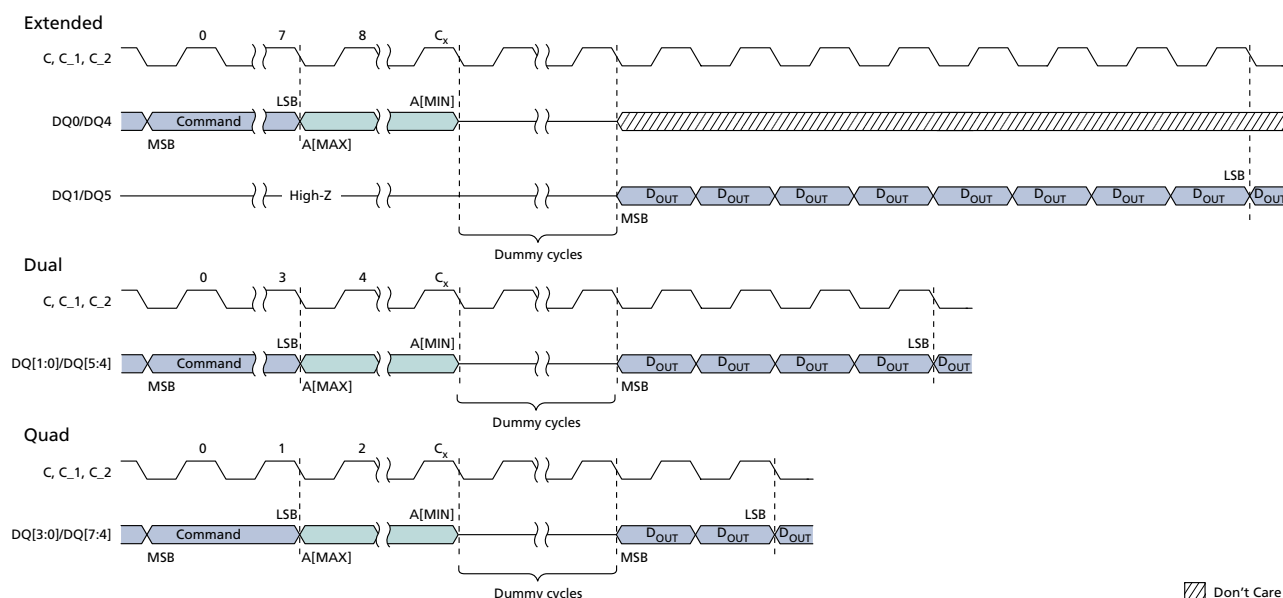
Note: 1. S# not shown.

## ONE-TIME PROGRAMMABLE Operations

### READ OTP ARRAY Command

To initiate a READ OTP ARRAY command,  $S\#$  is driven LOW. The command code is input on DQ0/DQ4, followed by address bytes and dummy clock cycles. Each address bit is latched in during the rising edge of C. Data is shifted out on DQ1/DQ5, beginning from the specified address and at a maximum frequency of  $f_C$  (MAX) on the falling edge of the clock. The address increments automatically to the next address after each byte of data is shifted out. There is no rollover mechanism; therefore, if read continuously, after location 0x40, the device continues to output data at location 0x40. The operation is terminated by driving  $S\#$  HIGH at any time during data output.

**Figure 42: READ OTP Command**



Note: 1. For extended SPI protocol,  $C_x = 7 + (A[\text{MAX}] + 1)$ ; For dual SPI protocol,  $C_x = 3 + (A[\text{MAX}] + 1)/2$ ; For quad SPI protocol,  $C_x = 1 + (A[\text{MAX}] + 1)/4$ .

### PROGRAM OTP ARRAY Command

To initiate the PROGRAM OTP ARRAY command, the WRITE ENABLE command must be issued to set the write enable latch bit to 1; otherwise, the PROGRAM OTP ARRAY command is ignored and flag status register bits are not set.  $S\#$  is driven LOW and held LOW until the eighth bit of the last data byte has been latched in, after which it must be driven HIGH. The command code is input on DQ0/DQ4, followed by address bytes and at least one data byte. Each address bit is latched in during the rising edge of the clock. When  $S\#$  is driven HIGH, the operation, which is self-timed, is initiated; its duration is  $t_{\text{POTP}}$ . There is no rollover mechanism; therefore, after a maximum of 65 bytes are latched in the subsequent bytes are discarded.

PROGRAM OTP ARRAY programs, at most, 64 bytes to the OTP memory area and one OTP control byte. When the operation is in progress, the write in progress bit is set to 1. The write enable latch bit is cleared to 0, whether the operation is successful or not, and

the status register and flag status register can be polled for the operation status. When the operation completes, the write in progress bit is cleared to 0.

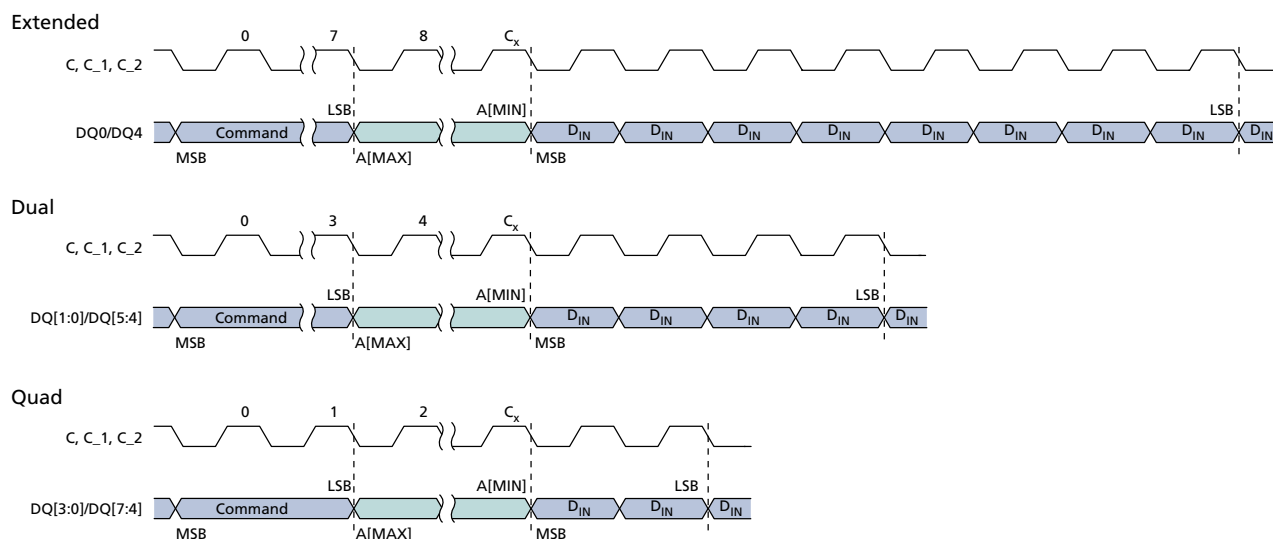
If the operation times out, the write enable latch bit is reset and the program fail bit is set to 1. If S# is not driven HIGH, the command is not executed, flag status register error bits are not set, and the write enable latch remains set to 1. The operation is considered complete once bit 7 of the flag status register outputs 1 with at least one byte output.

The OTP control byte (byte 64) is used to permanently lock the OTP memory array.

**Table 32: OTP Control Byte (Byte 64)**

| Bit | Name             | Settings                             | Description                                                                                                                                                                                                                                                                                                                                                     |
|-----|------------------|--------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0   | OTP control byte | 0 = Locked<br>1 = Unlocked (default) | Used to permanently lock the 64-byte OTP array. When bit 0 = 1, the 64-byte OTP array can be programmed. When bit 0 = 0, the 64-byte OTP array is read only.<br><br>Once bit 0 has been programmed to 0, it can no longer be changed to 1. Program OTP array is ignored, the write enable latch bit remains set, and flag status register bits 1 and 4 are set. |

**Figure 43: PROGRAM OTP Command**



Note: 1. For extended SPI protocol,  $C_x = 7 + (A[\text{MAX}] + 1)$ ; For dual SPI protocol,  $C_x = 3 + (A[\text{MAX}] + 1)/2$ ; For quad SPI protocol,  $C_x = 1 + (A[\text{MAX}] + 1)/4$ .

## DEEP POWER-DOWN Operations

### ENTER DEEP POWER-DOWN Command

To execute ENTER DEEP POWER-DOWN, S# must be driven HIGH after the eighth bit of the command code is latched in, after which, t<sub>DP</sub> time must elapse before the supply

current is reduced to  $I_{CC2}$ . Any attempt to execute ENTER DEEP POWER-DOWN during a WRITE operation is rejected without affecting the operation.

In deep power-down mode, no device error bits are set, the WEL state is unchanged, and the device ignores all commands except RELEASE FROM DEEP POWER-DOWN, RESET ENABLE, RESET, hardware reset, and power-loss rescue sequence commands.

## RELEASE FROM DEEP POWER-DOWN Command

To execute the RELEASE FROM DEEP POWER-DOWN command, S# is driven LOW, followed by the command code. Sending additional clock cycles on C while S# is driven LOW voids the command.

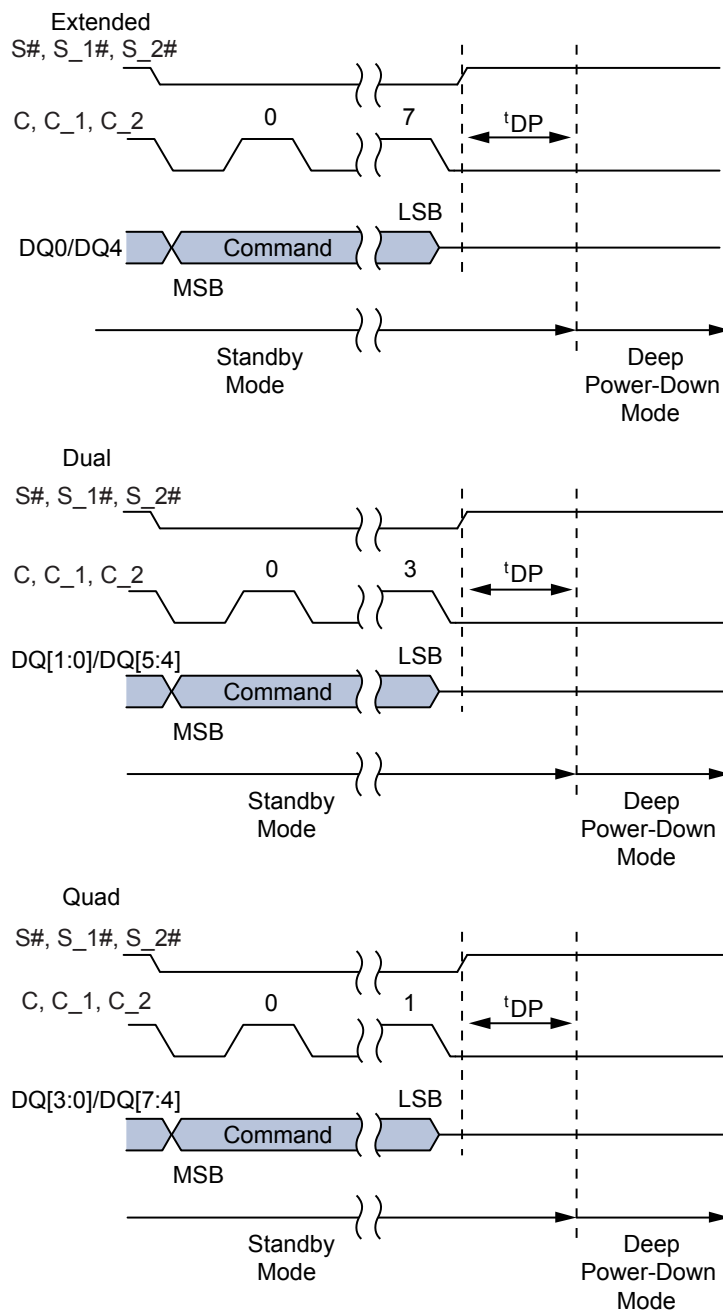
RELEASE FROM DEEP POWER-DOWN is terminated by driving S# HIGH. The device enters standby mode after S# is driven HIGH followed by a delay of  $t_{RDP}$ . S# must remain HIGH during this time.

**Table 33: DEEP POWER-DOWN Operations**

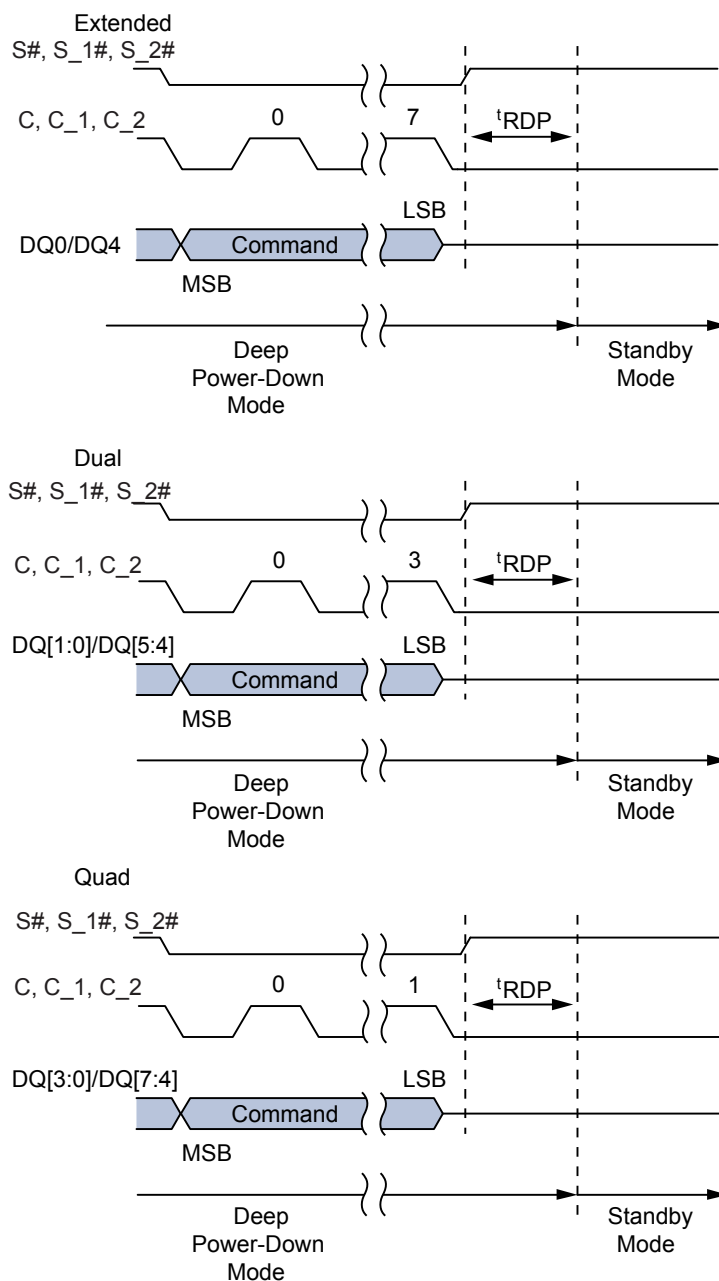
| Operation Name                     | Description/Conditions                                                                                                                                                                                                                                                                                    |
|------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ENTER DEEP POWER-DOWN (B9h)        | The command is used to place the device in deep power-down mode for the lowest device power consumption, with device current reduced to $I_{CC2}$ . This command can also be used as a software protection mechanism while the device is not in active use.                                               |
| RELEASE FROM DEEP POWER-DOWN (ABh) | The command is used to exit from deep power-down mode. The device also exits deep power-down mode upon:<br>A power-down, entering standby mode with the next power-up.<br>A hardware or software reset operation, entering standby mode with a recovery time as specified in the AC Reset Specifications. |

## DEEP POWER-DOWN Timings

**Figure 44: ENTER DEEP POWER-DOWN Timing**



**Figure 45: RELEASE FROM DEEP POWER-DOWN Timing**



## ADDRESS MODE Operations

### ENTER and EXIT 4-BYTE ADDRESS MODE Command

To initiate these commands, S# is driven LOW, and the command is input on DQ<sub>n</sub>.

**Table 34: ENTER and EXIT 4-BYTE ADDRESS MODE Operations**

| Operation Name                  | Description/Conditions                                                                                                                                       |
|---------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ENTER 4-BYTE ADDRESS MODE (B7h) | The effect of the command is immediate. The default address mode is three bytes, and the device returns to the default upon exiting the 4-byte address mode. |
| EXIT 4-BYTE ADDRESS MODE (E9h)  |                                                                                                                                                              |

## QUAD PROTOCOL Operations

### ENTER or RESET QUAD INPUT/OUTPUT MODE Command

To initiate these commands, the WRITE ENABLE command must not be executed. S# must be driven LOW, and the command must be input on DQ<sub>n</sub>.

**Table 35: ENTER and RESET QUAD PROTOCOL Operations**

| Operation Name                     | Description/Conditions                  |
|------------------------------------|-----------------------------------------|
| ENTER QUAD INPUT/OUTPUT MODE (35h) | The effect of the command is immediate. |
| RESET QUAD INPUT/OUTPUT MODE (F5h) |                                         |

## CYCLIC REDUNDANCY CHECK Operations

A CYCLIC REDUNDANCY CHECK (CRC) operation is a hash function designed to detect accidental changes to raw data and is used commonly in digital networks and storage devices such as hard disk drives. A CRC-enabled device calculates a short, fixed-length binary sequence, known as the CRC code or just CRC, for each block of data. CRC can be a higher performance alternative to reading data directly in order to verify recently programmed data. Or, it can be used to check periodically the data integrity of a large block of data against a stored CRC reference over the life of the product. CRC helps improve test efficiency for programmer or burn-in stress tests. No system hardware changes are required to enable CRC.

The CRC-64 operation follows the ECMA standard. The generating polynomial is:

$$G(x) = x^{64} + x^{62} + x^{57} + x^{55} + x^{54} + x^{53} + x^{52} + x^{47} + x^{46} + x^{45} + x^{40} + x^{39} + x^{38} + x^{37} + x^{35} + x^{33} + x^{32} + x^{31} + x^{29} + x^{27} + x^{24} + x^{23} + x^{22} + x^{21} + x^{19} + x^{17} + x^{13} + x^{12} + x^{10} + x^9 + x^7 + x^4 + x + 1$$

**Note:** The data stream sequence is from LSB to MSB and the default initial CRC value is all zero.

The device CRC operation generates the CRC result of the entire device or of an address range specified by the operation. Then the CRC result is compared with the expected CRC data provided in the sequence. Finally the device indicates a pass or fail through the bit #4 of FLAG STATUS REGISTER. If the CRC fails, it is possible to take corrective action such as verifying with a normal read mode or by rewriting the array data.

CRC operation supports CRC data read back when CRC check fails; the CRC data generated from the target address range or entire device will be stored in a dedicated register: general purpose read register (GPRR) only when CRC check fails, and it can be read out through the GPRR read sequence with command 96h, least significant byte first. GPRR is reset to default all 0 at the beginning of the CRC operation, and so customer will read all 0 if CRC operation pass.

Note that the GPRR is a volatile register. It is cleared to all 0s on power-up and hardware/software reset. Read GPRR starts from the first location, when clocked continuously, will output 00h after location 64.

The CYCLIC REDUNDANCY CHECK operation command sequences are shown in the tables below, for an entire die or for a selected range.

**Table 36: CRC Command Sequence on Entire Device**

| Command Sequence |            | Description                                                     |
|------------------|------------|-----------------------------------------------------------------|
| Byte#            | Data       |                                                                 |
| 1                | 9Bh        | Command code for interface activation                           |
| 2                | 27h        | Sub-command code for CRC operation                              |
| 3                | FFh        | CRC operation option selection (CRC operation on entire device) |
| 4                | CRC[7:0]   | 1st byte of expected CRC value                                  |
| 5–10             | CRC[55:8]  | 2nd to 7th byte of expected CRC value                           |
| 11               | CRC[63:56] | 8th byte of expected CRC value                                  |
| Drive S# HIGH    |            | Operation sequence confirmed; CRC operation starts              |

**Table 37: CRC Command Sequence on a Range**

| Command Sequence |                       | Description                                               |
|------------------|-----------------------|-----------------------------------------------------------|
| Byte#            | Data                  |                                                           |
| 1                | 9Bh                   | Command code for interface activation                     |
| 2                | 27h                   | Sub-command code for CRC operation                        |
| 3                | FEh                   | CRC operation option selection (CRC operation on a range) |
| 4                | CRC[7:0]              | 1st byte of expected CRC value                            |
| 5–10             | CRC[55:8]             | 2nd to 7th byte of expected CRC value                     |
| 11               | CRC[63:56]            | 8th byte of expected CRC value                            |
| 12               | Start Address [7:0]   | Specifies the starting byte address for CRC operation     |
| 13–14            | Start Address [23:8]  |                                                           |
| 15               | Start Address [31:24] |                                                           |
| 16               | Stop Address [7:0]    | Specifies the ending byte address for CRC operation       |
| 17–18            | Stop Address [23:8]   |                                                           |
| 19               | Stop Address [31:24]  |                                                           |
| Drive S# HIGH    |                       | Operation sequence confirmed; CRC operation starts        |

## State Table

The device can be in only one state at a time. Depending on the state of the device, some operations as shown in the table below are allowed (Yes) and others are not (No). For example, when the device is in the standby state, all operations except SUSPEND are allowed in any sector. For all device states except the erase suspend state, if an operation is allowed or disallowed in one sector, it is allowed or disallowed in all other sectors. In the erase suspend state, a PROGRAM operation is allowed in any sector except the one in which an ERASE operation has been suspended.

**Table 38: Operations Allowed/Disallowed During Device States**

| Operation                           | Standby State | Program or Erase State | Subsector Erase Suspend or Program Suspend State | Erase Suspend State | Notes |
|-------------------------------------|---------------|------------------------|--------------------------------------------------|---------------------|-------|
| READ (memory)                       | Yes           | No                     | Yes                                              | Yes                 | 1     |
| READ (status/flag status registers) | Yes           | Yes                    | Yes                                              | Yes                 | 6     |
| PROGRAM                             | Yes           | No                     | No                                               | Yes/No              | 2     |
| ERASE (sector/subsector)            | Yes           | No                     | No                                               | No                  | 3     |
| WRITE                               | Yes           | No                     | No                                               | No                  | 4     |
| WRITE                               | Yes           | No                     | Yes                                              | Yes                 | 5     |
| SUSPEND                             | No            | Yes                    | No                                               | No                  | 7     |

- Notes:
1. All READ operations except READ STATUS REGISTER and READ FLAG REGISTER. When issued to a sector or subsector that is simultaneously in an erase suspend state, the READ operation is accepted, but the data output is not guaranteed until the erase has completed.
  2. All PROGRAM operations except PROGRAM OTP. In the erase suspend state, a PROGRAM operation is allowed in any sector (Yes) except the sector (No) in which an ERASE operation has been suspended.
  3. Applies to the SECTOR ERASE or SUBSECTOR ERASE operation.
  4. Applies to the following operations: WRITE STATUS REGISTER, WRITE NONVOLATILE CONFIGURATION REGISTER, PROGRAM OTP, and DIE ERASE.
  5. Applies to the WRITE VOLATILE CONFIGURATION REGISTER, WRITE ENHANCED VOLATILE CONFIGURATION REGISTER, WRITE ENABLE, WRITE DISABLE, CLEAR FLAG STATUS REGISTER, or WRITE LOCK REGISTER operation.
  6. Applies to the READ STATUS REGISTER or READ FLAG STATUS REGISTER operation.
  7. Applies to the PROGRAM SUSPEND or ERASE SUSPEND operation.

## XIP Mode

Execute-in-place (XIP) mode allows the memory to be read by sending an address to the device and then receiving the data on one, two, or four pins in parallel, depending on the customer requirements. XIP mode offers maximum flexibility to the application, saves instruction overhead, and reduces random access time.

### Activate or Terminate XIP Using Volatile Configuration Register

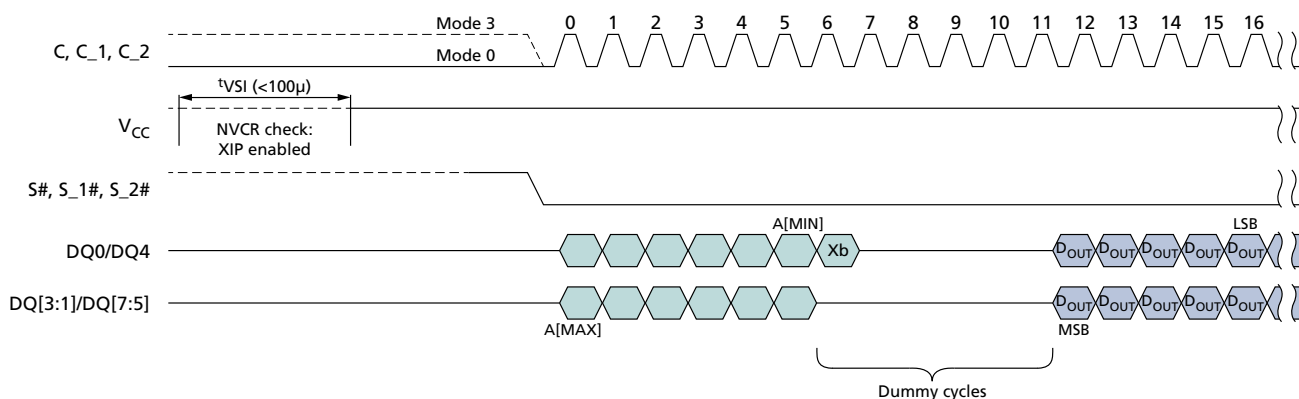
Applications that boot in SPI and must switch to XIP use the volatile configuration register. XIP provides faster memory READ operations by requiring only an address to execute, rather than a command code and an address.

To activate XIP requires two steps. First, enable XIP by setting volatile configuration register bit 3 to 0. Next, drive the XIP confirmation bit to 0 during the next FAST READ operation. XIP is then active. Once in XIP, any command that occurs after S# is toggled requires only address bits to execute; a command code is not necessary, and device operations use the SPI protocol that is enabled. XIP is terminated by driving the XIP confirmation bit to 1. The device automatically resets volatile configuration register bit 3 to 1.

### Activate or Terminate XIP Using Nonvolatile Configuration Register

Applications that must boot directly in XIP use the nonvolatile configuration register. To enable a device to power-up in XIP using this register, set nonvolatile configuration register bits [11:9]. Settings vary according to protocol, as explained in the Nonvolatile Configuration Register section. Because the device boots directly in XIP, after the power cycle, no command code is necessary. XIP is terminated by driving the XIP confirmation bit to 1.

**Figure 46: XIP Mode Directly After Power-On**



Note: 1. Xb is the XIP confirmation bit and should be set as follows: 0 to keep XIP state; 1 to exit XIP mode and return to standard read mode.

### Confirmation Bit Settings Required to Activate or Terminate XIP

The XIP confirmation bit setting activates or terminates XIP after it has been enabled or disabled. This bit is the value on DQ0/DQ4 during the first dummy clock cycle in the FAST READ operation. In dual I/O XIP mode, the value of DQ1/DQ5 during the first dummy clock cycle after the addresses is always "Don't Care." In quad I/O XIP mode,

the values of DQ3/DQ7, DQ2/DQ6, and DQ1/DQ5 during the first dummy clock cycle after the addresses are always "Don't Care."

**Table 39: XIP Confirmation Bit**

| Bit Value | Description                                                                                 |
|-----------|---------------------------------------------------------------------------------------------|
| 0         | Activates XIP: While this bit is 0, XIP remains activated.                                  |
| 1         | Terminates XIP: When this bit is set to 1, XIP is terminated and the device returns to SPI. |

**Table 40: Effects of Running XIP in Different Protocols**

| Protocol                  | Effect                                                                                                                                                                                                                          |
|---------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Extended I/O and Dual I/O | In a device with a dedicated part number where RESET# is enabled, a LOW pulse on that pin resets XIP and the device to the state it was in previous to the last power-up, as defined by the nonvolatile configuration register. |
| Dual I/O                  | Values of DQ1/DQ5 during the first dummy clock cycle are "Don't Care."                                                                                                                                                          |
| Quad I/O <sup>1</sup>     | Values of DQ[3:1]/DQ[7:5] during the first dummy clock cycle are "Don't Care." In a device with a dedicated part number, it is only possible to reset memory when the device is deselected.                                     |

Note: 1. In a device with a dedicated part number where RESET# is enabled, a LOW pulse on that pin resets XIP and the device to the state it was in previous to the last power-up, as defined by the nonvolatile configuration register only when the device is deselected.

## Terminating XIP After a Controller and Memory Reset

The system controller and the device can become out of synchronization if, during the life of the application, the system controller is reset without the device being reset. In such a case, the controller can reset the memory to power-on reset if the memory has reset functionality. (Reset is available in devices with a dedicated part number.)

- 7 clock cycles within S# LOW (S# becomes HIGH before 8th clock cycle)
- + 9 clock cycles within S# LOW (S# becomes HIGH before 10th clock cycle)
- + 13 clock cycles within S# LOW (S# becomes HIGH before 14th clock cycle)
- + 17 clock cycles within S# LOW (S# becomes HIGH before 18th clock cycle)
- + 25 clock cycles within S# LOW (S# becomes HIGH before 26th clock cycle)
- + 33 clock cycles within S# LOW (S# becomes HIGH before 34th clock cycle)

These sequences cause the controller to set the XIP confirmation bit to 1, thereby terminating XIP. However, it does not reset the device or interrupt PROGRAM/ERASE operations that may be in progress. After terminating XIP, the controller must execute RESET ENABLE and RESET MEMORY to implement a software reset and reset the device.

## Power-Up and Power-Down

### Power-Up and Power-Down Requirements

At power-up and power-down, the device must not be selected; that is, S# must follow the voltage applied on  $V_{CC}$  until  $V_{CC}$  reaches the correct values:  $V_{CC,min}$  at power-up and  $V_{SS}$  at power-down.

To provide device protection and prevent data corruption and inadvertent WRITE operations during power-up, a power-on reset circuit is included. The logic inside the device is held to RESET while  $V_{CC}$  is less than the power-on reset threshold voltage shown here; all operations are disabled, and the device does not respond to any instruction. During a standard power-up phase, the device ignores all commands except READ STATUS REGISTER and READ FLAG STATUS REGISTER. These operations can be used to check the memory internal state. After power-up, the device is in standby power mode; the write enable latch bit is reset; the write in progress bit is reset; and the dynamic protection register is configured as: (write lock bit, lock down bit) = (0,0).

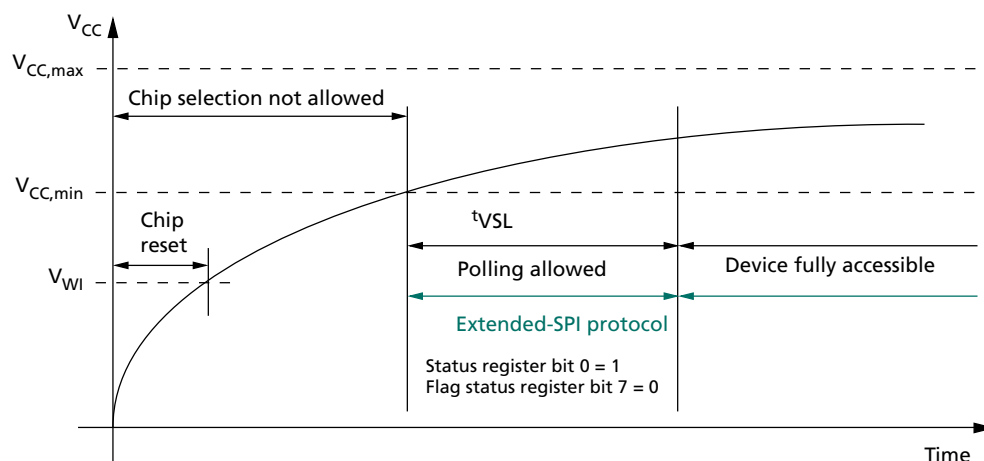
Normal precautions must be taken for supply line decoupling to stabilize the  $V_{CC}$  supply. Each device in a system should have the  $V_{CC}$  line decoupled by a suitable capacitor (typically 100nF) close to the package pins. At power-down, when  $V_{CC}$  drops from the operating voltage to below the power-on-reset threshold voltage shown here, all operations are disabled and the device does not respond to any command.

When the operation is in progress, the program or erase controller bit of the status register is set to 0. To obtain the operation status, the flag status register must be polled. When the operation completes, the program or erase controller bit is cleared to 1. The cycle is complete after the flag status register outputs the program or erase controller bit to 1.

**Note:** If power-down occurs while a WRITE, PROGRAM, or ERASE cycle is in progress, data corruption may result.

**Note:** For additional details about how to properly apply and remove the power supply to the device, refer to TN-25-38: Power-Up, Power-Down, and Brownout Considerations on MT25Q, MT25T, and MT35X NOR Flash Memory

**Figure 47: Power-Up Timing**



- Notes:
1.  $t_{VSL}$  polling has to be in Extended-SPI protocol and STR mode.
  2. During  $t_{VSL}$  period,  $HOLD\#$  is enabled,  $RESET\#$  disabled, and output strength is in default setting.
  3. In a system that uses a fast  $V_{CC}$  ramp rate, current design requires a minimum 100 $\mu s$  after  $V_{CC}$  reaches  $V_{WVI}$ , and before the polling is allowed, even though  $V_{CC,min}$  is achieved.

**Table 41: Power-Up Timing and  $V_{WVI}$  Threshold**

Note 1 applies to entire table

| Symbol    | Parameter                               | Min | Max | Unit    | Notes |
|-----------|-----------------------------------------|-----|-----|---------|-------|
| $t_{VSL}$ | $V_{CC,min}$ to device fully accessible | –   | 300 | $\mu s$ | 2, 3  |
| $V_{WVI}$ | Write inhibit voltage                   | 1.5 | 2.5 | V       | 2     |

- Notes:
1. When  $V_{CC}$  reaches  $V_{CC,min}$ , to determine whether power-up initialization is complete, the host can poll status register bit 0 or flag status register bit 7 only in extended SPI protocol because the device will accept commands only on DQ0/DQ4 and output data only on DQ1/DQ5. When the device is ready, the host has full access using the protocol configured in the nonvolatile configuration register. If the host cannot poll the status register in x1 SPI mode, it is recommended to wait  $t_{VSL}$  before accessing the device.
  2. Parameters listed are characterized only.
  3. On the first power up after an event causing a sub-sector erase operation interrupt (e.g. due to power-loss), the maximum time for  $t_{VSL}$  will be up to 4.5ms in case of 4KB sub-sector erase interrupt and up to 36ms in case of 32KB sub-sector erase interrupt; this accounts for erase recovery embedded operation.

## Active, Standby, and Deep Power-Down Modes

When  $S\#$  is LOW, the device is selected and in active power mode. When  $S\#$  is HIGH, the device is deselected but could remain in active power mode until ongoing internal operations are completed. Then the device goes into standby power mode and device current consumption drops to  $I_{CC1}$ .

Deep power-down mode enables users to place the device in the lowest power consumption mode,  $I_{CC2}$ . The ENTER DEEP POWER-DOWN command is used to put the device in deep power-down mode, and the RELEASE FROM DEEP POWER-DOWN command is used to bring the device out of deep power-down mode. Command details are in the Command Set table and the DEEP POWER-DOWN Operations section of this data sheet.

## Power Loss and Interface Rescue

If a power loss occurs during a WRITE NONVOLATILE CONFIGURATION REGISTER command, after the next power-on, the device might begin in an undetermined state (XIP mode or an unnecessary protocol). If this occurs, a power loss recovery sequence must reset the device to a fixed state (extended SPI protocol without XIP) until the next power-up.

If the controller and memory device get out of synchronization, the controller can follow an interface rescue sequence to reset the memory device interface to power-up to the last reset state (as defined by latest nonvolatile configuration register). This resets only the interface, not the entire memory device, and any ongoing operations are not interrupted.

After each sequence, the issue should be resolved definitively by running the WRITE NONVOLATILE CONFIGURATION REGISTER command again.

**Note:** The two steps in each sequence must be in the correct order, and <sup>t</sup>SHSL2 must be at least 50ns for the duration of each sequence.

The first step for both the power loss recovery and interface rescue sequences is described under "Recovery." The second step in the power loss recovery sequence is under "Power Loss Recovery" and the second step in the interface rescue sequence is under "Interface Rescue."

### Recovery

Step one of both the power loss recovery and interface rescue sequences is DQ0/DQ4 (PAD DATA) and DQ3/DQ7 (PAD HOLD) equal to 1 for the situations listed here:

- 7 clock cycles within S# LOW (S# becomes HIGH before 8th clock cycle)
- + 9 clock cycles within S# LOW (S# becomes HIGH before 10th clock cycle)
- + 13 clock cycles within S# LOW (S# becomes HIGH before 14th clock cycle)
- + 17 clock cycles within S# LOW (S# becomes HIGH before 18th clock cycle)
- + 25 clock cycles within S# LOW (S# becomes HIGH before 26th clock cycle)
- + 33 clock cycles within S# LOW (S# becomes HIGH before 34th clock cycle)

### Power Loss Recovery

For power loss recovery, the second part of the sequence is exiting from dual or quad SPI protocol by using the following FFh sequence: DQ0/DQ4 and DQ3/DQ7 equal to 1 for 8 clock cycles within S# LOW; S# becomes HIGH before 9th clock cycle. After this two-part sequence the extended SPI protocol is active.

### Interface Rescue

For interface rescue, the second part of the sequence is for exiting from dual or quad SPI protocol by using the following FFh sequence: DQ0/DQ4 and DQ3/DQ7 equal to 1 for 16 clock cycles within S# LOW; S# becomes HIGH before 17th clock cycle. For DTR protocol, 1 should be driven on both edges of clock for 16 cycles with S# LOW. After this two-part sequence, the extended SPI protocol is active.

### Absolute Ratings and Operating Conditions

Stresses greater than those listed may cause permanent damage to the device. This is a stress rating only. Exposure to absolute maximum rating for extended periods may adversely affect reliability. Stressing the device beyond the absolute maximum ratings may cause permanent damage.

**Table 42: Absolute Ratings**

| Symbol            | Parameter                                          | Min   | Max                   | Units | Notes |
|-------------------|----------------------------------------------------|-------|-----------------------|-------|-------|
| T <sub>STG</sub>  | Storage temperature                                | -65   | 150                   | °C    |       |
| T <sub>LEAD</sub> | Lead temperature during soldering                  | –     | See note 1            | °C    |       |
| V <sub>CC</sub>   | Supply voltage                                     | -0.6  | 4.0                   | V     | 2     |
| V <sub>IO</sub>   | Input/output voltage with respect to ground        | -0.6  | V <sub>CC</sub> + 0.6 | V     | 2     |
| V <sub>ESD</sub>  | Electrostatic discharge voltage (human body model) | -2000 | 2000                  | V     | 2, 3  |

- Notes:
1. Compliant with JEDEC Standard J-STD-020C (for small-body, Sn-Pb or Pb assembly), RoHS, and the European directive on Restrictions on Hazardous Substances (RoHS) 2002/95/EU.
  2. All specified voltages are with respect to V<sub>SS</sub>. During infrequent, nonperiodic transitions, the voltage potential between V<sub>SS</sub> and the V<sub>CC</sub> may undershoot to -2.0V for periods less than 20ns, or overshoot to V<sub>CC,max</sub> + 2.0V for periods less than 20ns.
  3. JEDEC Standard JESD22-A114A (C1 = 100pF, R1 = 1500Ω, R2 = 500Ω).

**Table 43: Operating Conditions**

| Symbol          | Parameter                                | Min | Max | Units |
|-----------------|------------------------------------------|-----|-----|-------|
| V <sub>CC</sub> | Supply voltage                           | 2.7 | 3.6 | V     |
| T <sub>A</sub>  | Ambient operating temperature (AT range) | -40 | 105 | °C    |

**Table 44: Input/Output Capacitance**

Note 1 applies to entire table

| Symbol              | Description                                                  | Min | Max    | Units |
|---------------------|--------------------------------------------------------------|-----|--------|-------|
| C <sub>IN/OUT</sub> | Input/output capacitance (DQ0/DQ1/DQ2/DQ3) (DQ4/DQ5/DQ6/DQ7) | –   | 10     | pF    |
| C <sub>IN</sub>     | Input capacitance (other pins)                               | –   | 6 (2)  | pF    |
| C <sub>IN/S#</sub>  | Input/Chip select                                            | –   | 10 (3) | pF    |

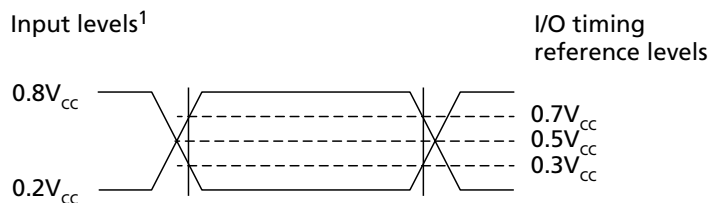
- Notes:
1. Verified in device characterization; not 100% tested. These parameters are not subject to a production test. They are verified by design and characterization. The capacitance is measured according to JEP147 ("PROCEDURE FOR MEASURING INPUT CAPACITANCE USING A VECTOR NETWORK ANALYZER (VNA)") with V<sub>CC</sub> and V<sub>SS</sub> applied and all other pins floating (except the pin under test), V<sub>BIAS</sub> = V<sub>CC</sub>/2, T<sub>A</sub> = 25°C, Frequency = 54 MHz
  2. For 1CS/1CLK configuration, capacitance is double for CLK and it is 12pF.
  3. For 1CS/1CLK configuration, capacitance is double for Chip Select pin and it is 20pF.

**Table 45: AC Timing Input/Output Conditions**

| Symbol | Description                      | Min                        | Max        | Units | Notes |
|--------|----------------------------------|----------------------------|------------|-------|-------|
| $C_L$  | Load capacitance                 | 10                         | 30         | pF    | 1     |
| –      | Input rise and fall times        | –                          | 1.5        | ns    |       |
|        | Input pulse voltages             | $0.2V_{CC}$ to $0.8V_{CC}$ |            | V     | 2     |
|        | Input timing reference voltages  | $0.3V_{CC}$ to $0.7V_{CC}$ |            | V     |       |
|        | Output timing reference voltages | $V_{CC}/2$                 | $V_{CC}/2$ | V     |       |

- Notes: 1. Output buffers are configurable by user.  
 2. For quad/dual operations: 0V to  $V_{CC}$ .

**Figure 48: AC Timing Input/Output Reference Levels**



- Note: 1.  $0.8V_{CC} = V_{CC}$  for dual/quad operations;  $0.2V_{CC} = 0V$  for dual/quad operations.

## Initial Delivery Status

The device is delivered as the following:

- Memory array erased: all bits are set to 1 (each byte contains FFh)
- Status register contains 00h (all status register bits are 0)
- Nonvolatile configuration register (NVCR) bits are all erased (FFFFh)

## DC Characteristics and Operating Conditions

The table below applies to each 512Mb Flash device. As each 512Mb device can operate independently from each other, Designer must take into consideration combined total power consumption of Twin-Quad 1Gb device

**Table 46: DC Current Characteristics and Operating Conditions**

Notes 1–5 apply to entire table

| Parameter                                  | Symbol           | Test Conditions                                                             | Typ | Max | Unit |
|--------------------------------------------|------------------|-----------------------------------------------------------------------------|-----|-----|------|
| Input leakage current                      | I <sub>LI</sub>  |                                                                             | –   | ±2  | µA   |
| Output leakage current                     | I <sub>LO</sub>  |                                                                             | –   | ±2  | µA   |
| Standby current (AT range)                 | I <sub>CC1</sub> | S# = V <sub>CC</sub> , V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub> | 30  | 200 | µA   |
| Deep power-down current (AT range)         | I <sub>CC2</sub> | S# = V <sub>CC</sub> , V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub> | 5   | 100 | µA   |
| Operating current (fast-read extended I/O) | I <sub>CC3</sub> | C = 0.1V <sub>CC</sub> /0.9V <sub>CC</sub> at 133 MHz, DQ1/DQ5 = open       | –   | 16  | mA   |
|                                            |                  | C = 0.1V <sub>CC</sub> /0.9V <sub>CC</sub> at 54 MHz, DQ1/DQ5 = open        | –   | 10  | mA   |
| Operating current (fast-read dual I/O)     |                  | C = 0.1V <sub>CC</sub> /0.9V <sub>CC</sub> at 133 MHz DQ = open             | –   | 20  | mA   |
| Operating current (fast-read quad I/O)     |                  | C = 0.1V <sub>CC</sub> /0.9V <sub>CC</sub> at 133 MHz, DQ = open            | –   | 24  | mA   |
|                                            |                  | C = 0.1V <sub>CC</sub> /0.9V <sub>CC</sub> at 80 MHz DTR, DQ = open         | –   | 28  | mA   |
|                                            |                  | C = 0.1V <sub>CC</sub> /0.9V <sub>CC</sub> at 90 MHz DTR, DQ = open         | –   | 31  | mA   |
| Operating current (PROGRAM operations)     | I <sub>CC4</sub> | S# = V <sub>CC</sub>                                                        | –   | 35  | mA   |
| Operating current (WRITE operations)       | I <sub>CC5</sub> | S# = V <sub>CC</sub>                                                        | –   | 35  | mA   |
| Operating current (erase)                  | I <sub>CC6</sub> | S# = V <sub>CC</sub>                                                        | –   | 35  | mA   |

- Notes:
1. All currents are RMS unless noted. Typical values at typical  $V_{CC}$  (3.0/1.8V);  $V_{IO} = 0V/V_{CC}$ ;  $T_C = +25^\circ C$ .
  2. Standby current is the average current measured over any time interval 5 $\mu s$  after S de-assertion (and any internal operations are complete).
  3. Deep power-down current is the average current measured 5ms over any 5ms time interval, 100 $\mu s$  after the ENTER DEEP POWER-DOWN operation (and any internal operations are complete).
  4. All read currents are the average current measured over any 1KB continuous read. No load, checker-board pattern.
  5. All program currents are the average current measured over any 256-byte typical data program.

**Table 47: DC Voltage Characteristics and Operating Conditions**

Note 1 applies to entire table

| Parameter           | Symbol   | Conditions                 | Min            | Max            | Unit |
|---------------------|----------|----------------------------|----------------|----------------|------|
| Input low voltage   | $V_{IL}$ |                            | -0.5           | $0.3V_{CC}$    | V    |
| Input high voltage  | $V_{IH}$ |                            | $0.7V_{CC}$    | $V_{CC} + 0.4$ | V    |
| Output low voltage  | $V_{OL}$ | $I_{OL} = 1.6\text{mA}$    | -              | 0.4            | V    |
| Output high voltage | $V_{OH}$ | $I_{OH} = -100\mu\text{A}$ | $V_{CC} - 0.2$ | -              | V    |

Note: 1.  $V_{IL}$  can undershoot to -1.0V for periods <2ns and  $V_{IH}$  may overshoot to  $V_{CC,max} + 1.0\text{V}$  for periods less than 2ns.

## AC Characteristics and Operating Conditions

**Table 48: AC Characteristics and Operating Conditions**

| Parameter                                                                                      | Symbol      | Data Transfer Rate | Min   | Typ | Max | Unit | Notes |
|------------------------------------------------------------------------------------------------|-------------|--------------------|-------|-----|-----|------|-------|
| Clock frequency for all commands other than READ (Extended-SPI, DIO-SPI, and QIO-SPI protocol) | $f_C$       | STR                | DC    | –   | 133 | MHz  |       |
|                                                                                                |             | DTR                | DC    | –   | 90  |      |       |
| Clock frequency for READ command (03h or 13h)                                                  | $f_R$       | STR                | DC    | –   | 54  | MHz  |       |
|                                                                                                |             | DTR                | DC    | –   | 27  |      |       |
| Clock HIGH time                                                                                | $t_{CH}$    | STR                | 3.375 | –   | –   | ns   | 2     |
|                                                                                                |             | DTR                | 5.0   | –   | –   |      |       |
| Clock LOW time                                                                                 | $t_{CL}$    | STR                | 3.375 | –   | –   | ns   | 2     |
|                                                                                                |             | DTR                | 5.0   | –   | –   |      |       |
| Clock rise time (peak-to-peak)                                                                 | $t_{CLCH}$  | STR/DTR            | 0.1   | –   | –   | V/ns | 3, 4  |
| Clock fall time (peak-to-peak)                                                                 | $t_{CHCL}$  | STR/DTR            | 0.1   | –   | –   | V/ns | 3, 4  |
| S# active setup time (relative to clock)                                                       | $t_{SLCH}$  | STR/DTR            | 3.375 | –   | –   | ns   |       |
| S# not active hold time (relative to clock)                                                    | $t_{CHSL}$  | STR/DTR            | 3.375 | –   | –   | ns   |       |
| Data in setup time                                                                             | $t_{DVCH}$  | STR                | 1.75  | –   | –   | ns   |       |
|                                                                                                |             | DTR                | 1.5   | –   | –   | ns   |       |
|                                                                                                | $t_{DVCL}$  | DTR only           | 1.5   | –   | –   | ns   |       |
| Data in hold time                                                                              | $t_{CHDX}$  | STR/DTR            | 2.3   | –   | –   | ns   |       |
|                                                                                                | $t_{CLDX}$  | DTR only           | 2.3   | –   | –   | ns   |       |
| S# active hold time (relative to clock)                                                        | $t_{CHSH}$  | STR                | 3.375 | –   | –   | ns   |       |
|                                                                                                |             | DTR                | 5.0   | –   | –   |      |       |
| S# active hold time (relative to clock LOW)<br>Only for writes in DTR                          | $t_{CLSH}$  | DTR only           | 3.375 | –   | –   | ns   |       |
| S# not active setup time (relative to clock)                                                   | $t_{SHCH}$  | STR                | 3.375 | –   | –   | ns   |       |
|                                                                                                |             | DTR                | 5.0   | –   | –   | ns   |       |
| S# deselect time after a READ command                                                          | $t_{SHSL1}$ | STR/DTR            | 20    | –   | –   | ns   |       |
| S# deselect time after a nonREAD command                                                       | $t_{SHSL2}$ | STR/DTR            | 50    | –   | –   | ns   |       |
| Output disable time                                                                            | $t_{SHQZ}$  | STR/DTR            | –     | –   | 7   | ns   | 3     |
| Clock LOW to output valid under 30pF                                                           | $t_{CLQV}$  | STR/DTR            | –     | –   | 6   | ns   |       |
| Clock LOW to output valid under 10pF                                                           |             | STR/DTR            | –     | –   | 5   | ns   |       |
| Clock HIGH to output valid under 30pF                                                          | $t_{CHQV}$  | DTR only           | –     | –   | 6   | ns   |       |
| Clock HIGH to output valid under 10pF                                                          |             | DTR only           | –     | –   | 5   | ns   |       |
| Output hold time                                                                               | $t_{CLQX}$  | STR/DTR            | 1.5   | –   | –   | ns   |       |
| Output hold time                                                                               | $t_{CHQX}$  | DTR only           | 1.5   | –   | –   | ns   |       |
| HOLD setup time (relative to clock)                                                            | $t_{HLCH}$  | STR/DTR            | 3.375 | –   | –   | ns   |       |
| HOLD hold time (relative to clock)                                                             | $t_{CHHH}$  | STR/DTR            | 3.375 | –   | –   | ns   |       |

**Table 48: AC Characteristics and Operating Conditions (Continued)**

| Parameter                                           | Symbol      | Data Transfer Rate | Min   | Typ                               | Max  | Unit | Notes |
|-----------------------------------------------------|-------------|--------------------|-------|-----------------------------------|------|------|-------|
| HOLD setup time (relative to clock)                 | $t_{HHCH}$  | STR/DTR            | 3.375 | –                                 | –    | ns   |       |
| HOLD hold time (relative to clock)                  | $t_{CHHL}$  | STR/DTR            | 3.375 | –                                 | –    | ns   |       |
| HOLD to output Low-Z                                | $t_{HHQX}$  | STR/DTR            | –     | –                                 | 8    | ns   | 3     |
| HOLD to output High-Z                               | $t_{HLQZ}$  | STR/DTR            | –     | –                                 | 8    | ns   | 3     |
| CRC check time: Main block                          | $t_{CRC}$   | STR/DTR            | –     | 1.3                               | –    | ms   |       |
| CRC check time: Full chip (512Mb)                   | $t_{CRC}$   | STR/DTR            | –     | 2                                 | –    | s    |       |
| Write protect setup time                            | $t_{WHSL}$  | STR/DTR            | 20    | –                                 | –    | ns   | 5     |
| Write protect hold time                             | $t_{SHWL}$  | STR/DTR            | 100   | –                                 | –    | ns   | 5     |
| S# HIGH to deep power-down                          | $t_{DP}$    | STR/DTR            | 3     | –                                 | –    | us   |       |
| S# HIGH to standby mode (DPD exit time)             | $t_{RDP}$   | STR/DTR            | 30    | –                                 | –    | us   |       |
| WRITE STATUS REGISTER cycle time                    | $t_W$       | STR/DTR            | –     | 1.3                               | 8    | ms   |       |
| WRITE NONVOLATILE CONFIGURATION REGISTER cycle time | $t_{WNVCR}$ | STR/DTR            | –     | 0.2                               | 1    | s    |       |
| Nonvolatile sector lock time                        | $t_{PPBP}$  | STR/DTR            | –     | 0.1                               | 2.8  | ms   |       |
| Program ASP register                                | $t_{ASPP}$  | STR/DTR            | –     | 0.1                               | 0.5  | ms   |       |
| Program password                                    | $t_{PASSP}$ | STR/DTR            | –     | 0.2                               | 0.8  | ms   |       |
| Erase nonvolatile sector lock array                 | $t_{PPBE}$  | STR/DTR            | –     | 0.2                               | 1    | s    |       |
| Page program time (256 bytes)                       | $t_{PP}$    | STR/DTR            | –     | 120                               | 1800 | us   | 7     |
| Page program time (n bytes)                         |             |                    | –     | $18 + 2.5 \times \text{int}(n/6)$ | 1800 | us   | 8     |
| PROGRAM OTP cycle time (64 bytes)                   | $t_{POTP}$  | STR/DTR            | –     | 0.12                              | 0.8  | ms   |       |
| Sector erase time                                   | $t_{SE}$    | STR/DTR            | –     | 0.15                              | 1    | s    |       |
| 4KB subsector erase time                            | $t_{SSE}$   | STR/DTR            | –     | 0.05                              | 0.4  | s    |       |
| 32KB subsector erase time                           | $t_{SSE}$   | STR/DTR            | –     | 0.1                               | 1    | s    |       |
| 512Mb bulk erase time                               | $t_{DE}$    | STR/DTR            | –     | 153                               | 460  | s    |       |

- Notes:
1. Typical values given for  $T_A = 25^\circ\text{C}$ .
  2.  $t_{CH} + t_{CL}$  must add up to  $1/f_C$ .
  3. Value guaranteed by characterization; not 100% tested.
  4. Expressed as a slew-rate.
  5. Only applicable as a constraint for a WRITE STATUS REGISTER command when STATUS REGISTER WRITE is set to 1.
  6. Typical value is applied for pattern: 50% 0 and 50% 1.
  7.  $\text{int}(n)$  correspond to the integer part of n, For example  $\text{int}(12/8) = 1$ ,  $\text{int}(32/8) = 4$ ,  $\text{int}(15.3) = 15$ .

## AC Reset Specifications

**Table 49: AC Reset Conditions**

Note 1 applies to entire table

| Parameter                    | Symbol       | Conditions                                                                                                                                              | Min | Typ         | Max | Unit    |
|------------------------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-------------|-----|---------|
| Reset pulse width            | $t_{RLRH}^2$ |                                                                                                                                                         | 50  | –           | –   | ns      |
| Reset recovery time          | $t_{RHSL}$   | Device deselected (S# HIGH) and is in XIP mode                                                                                                          | 40  | –           | –   | ns      |
|                              |              | Device deselected (S# HIGH) and is in standby mode                                                                                                      | 40  | –           | –   | ns      |
|                              |              | Commands are being decoded, any READ operations are in progress or any WRITE operation to volatile registers are in progress                            | 40  | –           | –   | ns      |
|                              |              | Any device array PROGRAM/ERASE/SUSPEND/RESUME, PROGRAM OTP, NONVOLATILE SECTOR LOCK, and ERASE NONVOLATILE SECTOR LOCK ARRAY operations are in progress | 30  | –           | –   | $\mu$ s |
|                              |              | While a WRITE STATUS REGISTER operation is in progress                                                                                                  | –   | $t_W$       | –   | ms      |
|                              |              | While a WRITE NONVOLATILE CONFIGURATION REGISTER operation is in progress                                                                               | –   | $t_{WNVCR}$ | –   | ms      |
|                              |              | On completion or suspension of a SUBSECTOR ERASE operation                                                                                              | –   | $t_{SSE}$   | –   | s       |
|                              |              | Device in deep power-down mode                                                                                                                          | –   | $t_{RDP}$   | –   | ms      |
|                              |              | While ADVANCED SECTOR PROTECTION PROGRAM operation is in progress                                                                                       | –   | $t_{ASPP}$  | –   | ms      |
|                              |              | While PASSWORD PROTECTION PROGRAM operation is in progress                                                                                              | –   | $t_{PASSP}$ | –   | ms      |
| Software reset recovery time | $t_{SHSL3}$  | Device deselected (S# HIGH) and is in standby mode                                                                                                      | 40  | –           | –   | ns      |
|                              |              | Any Flash array PROGRAM/ERASE/SUSPEND/RESUME, PROGRAM OTP, NONVOLATILE SECTOR LOCK, and ERASE NONVOLATILE SECTOR LOCK ARRAY operations are in progress  | 30  | –           | –   | $\mu$ s |
|                              |              | While WRITE STATUS REGISTER operation is in progress                                                                                                    | –   | $t_W$       | –   | ms      |
|                              |              | While a WRITE NONVOLATILE CONFIGURATION REGISTER operation is in progress                                                                               | –   | $t_{WNVCR}$ | –   | ms      |
|                              |              | On completion or suspension of a SUBSECTOR ERASE operation                                                                                              | –   | $t_{SSE}$   | –   | s       |
|                              |              | Device in deep power-down mode                                                                                                                          | –   | $t_{RDP}$   | –   | ms      |
|                              |              | While ADVANCED SECTOR PROTECTION PROGRAM operation is in progress                                                                                       | –   | $t_{ASPP}$  | –   | ms      |
|                              |              | While PASSWORD PROTECTION PROGRAM operation is in progress                                                                                              | –   | $t_{PASSP}$ | –   | ms      |

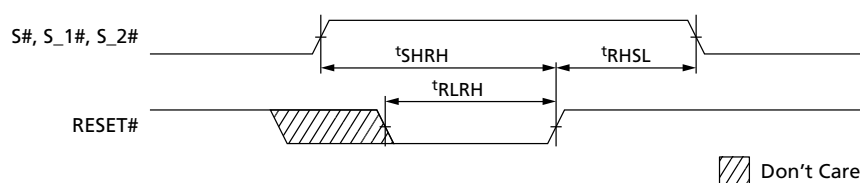
**Table 49: AC Reset Conditions (Continued)**

Note 1 applies to entire table

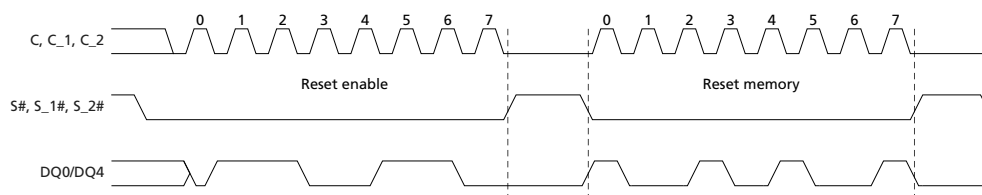
| Parameter                      | Symbol     | Conditions                                          | Min | Typ | Max | Unit |
|--------------------------------|------------|-----------------------------------------------------|-----|-----|-----|------|
| Chip select high to reset high | $t_{SHRH}$ | Chip must be deselected before reset is de-asserted | 10  | –   | –   | ns   |

- Notes: 1. Values are guaranteed by characterization; not 100% tested.  
2. The device reset is possible but not guaranteed if  $t_{RLRH} < 50\text{ns}$ .

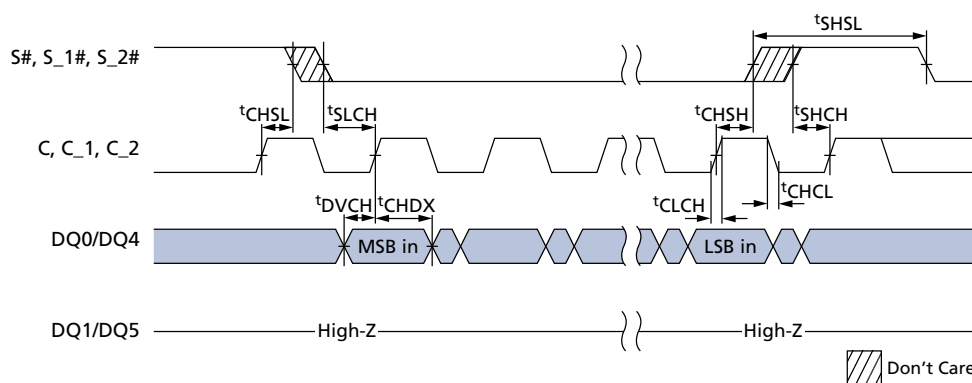
**Figure 49: Reset AC Timing During PROGRAM or ERASE Cycle**



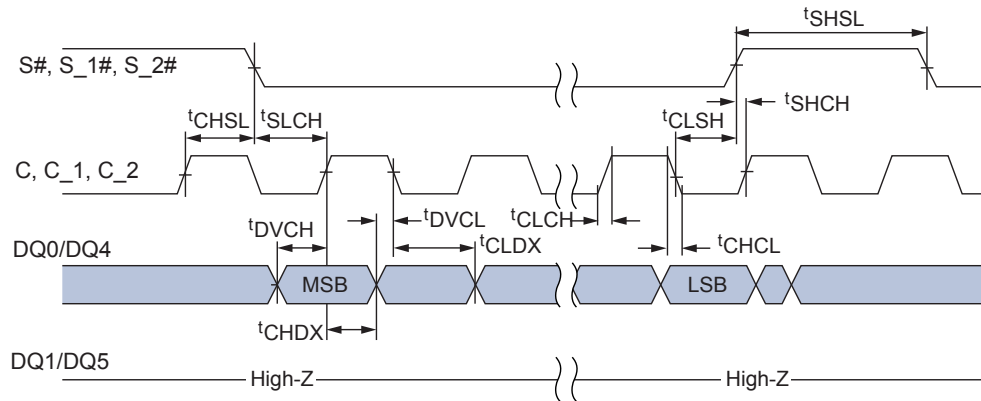
**Figure 50: Reset Enable and Reset Memory Timing**



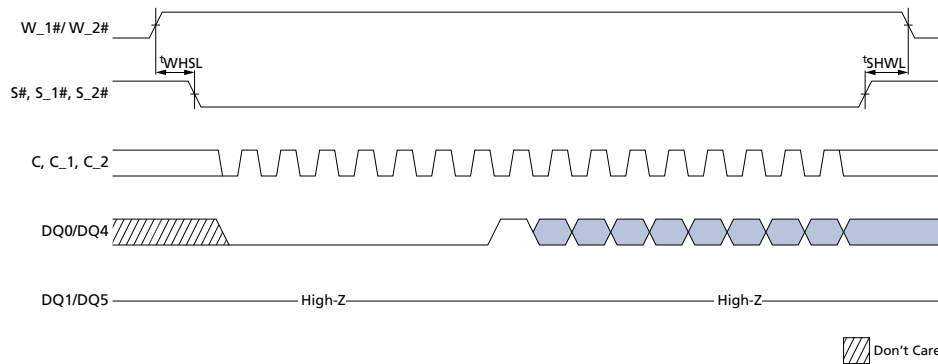
**Figure 51: Serial Input Timing STR**



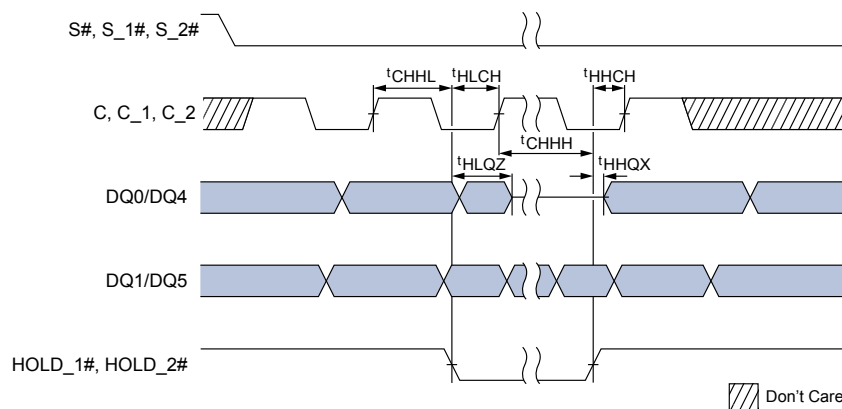
**Figure 52: Serial Input Timing DTR**



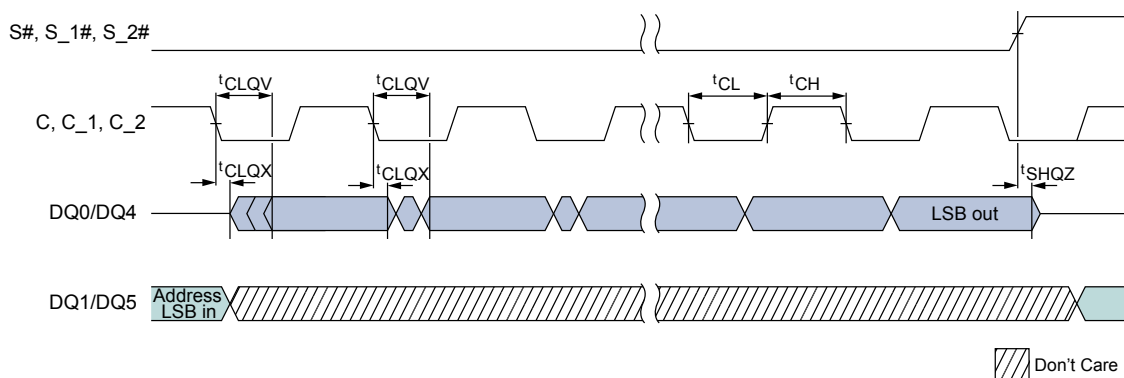
**Figure 53: Write Protect Setup and Hold During WRITE STATUS REGISTER Operation (SRWD = 1)**



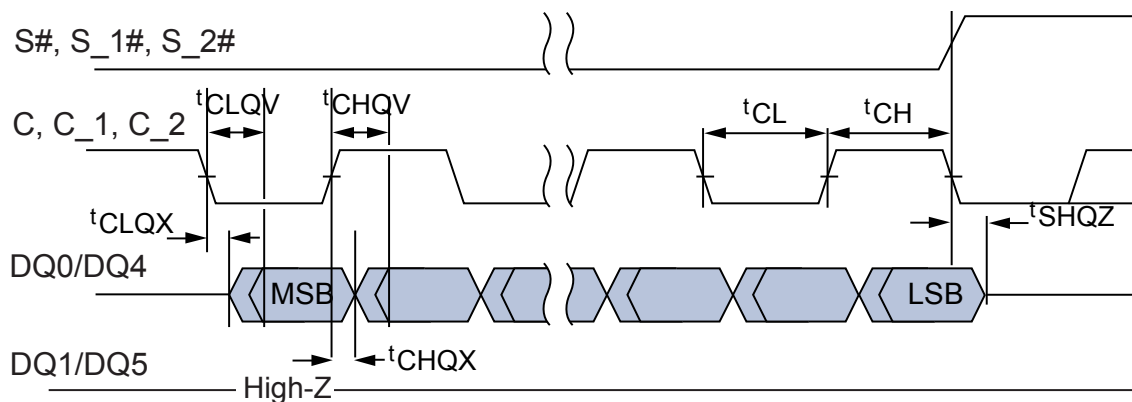
**Figure 54: Hold Timing**



**Figure 55: Output Timing for STR**



**Figure 56: Output Timing for DTR**



## Program/Erase Specifications

**Table 50: Program/Erase Specifications**

| Parameter                  | Condition                                                  | Typ | Max | Units | Notes |
|----------------------------|------------------------------------------------------------|-----|-----|-------|-------|
| Erase to suspend           | Sector erase or erase resume to erase suspend              | 150 | –   | μs    | 1     |
| Program to suspend         | Program resume to program suspend                          | 5   | –   | μs    | 1     |
| Subsector erase to suspend | Subsector erase or subsector erase resume to erase suspend | 50  | –   | μs    | 1     |
| Suspend latency            | Program                                                    | 7   | 25  | μs    | 2     |
| Suspend latency            | Subsector erase                                            | 15  | 30  | μs    | 2     |
| Suspend latency            | Erase                                                      | 15  | 30  | μs    | 3     |

- Notes:
1. Timing is not internally controlled.
  2. Any READ command accepted.
  3. Any command except the following are accepted: SECTOR, SUBSECTOR, or DIE ERASE; WRITE STATUS REGISTER; WRITE NONVOLATILE CONFIGURATION REGISTER; and PROGRAM OTP.

## Revision History

### Rev. F – 05/19

- Added Important Notes and Warnings section for further clarification aligning to industry standards
- Reviewed Part Number Ordering Information figure
- Eliminated IT temperature range

### Rev. E – 10/16

- Updated root part number in cover page
- Updated Part Number Ordering Information
- Added initial delivery status
- Updated MAX DTR frequency to 90 MHz

### Rev. D – 06/16

- Added general purpose read register notes to Command Definitions table

### Rev. C – 05/16

- To Production status

### Rev. B – 02/16

- Review Device ID Data table

### Rev. A – 02/15

- Initial release

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This data sheet contains minimum and maximum limits specified over the power supply and temperature range set forth herein. Although considered final, these specifications are subject to change, as further product development and data characterization sometimes occur.

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